

# 适用于 AMD™ 系列 17h 型 10h-1Fh 处理器的 TPS6508700 PMIC

## 1 器件概述

### 1.1 特性

- 5.6V 至 21V 的宽输入电压范围
- 三个可变输出电压同步降压控制器，采用 DCAP2™ 拓扑
  - 使用外部 FET 的可扩展输出电流，支持可选电流限制
  - 针对 BUCK2 和 BUCK6 进行 I<sup>2</sup>C 动态电压调节 (DVS) 控制，针对 BUCK1 进行外部反馈
- 三个可变输出电压同步降压转换器，采用 DCS-Control 拓扑技术并支持 I<sup>2</sup>C DVS 功能
  - 输入电压范围为 4.5V 至 5.5V
  - 输出电压范围为 0.425V 至 3.575V
  - 输出电流高达 3A
- 三个具有可调节输出电压的 LDO 稳压器
  - LDOA1: 可通过 I<sup>2</sup>C 选择的输出电压 (1.35V 至 3.3V)，输出电流高达 200mA
  - LDOA2 和 LDOA3: I<sup>2</sup>C 可选输出电压为 0.7V 至 1.5V，输出电流高达 600mA
- 带有 BUCK6 的 LDO 作为输入电压
- 三个具有压摆率控制功能的负载开关
  - 输出电流高达 300mA，压降小于标称输入电压的 1.5%
  - 输入电压为 1.8V 时，R<sub>DS(on)</sub> < 96mΩ
- 5V 固定输出电压 LDO (LDO5)
  - 用于 SMPS 的栅极驱动器和 LDOA1 的电源
  - 可自动切换至 5V 降压以实现更高效率
- 工厂 OTP 编程提供的内置时序功能
  - 用于 G3'、G3、S5 和 S0 状态选择的 CTL1、CTL4 和 CTL5
  - 用于 PG\_S0 和 PG\_S5 的 GPO1 和 GPO2
  - 漏极开路中断输出引脚
- I<sup>2</sup>C 接口支持:
  - 标准模式 (100kHz)
  - 快速模式 (400kHz)
  - 快速模式+ (1MHz)

### 1.2 应用

- 2、3 或 4 电芯锂离子电池供电产品 (NVDC 或非 NVDC)
- 墙供电设计，特别是 12V 电源
- 平板电脑、超极本和笔记本电脑
- 移动 PC 和移动网络设备

### 1.3 说明

TPS6508700 器件是一款单芯片电源管理 IC (PMIC)，专为笔记本电脑和一体式台式机的 AMD™ 系列 17h 型 10h-1Fh 处理器而设计。TPS6508700 器件可提供 5.6V 至 21V 的输入电压范围，用途广泛。该器件非常适合使用 2S、3S 或 4S 锂离子电池组的 NVDC 和非 NVDC 电源架构。该 D-CAP2™ 和 DCS-Control™ 高频稳压器采用小型电感和电容，以减小解决方案体积。D-CAP2 和 DCS-Control 拓扑具有出色的瞬态响应性能，特别适用于具有快速负载开关的处理器内核和系统内存电压轨。I<sup>2</sup>C 接口可通过嵌入式控制器 (EC) 或片上系统 (SoC) 进行轻松控制。PMIC 采用带散热焊盘的 8mm × 8mm 单行 VQFN 封装，因此散热性能良好，电路板布线简单。

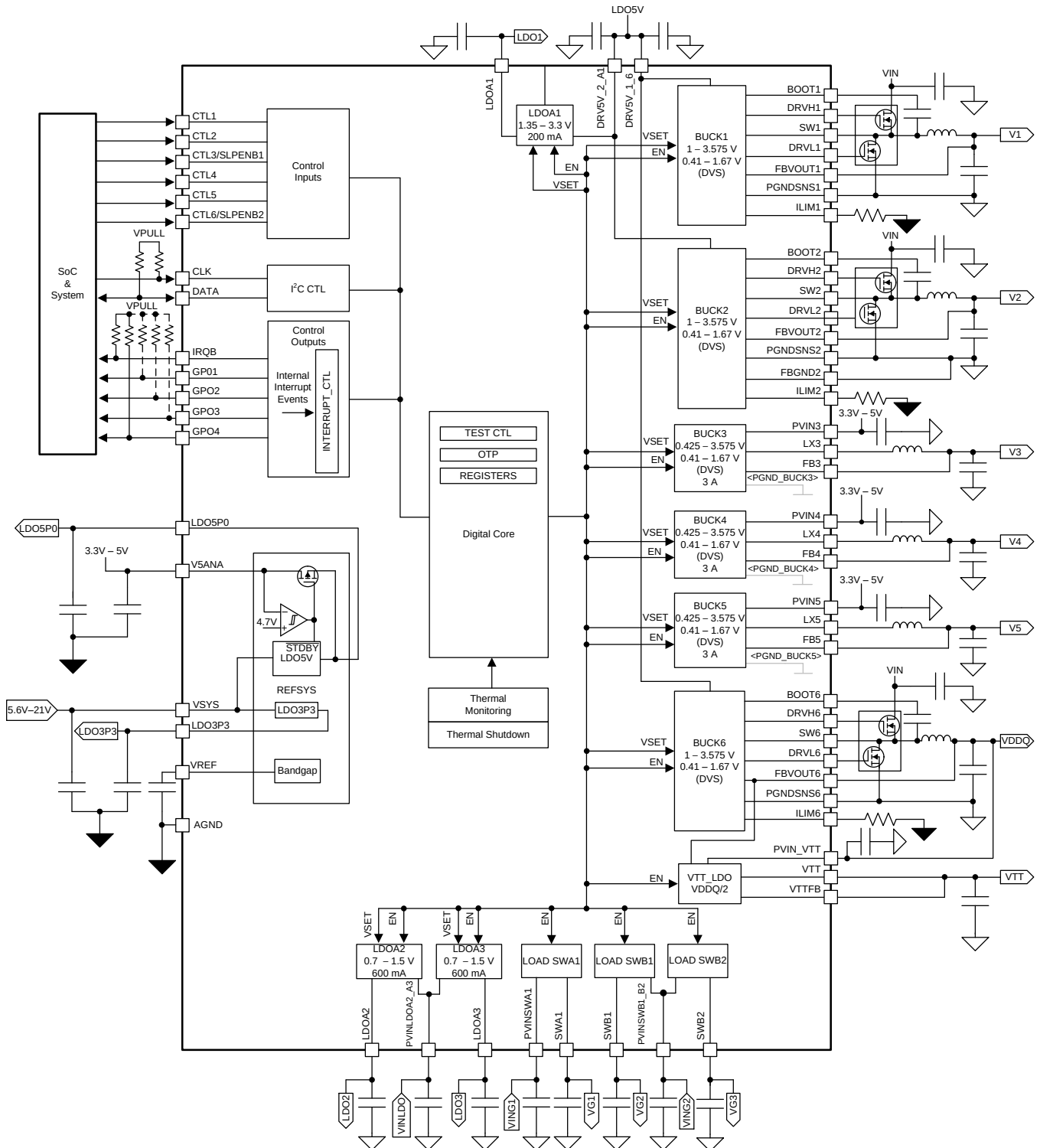
器件信息<sup>(1)</sup>

| 器件型号       | 封装        | 封装尺寸 (标称值)      |
|------------|-----------|-----------------|
| TPS6508700 | VQFN (64) | 8.00mm x 8.00mm |

(1) 有关详细信息，请参阅 [机械封装和可订购信息](#) 部分。



## 1.4 功能框图



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图 1-1. PMIC 功能框图

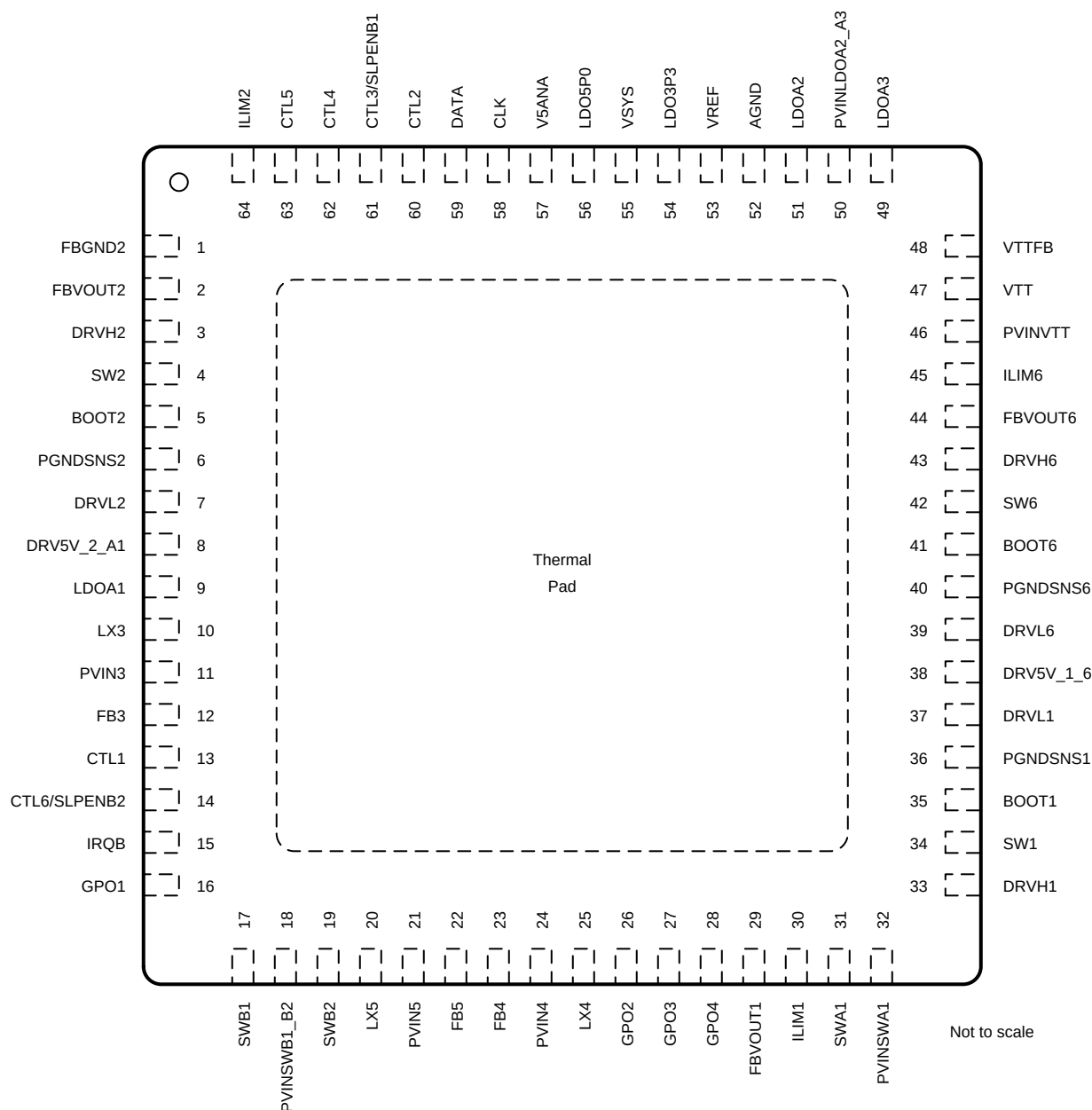
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注：之前版本的页码可能与当前版本有所不同。

| 日期          | 修订版本 | 说明    |
|-------------|------|-------|
| 2017 年 10 月 | *    | 初始发行版 |

### 3 Pin Configuration and Functions

Figure 3-1 shows the 64-pin RSK plastic quad-flatpack no-lead package with exposed thermal pad.



The thermal pad must be connected to the system power ground plane.

**Figure 3-1. 64-pin RSK VQFN (Top View)**

#### 3.1 Pin Functions

##### Pin Functions

| PIN             |        | I/O | DESCRIPTION                                                                                                                       |
|-----------------|--------|-----|-----------------------------------------------------------------------------------------------------------------------------------|
| NO.             | NAME   |     |                                                                                                                                   |
| SMPS REGULATORS |        |     |                                                                                                                                   |
| 1               | FBGND2 | I   | Remote negative feedback sense for BUCK2 controller. Connect to negative terminal of output capacitor or input capacitor of load. |

### Pin Functions (continued)

| NO.                          | PIN         | I/O | DESCRIPTION                                                                                                                                                                 |
|------------------------------|-------------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                              | NAME        |     |                                                                                                                                                                             |
| 2                            | FBVOUT2     | I   | Remote positive feedback sense for BUCK2 controller. Connect to positive terminal of output capacitor or input capacitor of load.                                           |
| 3                            | DRVH2       | O   | High-side gate driver output for BUCK2 controller.                                                                                                                          |
| 4                            | SW2         | I   | Switch node connection for BUCK2 controller.                                                                                                                                |
| 5                            | BOOT2       | I   | Bootstrap pin for BUCK2 controller. Connect a 100-nF ceramic capacitor between this pin and SW2 pin.                                                                        |
| 6                            | PGNDSNS2    | I   | Power GND sense connection for BUCK2. Connect to ground terminal of external low-side FET.                                                                                  |
| 7                            | DRVL2       | O   | Low-side gate driver output for BUCK2 controller.                                                                                                                           |
| 8                            | DRV5V_2_A1  | I   | 5-V supply to BUCK2 gate driver and LDOA1. Bypass to ground with a 2.2-μF (typical) ceramic capacitor. Shorted on board to LDO5P0 pin.                                      |
| 10                           | LX3         | O   | Switch node connection for BUCK3 converter.                                                                                                                                 |
| 11                           | PVIN3       | I   | Power input to BUCK3 converter. Bypass to ground with a 10-μF (typical) ceramic capacitor.                                                                                  |
| 12                           | FB3         | I   | Remote feedback sense for BUCK3 converter. Connect to positive terminal of output capacitor.                                                                                |
| 20                           | LX5         | O   | Switch node connection for BUCK5 converter.                                                                                                                                 |
| 21                           | PVIN5       | I   | Power input to BUCK5 converter. Bypass to ground with a 10-μF (typical) ceramic capacitor.                                                                                  |
| 22                           | FB5         | I   | Remote feedback sense for BUCK5 converter. Connect to positive terminal of output capacitor.                                                                                |
| 23                           | FB4         | I   | Remote feedback sense for BUCK4 converter. Connect to positive terminal of output capacitor.                                                                                |
| 24                           | PVIN4       | I   | Power input to BUCK4 converter. Bypass to ground with a 10-μF (typical) ceramic capacitor.                                                                                  |
| 25                           | LX4         | O   | Switch node connection for BUCK4 converter.                                                                                                                                 |
| 29                           | FBVOUT1     | I   | Remote feedback sense for BUCK1 controller. Connect to external feedback near either output capacitor or input capacitor of load. Recommend a 4.7-pF feedforward capacitor. |
| 30                           | ILIM1       | I   | Current limit set pin for BUCK1 controller. Fit a resistor from this pin to ground to set current limit of external low-side FET.                                           |
| 33                           | DRVH1       | O   | High-side gate driver output for BUCK1 controller.                                                                                                                          |
| 34                           | SW1         | I   | Switch node connection for BUCK1 controller.                                                                                                                                |
| 35                           | BOOT1       | I   | Bootstrap pin for BUCK1 controller. Connect a 100-nF ceramic capacitor between this pin and SW1 pin.                                                                        |
| 36                           | PGNDSNS1    | I   | Power GND sense connection for BUCK1. Connect to ground terminal of external low-side FET.                                                                                  |
| 37                           | DRVL1       | O   | Low-side gate driver output for BUCK1 controller.                                                                                                                           |
| 38                           | DRV5V_1_6   | I   | 5-V supply to BUCK1 and BUCK6 gate drivers. Bypass to ground with a 2.2-μF (typical) ceramic capacitor. Shorted on board to LDO5P0 pin.                                     |
| 39                           | DRVL6       | O   | Low-side gate driver output for BUCK6 controller.                                                                                                                           |
| 40                           | PGNDSNS6    | I   | Power GND sense connection for BUCK6. Connect to ground terminal of external low-side FET.                                                                                  |
| 41                           | BOOT6       | I   | Bootstrap pin for BUCK6 controller. Connect a 100-nF ceramic capacitor between this pin and SW6 pin.                                                                        |
| 42                           | SW6         | I   | Switch node connection for BUCK6 controller.                                                                                                                                |
| 43                           | DRVH6       | O   | High-side gate driver output for BUCK6 controller.                                                                                                                          |
| 44                           | FBVOUT6     | I   | Remote feedback sense for BUCK6 controller. Connect to positive terminal of output capacitor or input capacitor of load.                                                    |
| 45                           | ILIM6       | I   | Current limit set pin for BUCK6 controller. Fit a resistor from this pin to ground to set current limit of external low-side FET.                                           |
| 64                           | ILIM2       | I   | Current limit set pin for BUCK2 controller. Fit a resistor from this pin to ground to set current limit of external low-side FET.                                           |
| <b>LDO AND LOAD SWITCHES</b> |             |     |                                                                                                                                                                             |
| 9                            | LDOA1       | O   | LDOA1 output. Bypass to ground with a 4.7-μF (typical) ceramic capacitor.                                                                                                   |
| 17                           | SWB1        | O   | Output of load switch B1. Bypass to ground with a 0.1-μF (typical) ceramic capacitor. Leave floating when not in use.                                                       |
| 18                           | PVINSWB1_B2 | I   | Power supply to load switch B1 and B2. Bypass to ground with a 1-μF (typical) ceramic capacitor to improve transient performance. Connect to ground when not in use.        |
| 19                           | SWB2        | O   | Output of load switch B2. Bypass to ground with a 0.1-μF (typical) ceramic capacitor. Leave floating when not in use.                                                       |
| 31                           | SWA1        | O   | Output of load switch A1. Bypass to ground with a 0.1-μF (typical) ceramic capacitor. Leave floating when not in use.                                                       |

## Pin Functions (continued)

| PIN                |              | I/O | DESCRIPTION                                                                                                                                                                                               |
|--------------------|--------------|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NO.                | NAME         |     |                                                                                                                                                                                                           |
| 32                 | PVINSWA1     | I   | Power supply to load switch A1. Bypass to ground with a 1-μF (typical) ceramic capacitor to improve transient performance. Connect to ground when not in use.                                             |
| 46                 | PVINVTT      | I   | Power supply to VTT LDO. Bypass to ground with a 10-μF (minimum) ceramic capacitor. Connect to ground when not in use.                                                                                    |
| 47                 | VTT          | O   | Output of load VTT LDO. Bypass to ground with 2× 22-μF (minimum) ceramic capacitors. Leave floating when not in use.                                                                                      |
| 48                 | VTTFB        | I   | Remote feedback sense for VTT LDO. Connect to positive terminal of output capacitor. Leave floating when not in use.                                                                                      |
| 49                 | LDOA3        | O   | Output of LDOA3. Bypass to ground with a 4.7-μF (typical) ceramic capacitor. Leave floating when not in use.                                                                                              |
| 50                 | PVINLDOA2_A3 | I   | Power supply to LDOA2 and LDOA3. Bypass to ground with a 4.7-μF (typical) ceramic capacitor. Connect to ground when not in use.                                                                           |
| 51                 | LDOA2        | O   | Output of LDOA2. Bypass to ground with a 4.7-μF (typical) ceramic capacitor. Leave floating when not in use.                                                                                              |
| 54                 | LDO3P3       | O   | Output of 3.3-V internal LDO. Bypass to ground with a 4.7-μF (typical) ceramic capacitor.                                                                                                                 |
| 56                 | LDO5P0       | O   | Output of 5-V internal LDO or an internal switch that connects this pin to V5ANA. Bypass to ground with a 4.7-μF (typical) ceramic capacitor.                                                             |
| 57                 | V5ANA        | I   | External 5-V supply input to internal load switch that connects this pin to LDO5P0 pin. Bypass this pin with an optional ceramic capacitor to improve transient performance.                              |
| <b>INTERFACE</b>   |              |     |                                                                                                                                                                                                           |
| 13                 | CTL1         | I   | Active-high enable pin for BUCK4, BUCK5, and BUCK6. Connect to AND of GPIO_G3 and EN_S5 for typical sequencing.                                                                                           |
| 14                 | CTL6/SLPENB2 | I   | Active-high unused control signal. Sleep state control for BUCK6 (masked).                                                                                                                                |
| 15                 | IRQB         | O   | Open-drain output interrupt pin. Refer to <a href="#">Section 5.9.3</a> for definitions.                                                                                                                  |
| 16                 | GPO1         | O   | PG_S5 output indicates S5 power state has been reached. Open drain output, pull up to appropriate voltage rail.                                                                                           |
| 26                 | GPO2         | O   | PG_S0 output indicates S0 power state has been reached. Open drain output, pull up to appropriate voltage rail.                                                                                           |
| 27                 | GPO3         | O   | General purpose output that is configured to push-pull output at 3.3V and controlled by I <sup>2</sup> C. Default state is low.                                                                           |
| 28                 | GPO4         | O   | General purpose output that is configured to open-drain output and controlled by I <sup>2</sup> C. Default state is high.                                                                                 |
| 58                 | CLK          | I   | I <sup>2</sup> C clock                                                                                                                                                                                    |
| 59                 | DATA         | I/O | I <sup>2</sup> C data                                                                                                                                                                                     |
| 60                 | CTL2         | I   | Active-high LDOA2 and LDOA3 enable. Tie to GND unless using this pin to disable LDOA2 and LDOA3 after enabling them by I <sup>2</sup> C.                                                                  |
| 61                 | CTL3/SLPENB1 | I   | Active-high VTT LDO enable and sleep state control for BUCK1-BUCK5 (masked), LDOA2, and LDOA3.                                                                                                            |
| 62                 | CTL4         | I   | Active-high enable pin for BUCK1 and BUCK3. Connect to OR of CTL1 input and inverted GPIO_G3 for typical sequencing. SWA1, SWB1, and SWB2 can also use CTL4 if configured by I <sup>2</sup> C after boot. |
| 63                 | CTL5         | I   | Active-high enable pin for BUCK2. Connect to EN_S0 for typical sequencing.                                                                                                                                |
| <b>REFERENCE</b>   |              |     |                                                                                                                                                                                                           |
| 53                 | VREF         | O   | Band-gap reference output. Stabilize it by connecting a 100-nF (typical) ceramic capacitor between this pin and quiet ground.                                                                             |
| 52                 | AGND         | —   | Analog ground. Do not connect to the thermal pad ground on top layer. Connect to ground of VREF capacitor.                                                                                                |
| 55                 | VSYS         | I   | System voltage detection and input to internal LDOs (3.3 V and 5 V). Bypass to ground with a 1-μF (typical) ceramic capacitor.                                                                            |
| <b>THERMAL PAD</b> |              |     |                                                                                                                                                                                                           |
| —                  | Thermal pad  | —   | Connect to PCB ground plane using multiple vias for good thermal and electrical performance.                                                                                                              |

## 4 Specifications

### 4.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                                                                                                                 | MIN  | MAX | UNIT |
|-------------------------------------------------------------------------------------------------------------------------------------------------|------|-----|------|
| <b>ANALOG</b>                                                                                                                                   |      |     |      |
| Input voltage from battery, V <sub>SYS</sub>                                                                                                    | −0.3 | 28  | V    |
| PVIN3, PVIN4, PVIN5, LDO5P0, DRV5V_1_6, DRV5V_2_A1, DRVL1, DRVL2, DRVL6                                                                         | −0.3 | 7   | V    |
| V5ANA                                                                                                                                           | −0.3 | 6   | V    |
| PGNDSNS1, PGNDSNS2, PGNDSNS6, AGND, FBGND2                                                                                                      | −0.3 | 0.3 | V    |
| DRVH1, DRVH2, DRVH6, BOOT1, BOOT2, BOOT6                                                                                                        | −0.3 | 34  | V    |
| SW1, SW2, SW6, transient for less than 5 ns.                                                                                                    | −5   | 28  | V    |
| LX3, LX4, LX5                                                                                                                                   | −0.3 | 7   | V    |
| LX3, LX4, LX5, transient for less than 20 ns.                                                                                                   | −2   | 9   | V    |
| Differential voltage, BOOTx to SWx                                                                                                              | −0.3 | 5.5 | V    |
| VREF, LDO3P3, FBVOUT1, FBVOUT2, FBVOUT6, FB3, FB4, FB5, ILIM1, ILIM2, ILIM6, PVINVT, VTT, VTTFB, PVINSWA1, SWA1, PVINSWB1_B2, SWB1, SWB2, LDOA1 | −0.3 | 3.6 | V    |
| PVINLDOA2_A3, LDOA2, LDOA3                                                                                                                      | −0.3 | 3.3 | V    |
| <b>DIGITAL IO</b>                                                                                                                               |      |     |      |
| DATA, CLK, GPO1-GPO3                                                                                                                            | −0.3 | 3.6 | V    |
| CTL1-CTL6, GPO4, IRQB                                                                                                                           | −0.3 | 7   | V    |
| <b>CHIP</b>                                                                                                                                     |      |     |      |
| Storage temperature, T <sub>stg</sub>                                                                                                           | −40  | 150 | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 4.2 ESD Ratings

|                                            | VALUE                                                                          | UNIT  |
|--------------------------------------------|--------------------------------------------------------------------------------|-------|
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±250  |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 4.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                                                           | MIN  | NOM | MAX         | UNIT |
|-----------------------------------------------------------|------|-----|-------------|------|
| <b>ANALOG</b>                                             |      |     |             |      |
| VSYS                                                      | 5.6  | 13  | 21          | V    |
| VREF                                                      | –0.3 |     | 1.3         | V    |
| PVIN3, PVIN4, PVIN5, LDO5P0, V5ANA, DRV5V_1_6, DRV5V_2_A1 | –0.3 | 5   | 5.5         | V    |
| PGNDSNS1, PGNDSNS2, PGNDSNS6, AGND, FBGND2                | –0.3 |     | 0.3         | V    |
| DRVH1, DRVH2, DRVH6, BOOT1, BOOT2, BOOT6                  | –0.3 |     | 26.5        | v    |
| DRVL1, DRVL2, DRVL6                                       | –0.3 |     | 5.5         | V    |
| SW1, SW2, SW6                                             | –1   |     | 21          | V    |
| LX3, LX4, LX5                                             | –1   |     | 5.5         | V    |
| FBVOUT1, FBVOUT2, FBVOUT6, FB3, FB4, FB5                  | –0.3 |     | 3.6         | V    |
| LDO3P3, ILIM1, ILIM2, ILIM6, LDOA1                        | –0.3 |     | 3.3         | V    |
| PVINVT                                                    | –0.3 |     | FBVOUT6     | V    |
| VTT, VTTFB                                                | –0.3 |     | FBVOUT6 / 2 | V    |
| PVINSWA1, SWA1                                            | –0.3 | 3.3 | 3.6         | V    |
| PVINSWB1_B2, PVINLDOA2_A3, SWB1, SWB2                     | –0.3 |     | 1.8         | V    |
| LDOA2, LDOA3                                              | –0.3 |     | 1.5         | V    |
| <b>DIGITAL IO</b>                                         |      |     |             |      |
| DATA, CLK, CTL1–CTL6, GPO1–GPO4, IRQB                     | –0.3 |     | 3.3         | V    |
| <b>CHIP</b>                                               |      |     |             |      |
| Operating ambient temperature, $T_A$                      | –40  | 27  | 85          | °C   |
| Operating junction temperature, $T_J$                     | –40  | 27  | 125         | °C   |

### 4.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TPS6508700 | UNIT |
|-------------------------------|----------------------------------------------|------------|------|
|                               |                                              | RSK (VQFN) |      |
|                               |                                              | 64 PINS    |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 25.8       | °C/W |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 11.3       | °C/W |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 4.4        | °C/W |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 0.2        | °C/W |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 4.4        | °C/W |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | 0.7        | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

### 4.5 Electrical Characteristics: Total Current Consumption

over recommended free-air temperature range and over recommended input voltage range (typical values are at  $T_A = 25^\circ\text{C}$ ) (unless otherwise noted)

| PARAMETER | TEST CONDITIONS                                                                                                                                                | MIN | TYP | MAX | UNIT          |
|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|---------------|
| $I_{SD}$  | PMIC shutdown current that includes $I_Q$ for references, LDO5, LDO3P3, and digital core<br>$V_{SYS} = 13\text{ V}$ , all functional output rails are disabled |     | 65  |     | $\mu\text{A}$ |

## 4.6 Electrical Characteristics: Reference and Monitoring System

over recommended free-air temperature range and over recommended input voltage range (typical values are at  $T_A = 25^\circ\text{C}$ ) (unless otherwise noted)

| PARAMETER                            |                                                                  | TEST CONDITIONS                                                                            | MIN   | TYP  | MAX  | UNIT             |
|--------------------------------------|------------------------------------------------------------------|--------------------------------------------------------------------------------------------|-------|------|------|------------------|
| <b>REFERENCE</b>                     |                                                                  |                                                                                            |       |      |      |                  |
| $V_{REF}$                            | Band-gap reference voltage                                       |                                                                                            |       | 1.25 |      | V                |
|                                      | Band-gap reference voltage accuracy                              |                                                                                            | –0.5% |      | 0.5% |                  |
| $C_{VREF}$                           | Band-gap output capacitor                                        |                                                                                            | 0.047 | 0.1  | 0.22 | $\mu\text{F}$    |
| $V_{SYS\_UV}$<br>$LO\_5V$            | VSYS UVLO threshold for LDO5                                     | $V_{SYS}$ falling                                                                          | 5.24  | 5.4  | 5.56 | V                |
| $V_{SYS\_UV}$<br>$LO\_5V\_H$<br>$YS$ | VSYS UVLO threshold hysteresis for LDO5                          | $V_{SYS}$ rising above $V_{SYS\_UVLO\_5V}$                                                 |       | 200  |      | mV               |
| $V_{SYS\_UV}$<br>$LO\_3V$            | VSYS UVLO threshold for LDO3P3                                   | $V_{SYS}$ falling                                                                          | 3.45  | 3.6  | 3.75 | V                |
| $V_{SYS\_UV}$<br>$LO\_3V\_H$<br>$YS$ | VSYS UVLO threshold hysteresis for LDO3P3                        | $V_{SYS}$ rising above $V_{SYS\_UVLO\_3V}$                                                 |       | 150  |      | mV               |
| $T_{CRIT}$                           | Critical threshold of die temperature                            | $T_J$ rising                                                                               | 130   | 145  | 160  | $^\circ\text{C}$ |
| $T_{CRIT\_H}$<br>$YS$                | Hysteresis of $T_{CRIT}$                                         | $T_J$ falling                                                                              |       | 10   |      | $^\circ\text{C}$ |
| $T_{HOT}$                            | Hot threshold of die temperature                                 | $T_J$ rising                                                                               | 110   | 115  | 120  | $^\circ\text{C}$ |
| $T_{HOT\_HY}$<br>$S$                 | Hysteresis of $T_{HOT}$                                          | $T_J$ falling                                                                              |       | 10   |      | $^\circ\text{C}$ |
| <b>LDO5</b>                          |                                                                  |                                                                                            |       |      |      |                  |
| $V_{IN}$                             | Input voltage at $V_{SYS}$ pin                                   |                                                                                            | 5.6   | 13   | 21   | V                |
| $V_{OUT}$                            | DC output voltage                                                | $I_{OUT} = 10\text{ mA}$                                                                   | 4.9   | 5    | 5.1  | V                |
| $I_{OUT}$                            | DC output current                                                |                                                                                            |       | 100  | 180  | mA               |
| $I_{OCP}$                            | Overcurrent protection                                           | Measured with output shorted to ground                                                     | 200   |      |      | mA               |
| $V_{TH\_PG}$                         | Power good assertion threshold in percentage of target $V_{OUT}$ | $V_{OUT}$ rising                                                                           |       | 94%  |      |                  |
| $V_{TH\_PG\_HYS}$                    | Power good deassertion hysteresis                                | $V_{OUT}$ rising or falling                                                                |       | 4%   |      |                  |
| $I_Q$                                | Quiescent current                                                | $V_{IN} = 13\text{ V}$ , $I_{OUT} = 0\text{ A}$                                            |       | 20   |      | $\mu\text{A}$    |
| $C_{OUT}$                            | External output capacitance                                      |                                                                                            | 2.7   | 4.7  | 10   | $\mu\text{F}$    |
| <b>V5ANA-to-LDO5P0 LOAD SWITCH</b>   |                                                                  |                                                                                            |       |      |      |                  |
| $R_{DS(on)}$                         | On resistance                                                    | $V_{IN} = 5\text{ V}$ , measured from V5ANA pin to LDO5P0 pin at $I_{OUT} = 200\text{ mA}$ |       |      | 1    | $\Omega$         |
| $V_{TH\_PG}$                         | Power good threshold for external 5-V supply                     | $V_{V5ANA}$ rising                                                                         |       | 4.7  |      | V                |
| $V_{TH\_HYS\_PG}$                    | Power good threshold hysteresis for external 5-V supply          | $V_{V5ANA}$ falling                                                                        |       | 100  |      | mV               |
| $I_{LKG}$                            | Leakage current                                                  | Switch disabled, $V_{V5ANA} = 5\text{ V}$ , $V_{LDO5} = 0\text{ V}$                        |       |      | 10   | $\mu\text{A}$    |
| <b>LDO3P3</b>                        |                                                                  |                                                                                            |       |      |      |                  |
| $V_{IN}$                             | Input voltage at $V_{SYS}$ pin                                   |                                                                                            | 5.6   | 13   | 21   | V                |
| $V_{OUT}$                            | DC output voltage                                                | $I_{OUT} = 10\text{ mA}$                                                                   |       | 3.3  |      | V                |
|                                      | DC output voltage accuracy                                       | $V_{IN} = 13\text{ V}$ , $I_{OUT} = 10\text{ mA}$                                          | –3%   |      | 3%   |                  |
| $I_{OUT}$                            | DC output current                                                |                                                                                            |       |      | 40   | mA               |
| $I_{OCP}$                            | Overcurrent protection                                           | Measured with output shorted to ground                                                     | 70    |      |      | mA               |
| $V_{TH\_PG}$                         | Power good assertion threshold in percentage of target $V_{OUT}$ | $V_{OUT}$ rising                                                                           |       | 92%  |      |                  |
| $V_{TH\_PG\_HYS}$                    | Power good deassertion hysteresis                                | $V_{OUT}$ falling                                                                          |       | 3%   |      |                  |

## Electrical Characteristics: Reference and Monitoring System (continued)

over recommended free-air temperature range and over recommended input voltage range (typical values are at  $T_A = 25^\circ\text{C}$ ) (unless otherwise noted)

| PARAMETER                             | TEST CONDITIONS                                    | MIN | TYP | MAX | UNIT          |
|---------------------------------------|----------------------------------------------------|-----|-----|-----|---------------|
| $I_Q$ Quiescent current               | $V_{IN} = 13\text{ V}$ ,<br>$I_{OUT} = 0\text{ A}$ |     | 20  |     | $\mu\text{A}$ |
| $C_{OUT}$ External output capacitance |                                                    | 2.2 | 4.7 | 10  | $\mu\text{F}$ |

## 4.7 Electrical Characteristics: Buck Controllers

over recommended input voltage range,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$  and  $T_A = 25^\circ\text{C}$  for typical values (unless otherwise noted)

| PARAMETER                                  |                                                                                                   | TEST CONDITIONS                                                                           | MIN    | TYP   | MAX    | UNIT  |
|--------------------------------------------|---------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------|--------|-------|--------|-------|
| BUCK1                                      |                                                                                                   |                                                                                           |        |       |        |       |
| V <sub>IN</sub>                            | Power input voltage for external HSD FET                                                          |                                                                                           | 5.6    | 13    | 21     | V     |
| V <sub>FBVOU<sub>T1</sub></sub>            | Internal reference regulation voltage                                                             | T <sub>A</sub> = 25°C                                                                     | 0.392  | 0.4   | 0.408  | V     |
| I <sub>LIM_LSD</sub>                       | Low-side output valley current limit accuracy (programmed by external resistor R <sub>LIM</sub> ) |                                                                                           | –15%   |       | 15%    |       |
| I <sub>LIMREF</sub>                        | Source current out of ILIM1 pin                                                                   | T <sub>A</sub> = 25°C                                                                     | 45     | 50    | 55     | μA    |
| V <sub>LIM</sub>                           | Voltage at ILIM1 pin                                                                              | V <sub>LIM</sub> = R <sub>LIM</sub> × I <sub>LIMREF</sub>                                 | 0.2    |       | 2.25   | V     |
| V <sub>TH_PG</sub>                         | Power good deassertion threshold in percentage of target V <sub>FB</sub>                          | V <sub>OUT</sub> rising                                                                   | 105.5% | 108%  | 110.5% |       |
|                                            |                                                                                                   | V <sub>OUT</sub> falling                                                                  | 89.5%  | 92%   | 94.5%  |       |
| R <sub>DSON_<sub>DRVH</sub></sub>          | Driver DRVH resistance                                                                            | Source, IDR <sub>VH</sub> = –50 mA                                                        |        | 3     |        | Ω     |
|                                            |                                                                                                   | Sink, IDR <sub>VH</sub> = 50 mA                                                           |        | 2     |        | Ω     |
| R <sub>DSON_<sub>DRVL</sub></sub>          | Driver DRVL resistance                                                                            | Source, IDR <sub>VL</sub> = –50 mA                                                        |        | 3     |        | Ω     |
|                                            |                                                                                                   | Sink, IDR <sub>VL</sub> = 50 mA                                                           |        | 0.4   |        | Ω     |
| C <sub>BOOT</sub>                          | Bootstrap capacitance                                                                             |                                                                                           |        | 100   |        | nF    |
| R <sub>ON_<sub>BO<sub>OT</sub></sub></sub> | Bootstrap switch ON resistance                                                                    |                                                                                           |        |       | 20     | Ω     |
| BUCK2, BUCK6                               |                                                                                                   |                                                                                           |        |       |        |       |
| V <sub>IN</sub>                            | Power input voltage for external HSD FET                                                          |                                                                                           | 5.6    | 13    | 21     | V     |
| V <sub>OUT</sub>                           | DC output voltage VID range and options                                                           | VID step size = 10 mV, BUCKx_VID[6:0] progresses from 0000001b to 1111111b                | 0.41   |       | 1.67   | V     |
|                                            |                                                                                                   | VID step size = 25 mV, BUCKx_VID[6:0] progresses from 0000001b to 1111111b                | 1      |       | 3.575  | V     |
|                                            | BUCK2 output voltage default                                                                      | Set by BUCK2_VID[6:0], 10-mV step size selected                                           |        | 0.8   |        | V     |
|                                            | BUCK6 output voltage default                                                                      | Set by BUCK6_VID[6:0], 25-mV step size selected                                           |        | 3.3   |        | V     |
|                                            | DC output voltage accuracy                                                                        | V <sub>OUT</sub> = 1, 1.2, 1.35, 1.5, 1.8, 2.5, 3.3 V<br>I <sub>OUT</sub> = 100 mA to 7 A | –2%    |       | 2%     |       |
|                                            | Total output voltage accuracy (DC plus ripple) in DCM                                             | I <sub>OUT</sub> = 10 mA, V <sub>OUT</sub> ≤ 1 V                                          | –30    |       | 40     | mV    |
| SR(V <sub>OU<sub>T</sub></sub> )           | Output DVS slew rate                                                                              | Step size = 10 mV                                                                         | 2.5    | 3.125 |        | mV/μs |
|                                            |                                                                                                   | Step size = 25 mV                                                                         | 5      | 6.25  |        |       |
| I <sub>LIM_LSD</sub>                       | Low-side output valley current limit accuracy (programmed by external resistor R <sub>LIM</sub> ) |                                                                                           | –15%   |       | 15%    |       |
| I <sub>LIMREF</sub>                        | Source current out of ILIM1 pin                                                                   | T <sub>A</sub> = 25°C                                                                     | 45     | 50    | 55     | μA    |
| V <sub>LIM</sub>                           | Voltage at ILIM1 pin                                                                              | V <sub>LIM</sub> = R <sub>LIM</sub> × I <sub>LIMREF</sub>                                 | 0.2    |       | 2.25   | V     |
| ΔV <sub>OUT</sub> /ΔV <sub>IN</sub>        | Line regulation                                                                                   | V <sub>OUT</sub> = 1, 1.2, 1.35, 1.5, 1.8, 2.5, 3.3 V,<br>I <sub>OUT</sub> = 7 A          | –0.5%  |       | 0.5%   |       |

## Electrical Characteristics: Buck Controllers (continued)

over recommended input voltage range,  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and  $T_A = 25^{\circ}\text{C}$  for typical values (unless otherwise noted)

| PARAMETER                                                                       | TEST CONDITIONS                                                                                                                                                               | MIN    | TYP  | MAX    | UNIT     |
|---------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|------|--------|----------|
| $\Delta V_{OUT}/\Delta I_{OUT}$ Load regulation                                 | $V_{IN} = 13\text{ V}$ , $V_{OUT} = 1, 1.2, 1.35, 1.5, 1.8, 2.5, 3.3\text{ V}$ , $I_{OUT} = 0\text{ A}$ to $7\text{ A}$ , referenced to $V_{OUT}$ at $I_{OUT} = I_{OUT\_MAX}$ | 0%     |      | 1%     |          |
| $V_{TH\_PG}$ Power good deassertion threshold in percentage of target $V_{OUT}$ | $V_{OUT}$ rising                                                                                                                                                              | 105.5% | 108% | 110.5% |          |
|                                                                                 | $V_{OUT}$ falling                                                                                                                                                             | 89.5%  | 92%  | 94.5%  |          |
| $R_{DS(on)\_DRVH}$ Driver DRVH resistance                                       | Source, $IDRVH = -50\text{ mA}$                                                                                                                                               |        | 3    |        | $\Omega$ |
|                                                                                 | Sink, $IDRVH = 50\text{ mA}$                                                                                                                                                  |        | 2    |        | $\Omega$ |
| $R_{DS(on)\_DRVL}$ Driver DRVL resistance                                       | Source, $IDRVL = -50\text{ mA}$                                                                                                                                               |        | 3    |        | $\Omega$ |
|                                                                                 | Sink, $IDRVL = 50\text{ mA}$                                                                                                                                                  |        | 0.4  |        | $\Omega$ |
| $R_{DIS}$ Output auto-discharge resistance                                      | BUCKx_DIS[1:0] = 01b                                                                                                                                                          |        | 100  |        | $\Omega$ |
|                                                                                 | BUCKx_DIS[1:0] = 10b                                                                                                                                                          |        | 200  |        | $\Omega$ |
|                                                                                 | BUCKx_DIS[1:0] = 11b                                                                                                                                                          |        | 500  |        | $\Omega$ |
| $C_{BOOT}$ Bootstrap capacitance                                                |                                                                                                                                                                               |        | 100  |        | nF       |
| $R_{ON\_BOOT}$ Bootstrap switch ON resistance                                   |                                                                                                                                                                               |        |      | 20     | $\Omega$ |

## 4.8 Electrical Characteristics: Synchronous Buck Converters

over recommended input voltage range,  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and  $T_A = 25^{\circ}\text{C}$  for typical values (unless otherwise noted)

| PARAMETER                                                                           | TEST CONDITIONS                                                                                                                                                              | MIN                                                                               | TYP   | MAX   | UNIT              |
|-------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------|-------|-------|-------------------|
| <b>BUCK3, BUCK4, BUCK5</b>                                                          |                                                                                                                                                                              |                                                                                   |       |       |                   |
| $V_{IN}$ Power input voltage                                                        |                                                                                                                                                                              | 4.5                                                                               | 5     | 5.5   | V                 |
| $V_{OUT}$                                                                           | DC output voltage VID range and options                                                                                                                                      | VID step size = 25 mV, BUCKx_VID[6:0] progresses from 0000001b to 1111111b        | 0.425 | 3.575 | V                 |
|                                                                                     | BUCK3 output voltage default                                                                                                                                                 | Set by BUCK3_VID[6:0], 25-mV step size                                            |       | 1.8   | V                 |
|                                                                                     | BUCK4 output voltage default                                                                                                                                                 | Set by BUCK4_VID[6:0], 25-mV step size                                            |       | 0.8   | V                 |
|                                                                                     | BUCK5 output voltage default                                                                                                                                                 | Set by BUCK5_VID[6:0], 25-mV step size                                            |       | 1.8   | V                 |
|                                                                                     | DC output voltage accuracy                                                                                                                                                   | $V_{OUT} = 1, 1.2, 1.35, 1.5, 1.8, 2.5, 3.3\text{ V}$ , $I_{OUT} = 1.5\text{ A}$  | -2%   | 2%    |                   |
|                                                                                     |                                                                                                                                                                              | $V_{OUT} = 1, 1.2, 1.35, 1.5, 1.8, 2.5, 3.3\text{ V}$ , $I_{OUT} = 100\text{ mA}$ | -2.5% | 2.5%  |                   |
|                                                                                     | Total output voltage accuracy (DC plus ripple) in DCM                                                                                                                        | $I_{OUT} = 10\text{ mA}$ , $V_{OUT} \leq 1\text{ V}$                              | -30   | 40    | mV                |
| $SR(V_{OUT})$ Output DVS slew rate                                                  |                                                                                                                                                                              | 5                                                                                 | 6.25  |       | mV/ $\mu\text{s}$ |
| $I_{OUT}$ Continuous DC output current                                              |                                                                                                                                                                              |                                                                                   |       | 3     | A                 |
| $I_{IND\_LIM}$ HSD FET current limit                                                |                                                                                                                                                                              | 4.3                                                                               |       | 7     | A                 |
| $I_Q$ Quiescent current                                                             | $V_{IN} = 5\text{ V}$ , $V_{OUT} = 1\text{ V}$                                                                                                                               |                                                                                   | 35    |       | $\mu\text{A}$     |
| $\Delta V_{OUT}/\Delta V_{IN}$ Line regulation                                      | $V_{OUT} = 1, 1.2, 1.35, 1.5, 1.8, 2.5, 3.3\text{ V}$ , $I_{OUT} = 1.5\text{ A}$                                                                                             | -0.5%                                                                             |       | 0.5%  |                   |
| $\Delta V_{OUT}/\Delta I_{OUT}$ Load regulation                                     | $V_{IN} = 5\text{ V}$ , $V_{OUT} = 1, 1.2, 1.35, 1.5, 1.8, 2.5, 3.3\text{ V}$ , $I_{OUT} = 0\text{ A}$ to $3\text{ A}$ , referenced to $V_{OUT}$ at $I_{OUT} = 1.5\text{ A}$ | -0.2%                                                                             |       | 2%    |                   |
| $V_{TH\_PG}$ Power good deassertion threshold in percentage of target $V_{OUT}$     | $V_{OUT}$ rising                                                                                                                                                             |                                                                                   | 108%  |       |                   |
|                                                                                     | $V_{OUT}$ falling                                                                                                                                                            |                                                                                   | 92%   |       |                   |
| $V_{TH\_HYS\_PG}$ Power good reassertion hysteresis entering back into $V_{TH\_PG}$ | $V_{OUT}$ rising or falling                                                                                                                                                  |                                                                                   | 3%    |       |                   |
| $R_{DIS}$ Output auto-discharge resistance                                          | BUCKx_DIS[1:0] = 01b                                                                                                                                                         |                                                                                   | 100   |       | $\Omega$          |
|                                                                                     | BUCKx_DIS[1:0] = 10b                                                                                                                                                         |                                                                                   | 200   |       |                   |
|                                                                                     | BUCKx_DIS[1:0] = 11b                                                                                                                                                         |                                                                                   | 500   |       |                   |

## 4.9 Electrical Characteristics: LDOs

over recommended input voltage range,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$  and  $T_A = 25^\circ\text{C}$  for typical values (unless otherwise noted)

| PARAMETER                            |                                                                           | TEST CONDITIONS                                                             | MIN                                     | TYP  | MAX  | UNIT |
|--------------------------------------|---------------------------------------------------------------------------|-----------------------------------------------------------------------------|-----------------------------------------|------|------|------|
| LDOA1                                |                                                                           |                                                                             |                                         |      |      |      |
| V <sub>IN</sub>                      | Input voltage                                                             |                                                                             | 4.5                                     | 5    | 5.5  | V    |
| V <sub>OUT</sub>                     | DC output voltage                                                         | Set by LDOA1_VID[3:0]                                                       | 3.3                                     |      |      |      |
|                                      | Accuracy                                                                  | I <sub>OUT</sub> = 0 to 200 mA                                              | –2%                                     |      | 2%   | V    |
| I <sub>OUT</sub>                     | DC output current                                                         |                                                                             |                                         |      | 200  | mA   |
| ΔV <sub>OUT</sub> /ΔV <sub>IN</sub>  | Line regulation                                                           | I <sub>OUT</sub> = 40 mA                                                    | –0.5%                                   |      | 0.5% |      |
| ΔV <sub>OUT</sub> /ΔI <sub>OUT</sub> | Load regulation                                                           | I <sub>OUT</sub> = 10 mA to 200 mA                                          | –2%                                     |      | 2%   |      |
| I <sub>OCP</sub>                     | Overcurrent protection                                                    | V <sub>IN</sub> = 5 V, Measured with output shorted to ground               | 500                                     |      |      | mA   |
| V <sub>TH_PG</sub>                   | Power good deassertion threshold in percentage of target V <sub>OUT</sub> | V <sub>OUT</sub> rising                                                     |                                         | 108% |      |      |
|                                      |                                                                           | V <sub>OUT</sub> falling                                                    |                                         | 92%  |      |      |
| t <sub>STARTUP</sub>                 | Start-up time                                                             | Measured from EN = H to reach 95% of final value, C <sub>OUT</sub> = 4.7 μF |                                         |      | 500  | μs   |
| I <sub>Q</sub>                       | Quiescent current                                                         | I <sub>OUT</sub> = 0 A                                                      |                                         | 23   |      | μA   |
| C <sub>OUT</sub>                     | External output capacitance                                               |                                                                             | 2.7                                     | 4.7  | 10   | μF   |
|                                      | ESR                                                                       |                                                                             |                                         |      | 100  | mΩ   |
| R <sub>DIS</sub>                     | Output auto-discharge resistance                                          | LDOA1_DIS[1:0] = 01b                                                        |                                         | 100  |      | Ω    |
|                                      |                                                                           | LDOA1_DIS[1:0] = 10b                                                        |                                         | 190  |      | Ω    |
|                                      |                                                                           | LDOA1_DIS[1:0] = 11b                                                        |                                         | 450  |      | Ω    |
| LDOA2 and LDOA3                      |                                                                           |                                                                             |                                         |      |      |      |
| V <sub>IN</sub>                      | Power input voltage                                                       |                                                                             | V <sub>OUT</sub> + V <sub>DROP(1)</sub> | 1.8  | 1.98 | V    |
| V <sub>OUT</sub>                     | LDOA2 DC output voltage                                                   | Set by LDOA2_VID[3:0]                                                       |                                         | 1.5  |      | V    |
|                                      | LDOA3 DC output voltage                                                   | Set by LDOA3_VID[3:0]                                                       |                                         | 1.2  |      | V    |
|                                      | DC output voltage accuracy                                                | I <sub>OUT</sub> = 0 to 600 mA                                              | –2%                                     |      | 3%   |      |
| I <sub>OUT</sub>                     | DC output current                                                         |                                                                             |                                         |      | 600  | mA   |
| V <sub>DROP</sub>                    | Dropout voltage                                                           | V <sub>OUT</sub> = 0.99 × V <sub>OUT_NOM</sub> , I <sub>OUT</sub> = 600 mA  |                                         |      | 350  | mV   |
| ΔV <sub>OUT</sub> /ΔV <sub>IN</sub>  | Line regulation                                                           | I <sub>OUT</sub> = 300 mA                                                   | –0.5%                                   |      | 0.5% |      |
| ΔV <sub>OUT</sub> /ΔI <sub>OUT</sub> | Load regulation                                                           | I <sub>OUT</sub> = 10 mA to 600 mA                                          | –2%                                     |      | 2%   |      |
| I <sub>OCP</sub>                     | Overcurrent protection                                                    | Measured with output shorted to ground                                      | 0.65                                    | 1.25 |      | A    |
| V <sub>TH_PG</sub>                   | Power good assertion threshold in percentage of target V <sub>OUT</sub>   | V <sub>OUT</sub> rising                                                     |                                         | 108% |      |      |
|                                      |                                                                           | V <sub>OUT</sub> falling                                                    |                                         | 92%  |      |      |
| t <sub>STARTUP</sub>                 | Start-up time                                                             | Measured from EN = H to reach 95% of final value, C <sub>OUT</sub> = 4.7 μF |                                         |      | 500  | μs   |
| I <sub>Q</sub>                       | Quiescent current                                                         | I <sub>OUT</sub> = 0 A                                                      |                                         | 20   |      | μA   |

(1) It must be equal to or greater than 1.62 V.

## Electrical Characteristics: LDOs (continued)

over recommended input voltage range,  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and  $T_A = 25^{\circ}\text{C}$  for typical values (unless otherwise noted)

| PARAMETER                            |                                                                           | TEST CONDITIONS                                                                                                              | MIN  | TYP                 | MAX | UNIT |
|--------------------------------------|---------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------|------|---------------------|-----|------|
| LDOA2 and LDOA3 (continued)          |                                                                           |                                                                                                                              |      |                     |     |      |
| PSRR                                 | Power supply rejection ratio                                              | f = 1 kHz, V <sub>IN</sub> = 1.8 V, V <sub>OUT</sub> = 1.2 V, I <sub>OUT</sub> = 300 mA, C <sub>OUT</sub> = 2.2 μF – 4.7 μF  |      | 48                  |     | dB   |
|                                      |                                                                           | f = 10 kHz, V <sub>IN</sub> = 1.8 V, V <sub>OUT</sub> = 1.2 V, I <sub>OUT</sub> = 300 mA, C <sub>OUT</sub> = 2.2 μF – 4.7 μF |      | 30                  |     | dB   |
| C <sub>OUT</sub>                     | External output capacitance                                               |                                                                                                                              | 2.2  | 4.7                 | 10  | μF   |
|                                      | ESR                                                                       |                                                                                                                              |      |                     | 100 | mΩ   |
| R <sub>DIS</sub>                     | Output auto-discharge resistance                                          | LDOAx_DIS[1:0] = 01b                                                                                                         |      | 80                  |     | Ω    |
|                                      |                                                                           | LDOAx_DIS[1:0] = 10b                                                                                                         |      | 180                 |     |      |
|                                      |                                                                           | LDOAx_DIS[1:0] = 11b                                                                                                         |      | 475                 |     |      |
| VTT LDO                              |                                                                           |                                                                                                                              |      |                     |     |      |
| V <sub>IN</sub>                      | Power input voltage                                                       |                                                                                                                              |      | 1.2                 | 3.3 | V    |
| V <sub>OUT</sub>                     | DC output voltage                                                         | V <sub>IN</sub> = 1.2 V, Measured at VTTFB pin                                                                               |      | V <sub>IN</sub> / 2 |     | V    |
|                                      | DC output voltage accuracy                                                | Relative to V <sub>IN</sub> / 2, I <sub>OUT</sub> ≤ 10 mA, 1.1 V ≤ V <sub>IN</sub> ≤ 1.35 V                                  | –10  |                     | 10  | mV   |
|                                      |                                                                           | Relative to V <sub>IN</sub> / 2, I <sub>OUT</sub> ≤ 500 mA, 1.1 V ≤ V <sub>IN</sub> ≤ 1.35 V                                 | –25  |                     | 25  |      |
| I <sub>OUT</sub>                     | DC output current                                                         | sink(–) and source(+)                                                                                                        | –500 |                     | 500 | mA   |
| ΔV <sub>OUT</sub> /ΔI <sub>OUT</sub> | Load regulation                                                           | 1.1 V ≤ V <sub>IN</sub> ≤ 1.35 V, I <sub>OUT</sub> = –500 mA to 500 mA                                                       | –4%  |                     | 4%  |      |
| I <sub>OCP</sub>                     | Overcurrent protection                                                    | Measured with output shorted to ground                                                                                       | 0.95 |                     |     | A    |
| V <sub>TH_PG</sub>                   | Power good deassertion threshold in percentage of target V <sub>OUT</sub> | V <sub>OUT</sub> rising                                                                                                      |      | 110%                |     |      |
|                                      |                                                                           | V <sub>OUT</sub> falling                                                                                                     |      | 95%                 |     |      |
| V <sub>TH_HYS_PG</sub>               | Power good reassertion hysteresis entering back into V <sub>TH_PG</sub>   |                                                                                                                              |      | 5%                  |     |      |
| I <sub>Q</sub>                       | Total ground current                                                      | V <sub>IN</sub> = 1.2 V, I <sub>OUT</sub> = 0 A                                                                              |      |                     | 240 | μA   |
| I <sub>LKG</sub>                     | OFF leakage current                                                       | V <sub>IN</sub> = 1.2 V, disabled                                                                                            |      |                     | 1   | μA   |
| C <sub>IN</sub>                      | External input capacitance                                                |                                                                                                                              | 10   |                     |     | μF   |
| C <sub>OUT</sub>                     | External output capacitance                                               |                                                                                                                              | 35   |                     |     | μF   |
| R <sub>DIS</sub>                     | Output auto-discharge resistance                                          | VTT_DIS = 0b                                                                                                                 | 1000 |                     |     | kΩ   |
|                                      |                                                                           | VTT_DIS = 1b                                                                                                                 | 60   | 80                  | 100 | Ω    |

## 4.10 Electrical Characteristics: Load Switches

over operating free-air temperature range (unless otherwise noted)

| PARAMETER              |                                                                           | TEST CONDITIONS                                                                                                    | MIN | TYP  | MAX  | UNIT |
|------------------------|---------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------|-----|------|------|------|
| SWA1                   |                                                                           |                                                                                                                    |     |      |      |      |
| V <sub>IN</sub>        | Input voltage range                                                       |                                                                                                                    | 0.5 | 1.5  | 3.3  | V    |
| I <sub>OUT</sub>       | DC output current                                                         |                                                                                                                    |     |      | 300  | mA   |
| R <sub>DS(on)</sub>    | ON resistance                                                             | V <sub>IN</sub> = 1.8 V, measured from PVINSWA1 pin to SWA1 pin at I <sub>OUT</sub> = I <sub>OUT,MAX</sub>         |     | 60   | 93   | mΩ   |
|                        |                                                                           | V <sub>IN</sub> = 3.3 V, measured from PVINSWA1 pin to SWA1 pin at I <sub>OUT</sub> = I <sub>OUT,MAX</sub>         |     | 100  | 165  |      |
| V <sub>TH_PG</sub>     | Power good deassertion threshold in percentage of target V <sub>OUT</sub> | V <sub>OUT</sub> rising                                                                                            |     | 108% |      |      |
|                        |                                                                           | V <sub>OUT</sub> falling                                                                                           |     | 92%  |      |      |
| V <sub>TH_HYS_PG</sub> | Power good reassertion hysteresis entering back into V <sub>TH_PG</sub>   | V <sub>OUT</sub> rising or falling                                                                                 |     | 2%   |      |      |
| I <sub>INRUSH</sub>    | Inrush current upon turnon                                                | V <sub>IN</sub> = 3.3 V, C <sub>OUT</sub> = 0.1 μF                                                                 |     |      | 10   | mA   |
| I <sub>Q</sub>         | Quiescent current                                                         | V <sub>IN</sub> = 3.3 V, I <sub>OUT</sub> = 0 A                                                                    |     | 10.5 |      | μA   |
|                        |                                                                           | V <sub>IN</sub> = 1.8 V, I <sub>OUT</sub> = 0 A                                                                    |     | 9    |      |      |
| I <sub>LKG</sub>       | Leakage current                                                           | Switch disabled, V <sub>IN</sub> = 1.8 V                                                                           |     | 7    | 370  | nA   |
|                        |                                                                           | Switch disabled, V <sub>IN</sub> = 3.3 V                                                                           |     | 10   | 900  |      |
| C <sub>OUT</sub>       | External output capacitance                                               |                                                                                                                    |     | 0.1  |      | μF   |
| R <sub>DIS</sub>       | Output auto-discharge resistance                                          | SWA1_DIS[1:0] = 01                                                                                                 |     | 100  |      | Ω    |
|                        |                                                                           | SWA1_DIS[1:0] = 10                                                                                                 |     | 200  |      |      |
|                        |                                                                           | SWA1_DIS[1:0] = 11                                                                                                 |     | 500  |      |      |
| SWB1, SWB2             |                                                                           |                                                                                                                    |     |      |      |      |
| V <sub>IN</sub>        | Input voltage range                                                       |                                                                                                                    | 0.5 | 1.5  | 3.3  | V    |
| I <sub>OUT</sub>       | DC current per channel                                                    |                                                                                                                    |     |      | 400  | mA   |
| R <sub>DS(on)</sub>    | ON resistance per channel                                                 | V <sub>IN</sub> = 1.8 V, measured from PVINSWB1_B2 pin to SWB1/SWB2 pin at I <sub>OUT</sub> = I <sub>OUT,MAX</sub> |     | 68   | 92   | mΩ   |
|                        |                                                                           | V <sub>IN</sub> = 3.3 V, measured from PVINSWB1_B2 pin to SWB1/SWB2 pin at I <sub>OUT</sub> = I <sub>OUT,MAX</sub> |     | 75   | 125  | mΩ   |
| V <sub>TH_PG</sub>     | Power good deassertion threshold in percentage of target V <sub>OUT</sub> | V <sub>OUT</sub> rising                                                                                            |     | 108% |      |      |
|                        |                                                                           | V <sub>OUT</sub> falling                                                                                           |     | 92%  |      |      |
| V <sub>TH_HYS_PG</sub> | Power good reassertion hysteresis entering back into V <sub>TH_PG</sub>   | V <sub>OUT</sub> rising or falling                                                                                 |     | 2%   |      |      |
| I <sub>INRUSH</sub>    | Inrush current upon turning on                                            | V <sub>IN</sub> = 3.3 V, C <sub>OUT</sub> = 0.1 μF                                                                 |     |      | 10   | mA   |
| I <sub>Q</sub>         | Quiescent current                                                         | V <sub>IN</sub> = 3.3 V, I <sub>OUT</sub> = 0 A                                                                    |     | 10.5 |      | μA   |
|                        |                                                                           | V <sub>IN</sub> = 1.8 V, I <sub>OUT</sub> = 0 A                                                                    |     | 9    |      |      |
| I <sub>LKG</sub>       | Leakage current                                                           | Switch disabled, V <sub>IN</sub> = 1.8 V                                                                           |     | 7    | 460  | nA   |
|                        |                                                                           | Switch disabled, V <sub>IN</sub> = 3.3 V                                                                           |     | 10   | 1150 |      |
| C <sub>OUT</sub>       | External output capacitance                                               |                                                                                                                    |     | 0.1  |      | μF   |
| R <sub>DIS</sub>       | Output auto-discharge resistance                                          | SWBx_DIS[1:0] = 01                                                                                                 |     | 100  |      | Ω    |
|                        |                                                                           | SWBx_DIS[1:0] = 10                                                                                                 |     | 200  |      |      |
|                        |                                                                           | SWBx_DIS[1:0] = 11                                                                                                 |     | 500  |      |      |

#### 4.11 Digital Signals: I<sup>2</sup>C Interface

over recommended free-air temperature range and over recommended input voltage range (typical values are at T<sub>A</sub> = 25°C) (unless otherwise noted)

| PARAMETER            |                                | TEST CONDITIONS              | MIN | TYP  | MAX | UNIT |
|----------------------|--------------------------------|------------------------------|-----|------|-----|------|
| V <sub>OL</sub>      | Low-level output voltage       | V <sub>PULL_UP</sub> = 1.8 V |     |      | 0.4 | V    |
| V <sub>IH</sub>      | High-level input voltage       |                              | 1.2 |      |     | V    |
| V <sub>IL</sub>      | Low-level input voltage        |                              |     |      | 0.4 | V    |
| I <sub>LKG</sub>     | Leakage current                | V <sub>PULL_UP</sub> = 1.8 V |     | 0.01 | 0.3 | μA   |
| R <sub>PULL-UP</sub> | Pullup resistance              | Standard mode                |     |      | 8.5 | kΩ   |
|                      |                                | Fast mode                    |     |      | 2.5 |      |
|                      |                                | Fast mode plus               |     |      | 1   |      |
| C <sub>OUT</sub>     | Total load capacitance per pin |                              |     |      | 50  | pF   |

#### 4.12 Digital Input Signals (CTLx)

over recommended free-air temperature range and over recommended input voltage range (typical values are at T<sub>A</sub> = 25°C) (unless otherwise noted)

| PARAMETER       |                          | TEST CONDITIONS | MIN  | TYP | MAX | UNIT |
|-----------------|--------------------------|-----------------|------|-----|-----|------|
| V <sub>IH</sub> | High-level input voltage |                 | 0.85 |     |     | V    |
| V <sub>IL</sub> | Low-level input voltage  |                 |      |     | 0.4 | V    |

#### 4.13 Digital Output Signals (IRQB, GPOx)

over recommended free-air temperature range and over recommended input voltage range (typical values are at T<sub>A</sub> = 25°C) (unless otherwise noted)

| PARAMETER        |                          | TEST CONDITIONS              | MIN | TYP | MAX  | UNIT |
|------------------|--------------------------|------------------------------|-----|-----|------|------|
| V <sub>OL</sub>  | Low-level output voltage | I <sub>OL</sub> < 2 mA       |     |     | 0.4  | V    |
| I <sub>LKG</sub> | Leakage current          | V <sub>PULL_UP</sub> = 1.8 V |     |     | 0.35 | μA   |

#### 4.14 Timing Requirements

over recommended free-air temperature range and over recommended input voltage range (typical values are at T<sub>A</sub> = 25°C) (unless otherwise noted)

|                                 |                                  | MIN | NOM | MAX  | UNIT |
|---------------------------------|----------------------------------|-----|-----|------|------|
| <b>I<sup>2</sup>C INTERFACE</b> |                                  |     |     |      |      |
| f <sub>CLK</sub>                | Clock frequency (standard mode)  |     |     | 100  | kHz  |
|                                 | Clock frequency (fast mode)      |     |     | 400  | kHz  |
|                                 | Clock frequency (fast mode plus) |     |     | 1000 | kHz  |
| t <sub>r</sub>                  | Rise time (standard mode)        |     |     | 1000 | ns   |
|                                 | Rise time (fast mode)            |     |     | 300  | ns   |
|                                 | Rise time (fast mode plus)       |     |     | 120  | ns   |
| t <sub>f</sub>                  | Rise time (standard mode)        |     |     | 300  | ns   |
|                                 | Rise time (fast mode)            |     |     | 300  | ns   |
|                                 | Rise time (fast mode plus)       |     |     | 120  | ns   |

## 4.15 Switching Characteristics

over operating free-air temperature range and over recommended input voltage range (typical values are at  $T_A = 25^\circ\text{C}$ ) (unless otherwise noted)

| PARAMETER            |                         | TEST CONDITIONS                                                                                                                | MIN | TYP  | MAX  | UNIT |
|----------------------|-------------------------|--------------------------------------------------------------------------------------------------------------------------------|-----|------|------|------|
| BUCK CONTROLLERS     |                         |                                                                                                                                |     |      |      |      |
| t <sub>PG</sub>      | Total turnon time       | Measured from enable going high to when output reaches 90% of target value.                                                    |     | 550  | 850  | μs   |
| T <sub>ON,MIN</sub>  | Minimum on-time of DRVH |                                                                                                                                |     | 50   |      | ns   |
| T <sub>DEAD</sub>    | Driver dead-time        | DRVH off to DRVL on                                                                                                            |     | 15   |      | ns   |
|                      |                         | DRVL off to DRVH on                                                                                                            |     | 30   |      | ns   |
| f <sub>SW</sub>      | Switching frequency     | Continuous-conduction mode, V <sub>IN</sub> = 13 V, V <sub>OUT</sub> ≥ 1 V                                                     |     | 1000 |      | kHz  |
| BUCK CONVERTERS      |                         |                                                                                                                                |     |      |      |      |
| t <sub>PG</sub>      | Total turnon time       | Measured from enable going high to when output reaches 90% of target value.                                                    |     | 250  | 1000 | μs   |
| f <sub>SW</sub>      | Switching frequency     | Continuous-conduction mode, V <sub>OUT</sub> = 1 V, I <sub>OUT</sub> = 1 A                                                     |     | 1.6  |      | MHz  |
|                      |                         | Continuous-conduction mode, V <sub>OUT</sub> = 1.05 V, I <sub>OUT</sub> = 1 A                                                  |     | 1.7  |      | MHz  |
|                      |                         | Continuous-conduction mode, V <sub>OUT</sub> = 1.24 V, I <sub>OUT</sub> = 1 A                                                  |     | 1.9  |      | MHz  |
|                      |                         | Continuous-conduction mode, V <sub>OUT</sub> = 1.35 V, I <sub>OUT</sub> = 1 A                                                  |     | 2    |      | MHz  |
|                      |                         | Continuous-conduction mode, V <sub>OUT</sub> = 1.8 V, I <sub>OUT</sub> = 1 A                                                   |     | 2.5  |      | MHz  |
| LDOAx                |                         |                                                                                                                                |     |      |      |      |
| t <sub>STARTUP</sub> | Start-up time           | Measured from enable going high to when output reaches 95% of final value, V <sub>OUT</sub> = 1.2 V, C <sub>OUT</sub> = 4.7 μF |     | 180  |      | μs   |
| VTT LDO              |                         |                                                                                                                                |     |      |      |      |
| t <sub>STARTUP</sub> | Start-up time           | Measured from enable going high to PG assertion, V <sub>OUT</sub> = 0.675 V, C <sub>OUT</sub> = 40 μF                          |     | 22   |      | μs   |
| SWA1                 |                         |                                                                                                                                |     |      |      |      |
| t <sub>TURN-ON</sub> | Turnon time             | Measured from enable going high to reach 95% of final value, V <sub>IN</sub> = 3.3 V, C <sub>OUT</sub> = 0.1 μF                |     | 0.85 |      | ms   |
|                      |                         | Measured from enable going high to reach 95% of final value, V <sub>IN</sub> = 1.8 V, C <sub>OUT</sub> = 0.1 μF                |     | 0.63 |      | ms   |
| SWB1_2               |                         |                                                                                                                                |     |      |      |      |
| t <sub>TURN-ON</sub> | Turnon time             | Measured from enable going high to reach 95% of final value, V <sub>IN</sub> = 3.3 V, C <sub>OUT</sub> = 0.1 μF                |     | 1.1  |      | ms   |
|                      |                         | Measured from enable going high to reach 95% of final value, V <sub>IN</sub> = 1.8 V, C <sub>OUT</sub> = 0.1 μF                |     | 0.82 |      | ms   |

## 4.16 Typical Characteristics

Measurements done at 25°C.

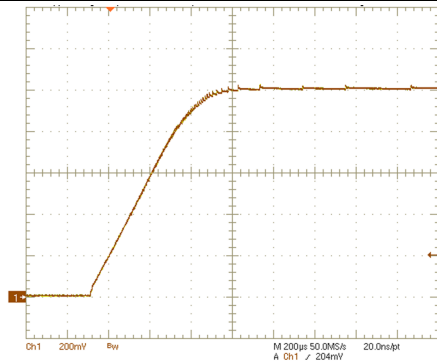


图 4-1. BUCK2 Controller Start Up to 1 V by I²C

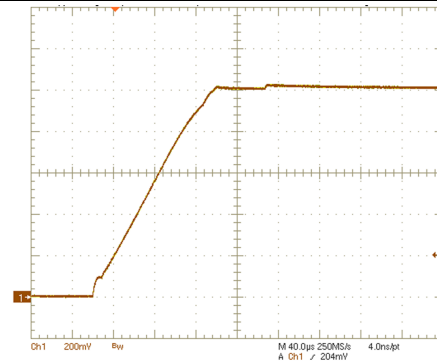


图 4-2. Converter Start Up to 1 V by I²C

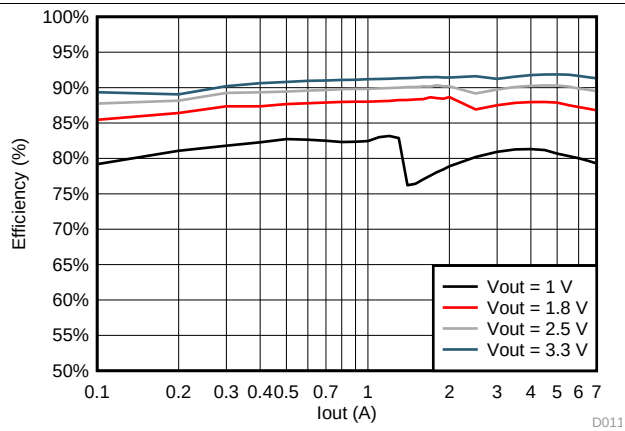


图 4-3. BUCK6 Efficiency at  $V_{IN} = 13\text{ V}$

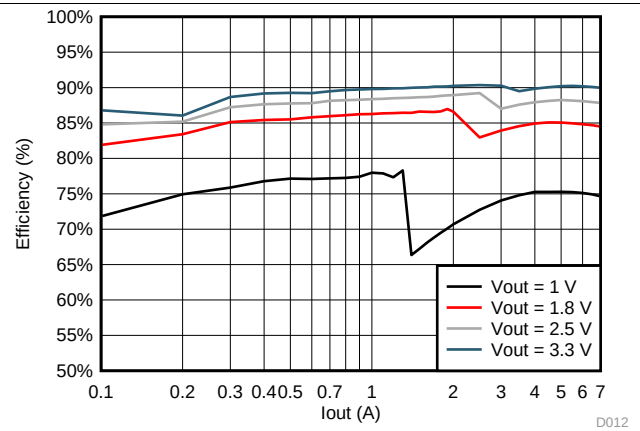


图 4-4. BUCK6 Efficiency at  $V_{IN} = 18\text{ V}$

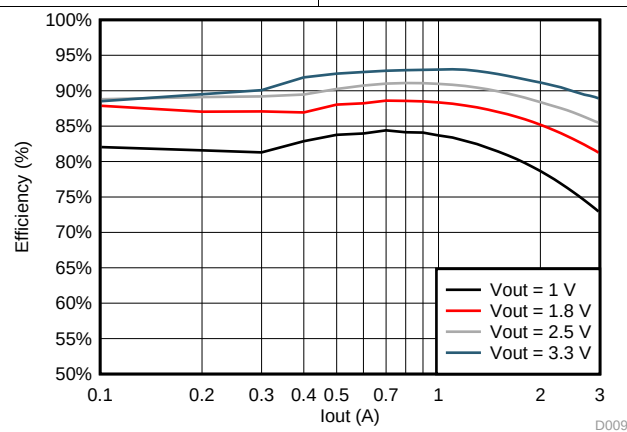


图 4-5. Converter Efficiency at  $V_{IN} = 5\text{ V}$

## 5 Detailed Description

### 5.1 Overview

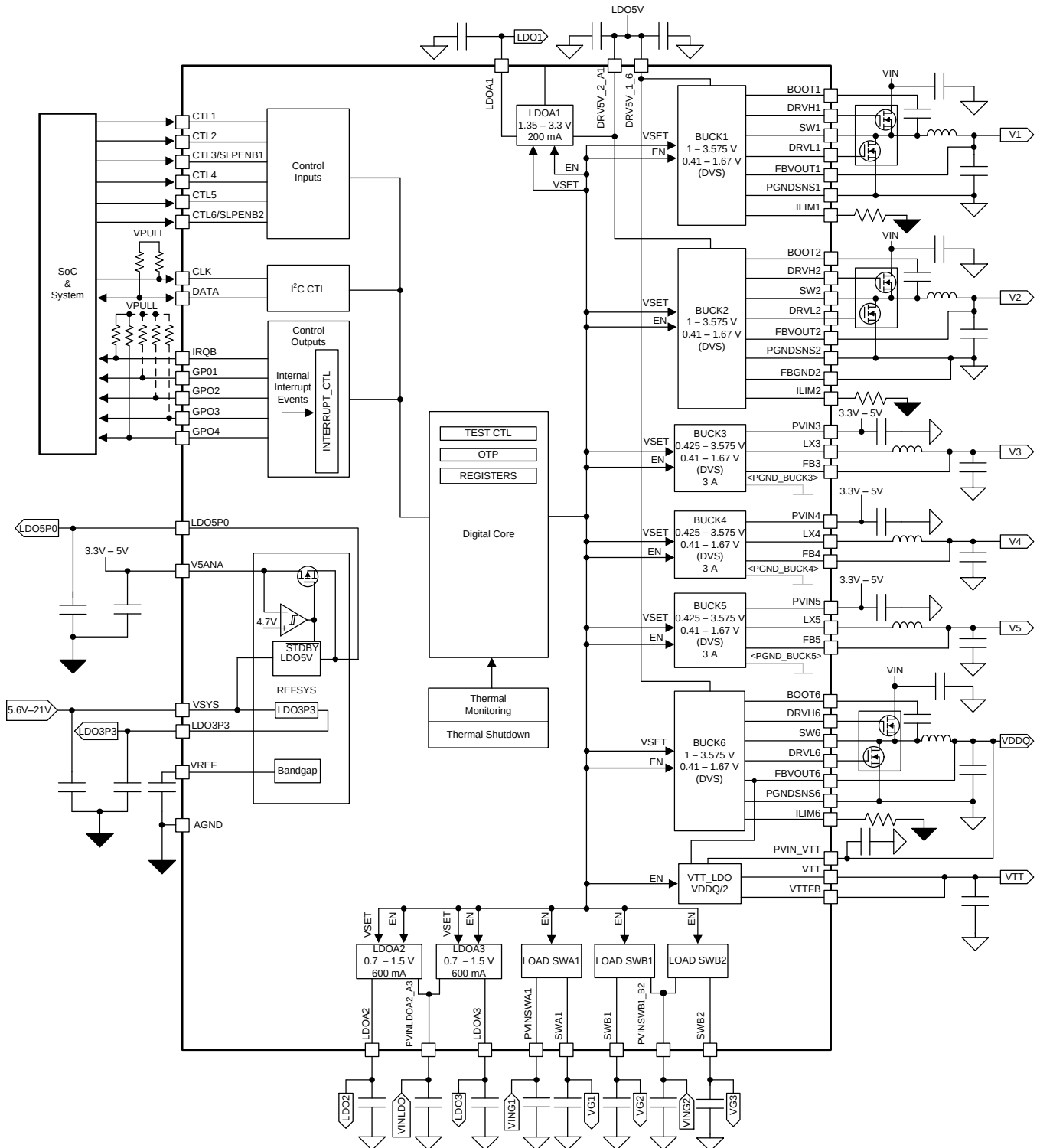
The TPS6508700 power-management integrated circuit (PMIC) provides all the required power supplies for the AMD Family 17h Models 10h-1Fh Processors. The PMIC has the following integrated components: three step-down controllers (BUCK1, BUCK2, and BUCK6), three step-down converters (BUCK3, BUCK4, and BUCK5), a sink or source LDO (VTT LDO), three low-voltage  $V_{IN}$  LDOs (LDOA1–LDOA3), and three load switches (SWA1, SWB1, and SWB2). With on-chip, one-time programmable (OTP) memory, configuration of each rail for the default output value, power-up sequence, fault handling, and power good mapping into a GPO pin are all conveniently flexible. All voltage rails (VRs) have a built-in discharge resistor, and the value can be changed using the DISCHCNT1–DISCHCNT3 and LDOA1\_CTRL registers. When enabling a VR, the PMIC automatically disconnects the discharge resistor for that rail without any I<sup>2</sup>C command. 表 5-1 lists the key characteristics of the voltage rails.

**表 5-1. Summary of Voltage Regulators**

| RAIL      | TYPE                 | INPUT VOLTAGE (V) |      | OUTPUT VOLTAGE RANGE (V) |                          |       | CURRENT (mA)       |
|-----------|----------------------|-------------------|------|--------------------------|--------------------------|-------|--------------------|
|           |                      | MIN               | MAX  | MIN                      | TYP                      | MAX   |                    |
| BUCK1     | Step-down controller | 4.5               | 21   |                          | 5 V by external feedback |       | Scalable           |
| BUCK2     | Step-down controller | 4.5               | 21   | 0.41                     | 0.8                      | 1.67  | Scalable           |
| BUCK3     | Step-down converter  | 4.5               | 5.5  | 0.425                    | 1.8                      | 3.575 | 3000               |
| BUCK4     | Step-down converter  | 4.5               | 5.5  | 0.425                    | 0.8                      | 3.575 | 3000               |
| BUCK5     | Step-down converter  | 4.5               | 5.5  | 0.425                    | 1.8                      | 3.575 | 3000               |
| BUCK6     | Step-down controller | 4.5               | 21   | 1                        | 3.3                      | 3.575 | Scalable           |
| LDOA1     | LDO                  | 4.5               | 5.5  | 1.35                     | 3.3                      | 3.3   | 200 <sup>(1)</sup> |
| LDOA2     | LDO                  | 1.62              | 1.98 | 0.7                      | 1.5                      | 1.5   | 600                |
| LDOA3     | LDO                  | 1.62              | 1.98 | 0.7                      | 1.2                      | 1.5   | 600                |
| SWA1      | Load switch          | 0.5               | 3.3  |                          | 1.5                      |       | 300                |
| SWB1/SWB2 | Load switch          | 0.5               | 3.3  |                          | 1.5                      |       | 300                |
| VTT       | Sink and Source LDO  | BUCK6 output      |      |                          | $V_{BUCK6} / 2$          |       |                    |

(1) When powered from a 5-V supply through the DRV5V\_2\_A1 pin. Otherwise, max current is limited by max  $I_{OUT}$  of LDO5.

## 5.2 Functional Block Diagram



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图 5-1. PMIC Functional Block Diagram

### 5.3 SMPS Voltage Regulators

The buck controllers integrate gate drivers for external power stages with a programmable current limit (set by an external resistor at ILIMx pin), which allows for optimal selection of external passive components based on the desired system load. The buck converters include an integrated power stage and require a minimum number of pins for power input, inductor, and output voltage feedback input. Combined with high-frequency switching, all these features allow the use of inductors in a small form factor, reducing total-system cost and size.

BUCK1–BUCK6 have selectable auto-PWM and forced-PWM mode through the BUCKx\_MODE bit in the BUCKxCTRL register. In default auto-PWM mode, the VR automatically switches between pulse width modulation (PWM) and pulse frequency modulation (PFM) depending on the output load to maximize efficiency.

All controllers and converters can be set to the default output voltage ( $V_{OUT}$ ) or dynamically voltage changing at any time. This feature means that the rails can be programmed for any  $V_{OUT}$  by the factory, therefore the device starts up with the default voltage, or during operation the rail can be programmed to another operating  $V_{OUT}$  while the rail is enable or disabled. Two step sizes, or ranges, are available for  $V_{OUT}$  selection: 10-mV steps and 25-mV steps. The step-size range must be selected prior to use and must be programmed by the factory. The step-size range is not subject to programming or change during operation.

表 5-2 lists the options for the 10-mV step-size range  $V_{OUT}$ . 表 5-3 lists the options for the 25-mV step-size range  $V_{OUT}$ .

**表 5-2. 10-mV Step-Size V<sub>OUT</sub> Range**

| VID BITS | V <sub>OUT</sub> | VID BITS | V <sub>OUT</sub> | VID BITS | V <sub>OUT</sub> |
|----------|------------------|----------|------------------|----------|------------------|
| 0000000b | 0                | 0101011b | 0.83             | 1010110b | 1.26             |
| 0000001b | 0.41             | 0101100b | 0.84             | 1010111b | 1.27             |
| 0000010b | 0.42             | 0101101b | 0.85             | 1011000b | 1.28             |
| 0000011b | 0.43             | 0101110b | 0.86             | 1011001b | 1.29             |
| 0000100b | 0.44             | 0101111b | 0.87             | 1011010b | 1.30             |
| 0000101b | 0.45             | 0110000b | 0.88             | 1011011b | 1.31             |
| 0000110b | 0.46             | 0110001b | 0.89             | 1011100b | 1.32             |
| 0000111b | 0.47             | 0110010b | 0.90             | 1011101b | 1.33             |
| 0001000b | 0.48             | 0110011b | 0.91             | 1011110b | 1.34             |
| 0001001b | 0.49             | 0110100b | 0.92             | 1011111b | 1.35             |
| 0001010b | 0.50             | 0110101b | 0.93             | 1100000b | 1.36             |
| 0001011b | 0.51             | 0110110b | 0.94             | 1100001b | 1.37             |
| 0001100b | 0.52             | 0110111b | 0.95             | 1100010b | 1.38             |
| 0001101b | 0.53             | 0111000b | 0.96             | 1100011b | 1.39             |
| 0001110b | 0.54             | 0111001b | 0.97             | 1100100b | 1.40             |
| 0001111b | 0.55             | 0111010b | 0.98             | 1100101b | 1.41             |
| 0010000b | 0.56             | 0111011b | 0.99             | 1100110b | 1.42             |
| 0010001b | 0.57             | 0111100b | 1.00             | 1100111b | 1.43             |
| 0010010b | 0.58             | 0111101b | 1.01             | 1101000b | 1.44             |
| 0010011b | 0.59             | 0111110b | 1.02             | 1101001b | 1.45             |
| 0010100b | 0.60             | 0111111b | 1.03             | 1101010b | 1.46             |
| 0010101b | 0.61             | 1000000b | 1.04             | 1101011b | 1.47             |
| 0010110b | 0.62             | 1000001b | 1.05             | 1101100b | 1.48             |
| 0010111b | 0.63             | 1000010b | 1.06             | 1101101b | 1.49             |
| 0011000b | 0.64             | 1000011b | 1.07             | 1101110b | 1.50             |
| 0011001b | 0.65             | 1000100b | 1.08             | 1101111b | 1.51             |
| 0011010b | 0.66             | 1000101b | 1.09             | 1110000b | 1.52             |
| 0011011b | 0.67             | 1000110b | 1.10             | 1110001b | 1.53             |
| 0011100b | 0.68             | 1000111b | 1.11             | 1110010b | 1.54             |
| 0011101b | 0.69             | 1001000b | 1.12             | 1110011b | 1.55             |
| 0011110b | 0.70             | 1001001b | 1.13             | 1110100b | 1.56             |
| 0011111b | 0.71             | 1001010b | 1.14             | 1110101b | 1.57             |
| 0100000b | 0.72             | 1001011b | 1.15             | 1110110b | 1.58             |
| 0100001b | 0.73             | 1001100b | 1.16             | 1110111b | 1.59             |
| 0100010b | 0.74             | 1001101b | 1.17             | 1111000b | 1.60             |
| 0100011b | 0.75             | 1001110b | 1.18             | 1111001b | 1.61             |
| 0100100b | 0.76             | 1001111b | 1.19             | 1111010b | 1.62             |
| 0100101b | 0.77             | 1010000b | 1.20             | 1111011b | 1.63             |
| 0100110b | 0.78             | 1010001b | 1.21             | 1111100b | 1.64             |
| 0100111b | 0.79             | 1010010b | 1.22             | 1111101b | 1.65             |
| 0101000b | 0.80             | 1010011b | 1.23             | 1111110b | 1.66             |
| 0101001b | 0.81             | 1010100b | 1.24             | 1111111b | 1.67             |
| 0101010b | 0.82             | 1010101b | 1.25             | —        | —                |

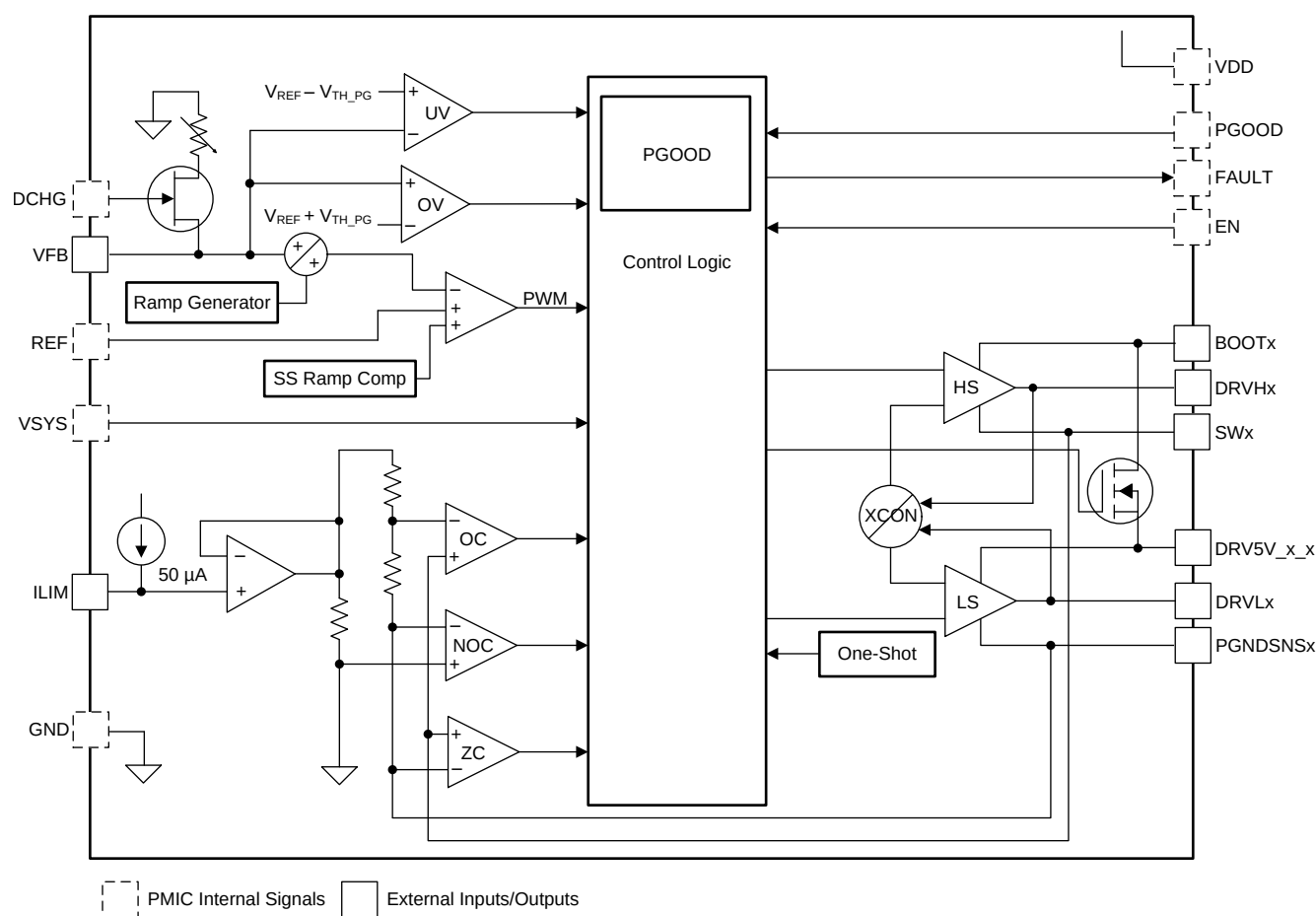
表 5-3. 25-mV Step-Size  $V_{OUT}$  Range

| VID BITS | $V_{OUT}$<br>(Converters) | $V_{OUT}$<br>(Controllers) | VID BITS | $V_{OUT}$ | VID BITS | $V_{OUT}$ |
|----------|---------------------------|----------------------------|----------|-----------|----------|-----------|
| 0000000b | 0                         | 1.000                      | 0101011b | 1.475     | 1010110b | 2.550     |
| 0000001b | 0.425                     | 1.000                      | 0101100b | 1.500     | 1010111b | 2.575     |
| 0000010b | 0.450                     | 1.000                      | 0101101b | 1.525     | 1011000b | 2.600     |
| 0000011b | 0.475                     | 1.000                      | 0101110b | 1.550     | 1011001b | 2.625     |
| 0000100b | 0.500                     | 1.000                      | 0101111b | 1.575     | 1011010b | 2.650     |
| 0000101b | 0.525                     | 1.000                      | 0110000b | 1.600     | 1011011b | 2.675     |
| 0000110b | 0.550                     | 1.000                      | 0110001b | 1.625     | 1011100b | 2.700     |
| 0000111b | 0.575                     | 1.000                      | 0110010b | 1.650     | 1011101b | 2.725     |
| 0001000b | 0.600                     | 1.000                      | 0110011b | 1.675     | 1011110b | 2.750     |
| 0001001b | 0.625                     | 1.000                      | 0110100b | 1.700     | 1011111b | 2.775     |
| 0001010b | 0.650                     | 1.000                      | 0110101b | 1.725     | 1100000b | 2.800     |
| 0001011b | 0.675                     | 1.000                      | 0110110b | 1.750     | 1100001b | 2.825     |
| 0001100b | 0.700                     | 1.000                      | 0110111b | 1.775     | 1100010b | 2.850     |
| 0001101b | 0.725                     | 1.000                      | 0111000b | 1.800     | 1100011b | 2.875     |
| 0001110b | 0.750                     | 1.000                      | 0111001b | 1.825     | 1100100b | 2.900     |
| 0001111b | 0.775                     | 1.000                      | 0111010b | 1.850     | 1100101b | 2.925     |
| 0010000b | 0.800                     | 1.000                      | 0111011b | 1.875     | 1100110b | 2.950     |
| 0010001b | 0.825                     | 1.000                      | 0111100b | 1.900     | 1100111b | 2.975     |
| 0010010b | 0.850                     | 1.000                      | 0111101b | 1.925     | 1101000b | 3.000     |
| 0010011b | 0.875                     | 1.000                      | 0111110b | 1.950     | 1101001b | 3.025     |
| 0010100b | 0.900                     | 1.000                      | 0111111b | 1.975     | 1101010b | 3.050     |
| 0010101b | 0.925                     | 1.000                      | 1000000b | 2.000     | 1101011b | 3.075     |
| 0010110b | 0.950                     | 1.000                      | 1000001b | 2.025     | 1101100b | 3.100     |
| 0010111b | 0.975                     | 1.000                      | 1000010b | 2.050     | 1101101b | 3.125     |
| 0011000b | 1.000                     | 1.000                      | 1000011b | 2.075     | 1101110b | 3.150     |
| 0011001b | 1.025                     | 1.025                      | 1000100b | 2.100     | 1101111b | 3.175     |
| 0011010b | 1.050                     | 1.050                      | 1000101b | 2.125     | 1110000b | 3.200     |
| 0011011b | 1.075                     | 1.075                      | 1000110b | 2.150     | 1110001b | 3.225     |
| 0011100b | 1.100                     | 1.100                      | 1000111b | 2.175     | 1110010b | 3.250     |
| 0011101b | 1.125                     | 1.125                      | 1001000b | 2.200     | 1110011b | 3.275     |
| 0011110b | 1.150                     | 1.150                      | 1001001b | 2.225     | 1110100b | 3.300     |
| 0011111b | 1.175                     | 1.175                      | 1001010b | 2.250     | 1110101b | 3.325     |
| 0100000b | 1.200                     | 1.200                      | 1001011b | 2.275     | 1110110b | 3.350     |
| 0100001b | 1.225                     | 1.225                      | 1001100b | 2.300     | 1110111b | 3.375     |
| 0100010b | 1.250                     | 1.250                      | 1001101b | 2.325     | 1111000b | 3.400     |
| 0100011b | 1.275                     | 1.275                      | 1001110b | 2.350     | 1111001b | 3.425     |
| 0100100b | 1.300                     | 1.300                      | 1001111b | 2.375     | 1111010b | 3.450     |
| 0100101b | 1.325                     | 1.325                      | 1010000b | 2.400     | 1111011b | 3.475     |
| 0100110b | 1.350                     | 1.350                      | 1010001b | 2.425     | 1111100b | 3.500     |
| 0100111b | 1.375                     | 1.375                      | 1010010b | 2.450     | 1111101b | 3.525     |
| 0101000b | 1.400                     | 1.400                      | 1010011b | 2.475     | 1111110b | 3.550     |
| 0101001b | 1.425                     | 1.425                      | 1010100b | 2.500     | 1111111b | 3.575     |
| 0101010b | 1.450                     | 1.450                      | 1010101b | 2.525     | —        | —         |

### 5.3.1 Controller Overview

The controllers are fast-reacting, high-frequency, scalable output-power controllers capable of driving two external N-MOSFETs. The controllers use the D-CAP2 control scheme that optimizes transient responses at high load currents for such applications as CORE and DDR supplies. The output voltage is compared with an internal reference voltage after divider resistors. The PWM comparator determines the timing to turn on the high-side MOSFET. The PWM comparator response maintains a very small PWM output ripple voltage. Because the device does not have a dedicated oscillator for the on-board control loop, the switching cycle is controlled by the adaptive on-time circuit. The on-time is controlled to meet the target switching frequency by feed-forwarding the input and output voltage into the on-time one-shot timer.

The D-CAP2 control scheme has an injected ripple from the SW node that is added on to the reference voltage to simulate output ripple, which eliminates the need for ESR-induced output ripple from D-CAP mode control. Therefore, low-ESR output capacitors (such as low-cost ceramic MLCC capacitors) can be used with the controllers. 图 5-2 shows the block diagram for the controller



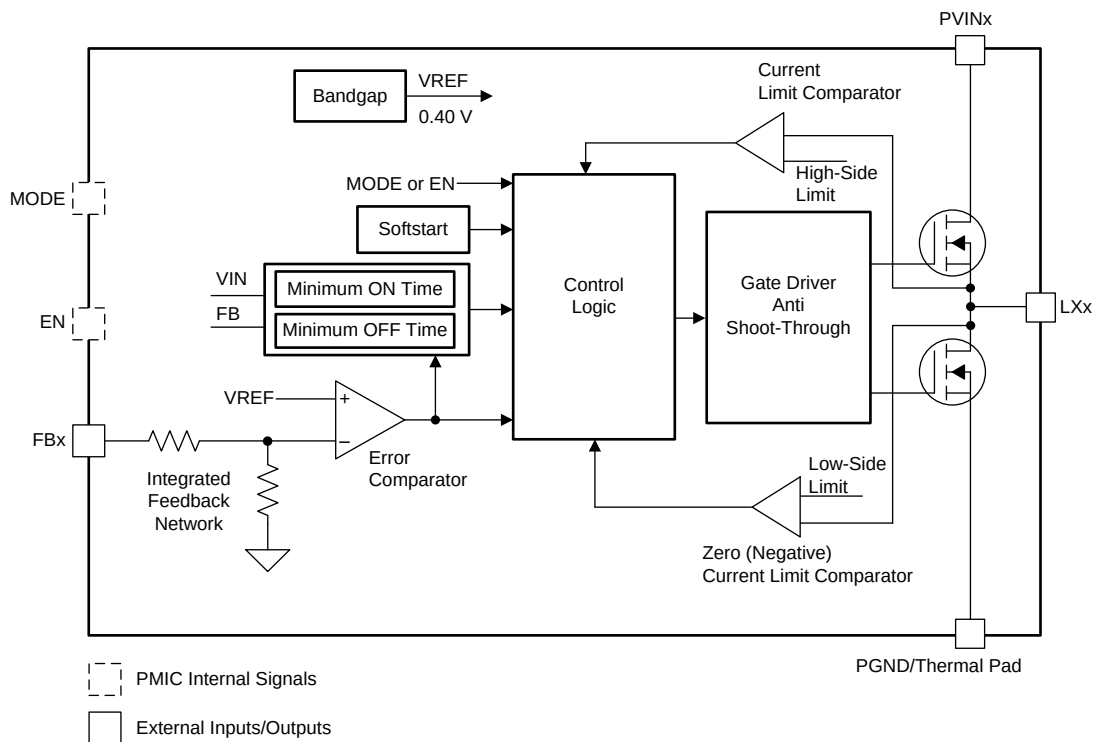
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图 5-2. Controller Block Diagram

### 5.3.2 Converter Overview

The PMIC synchronous step-down DC-DC converters include a unique, hysteretic PWM-controller scheme which enables a high switching-frequency converter, excellent transient and AC load regulation as well as operation with cost-competitive external components. The controller topology supports forced PWM mode as well as power-save mode operation. Power-save mode operation, or PFM mode, reduces the quiescent current consumption and ensures high conversion efficiency at light loads by skipping switch pulses. In forced PWM mode, the device operates on a quasi-fixed frequency, avoids pulse skipping, and allows filtering of the switch noise by external filter components. The PMIC device offers fixed output voltage options featuring a small solution size by using only three external components per converter.

A significant advantage of a PMIC over other hysteretic PWM controller topologies is the excellent AC load transient regulation capability of PMICs. When the output voltage falls below the threshold of the error comparator, a switch pulse is initiated, and the high-side switch is turned on. The switch remains turned on until a minimum on-time ( $t_{ONmin}$ ) expires and the output voltage trips the threshold of the error comparator, or until the inductor current reaches the current limit of the high-side switch. When the high-side switch turns off, the low-side switch rectifier is turned on and the inductor current ramps down until the high-side switch turns on again or the inductor current reaches zero. In forced PWM mode operation, negative inductor current is allowed to enable continuous conduction mode even at no load condition.



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图 5-3. Converter Block Diagram

### 5.3.3 Dynamic Voltage Scaling

The buck regulators (BUCK1 through BUCK6) support dynamic voltage scaling (DVS) for maximum system efficiency. The VR outputs can slew up and slew down in either 10-mV or 25-mV steps using the 7-bit voltage ID (VID) defined in [Section 4.7](#) and [Section 4.8](#). The DVS slew rate is 2.5 mV/μs (minimum). To meet the minimum slew rate, VID progresses to the next code at 3-μs (nominal) interval per 10-mV or at 6-μs interval per 25-mV steps. When DVS is active, the VR is forced into PWM mode, unless the BUCKx\_DECAY bit is 1b, to ensure the output keeps track of the VID code with minimal delay. Additionally, the PGOOD bits (in the PG\_STATUS1 and PG\_STATUS2 registers) are masked when DVS is in progress. [图 5-4](#) shows an example of slew down and slew up from one VID to another (step size of 10 mV).

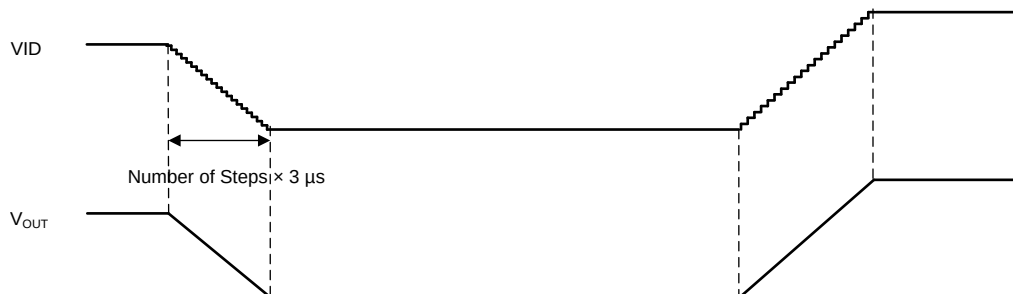


图 5-4. DVS Timing Diagram I (BUCKx\_DECAY = 0b)

When DVS is enabled and the BUCKx\_VID[6:0] bit is set to any setting except 0b or 1b, the slew rate of the voltage is as shown in [图 5-4](#).

As shown in [图 5-5](#), if a BUCKx\_VID[6:0] bit is set to 0000000b, the output voltage of that buck slews down to 0.5 V first, and then drifts down to 0 V as the SMPS stops switching. Subsequently, if a BUCKx\_VID[6:0] bit is set to a value (neither 0000000b nor 0000001b) when the output voltage of that buck is less than 0.5 V, the VR ramps up to 0.5 V first and the soft-start time begins. The output voltage then slews up to the target voltage of the previously mentioned slew rate.

#### 注

A fixed 200 μs of soft-start time is reserved for the output voltage to reach 0.5 V. In this case, however, the SMPS is not forced into PWM mode as it otherwise could cause the output voltage to droop momentarily if the output voltage might have been drifting above 0.5 V for any reason.

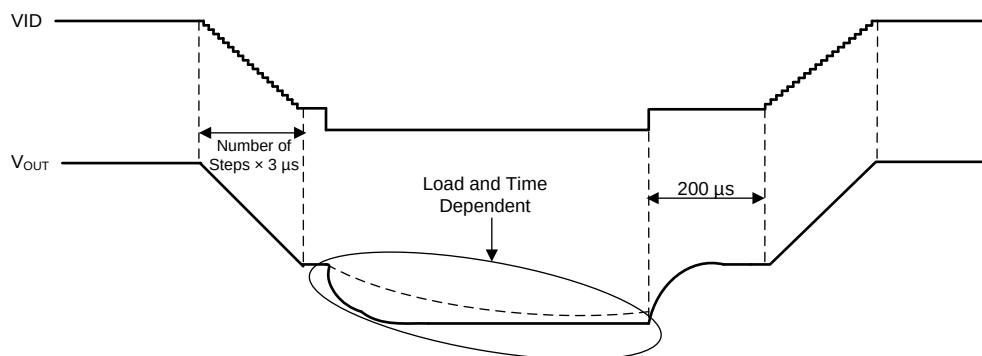


图 5-5. DVS Timing Diagram II (BUCKx\_DECAY = 0b)

### 5.3.4 Current Limit

The buck controllers (BUCK1, BUCK2, and BUCK6) have inductor-valley current-limit architecture and the current limit is programmable by an external resistor at the ILIMx pin. 公式 1 shows the calculation for a desired resistor value, depending on specific application conditions. The  $I_{LIMREF}$  current is the current source out of the ILIMx pin that is typically 50  $\mu$ A, and  $R_{DS(on)}$  is the maximum channel resistance of the low-side FET. The scaling factor is 1.3 to consider all errors and temperature variations of  $R_{DS(on)}$ ,  $I_{LIMREF}$ , and  $R_{ILIM}$ . Finally, 8 is another scaling factor associated with the  $I_{LIMREF}$  current.

$$R_{ILIM} = \frac{R_{DS(on)} \times 8 \times 1.3 \times \left( I_{LIM} - \frac{I_{ripple(min)}}{2} \right)}{I_{LIMREF}}$$

where

- $I_{LIM}$  is the target current limit. An appropriate margin must be allowed when determining the value of  $I_{LIM}$  from the maximum DC load current of the output.
- $I_{ripple(min)}$  is the minimum peak-to-peak inductor ripple current for a given output voltage. (1)

$$I_{ripple(min)} = \frac{V_{OUT} (V_{IN(MIN)} - V_{OUT})}{L_{max} \times V_{IN(MIN)} \times f_{sw(max)}}$$

where

- $L_{max}$  is the maximum inductance.
- $f_{sw(max)}$  is the maximum switching frequency.
- $V_{IN(MIN)}$  is the minimum input voltage to the external power stage. (2)

The inductor of the buck converter limits the peak current. This current limiting is done on a cycle-by-cycle basis to the current limit ( $I_{IND\_LIM}$ ), which is specified in Section 4.8.

## 5.4 LDO Regulators and Load Switches

### 5.4.1 VTT LDO

Powered from the BUCK6 output, the VTT LDO tracks the  $V_{BUCK6}$  voltage by regulating its output to a half of its input. The LDO current limit is OTP dependent, and it is designed specifically to power DDR memory. The LDO core is a transconductance amplifier with large gain, and it drives a current output stage that either sources or sinks current depending on the deviation of VTTFB pin voltage from the target regulation voltage.

### 5.4.2 LDOA1–LDOA3

The TPS6508700 device integrates three general-purpose LDOs. LDOA1 is powered from a 5-V supply through the DRV5V\_2\_A1 pin and it can be factory configured as an always-on rail as long as a valid power supply is available at the VSYS pin. For LDOA1 output voltage options, see 表 5-4. LDOA2 and LDOA3 share a power input pin (PVINLDOA2\_A3). The output regulation voltages are set by writing to the LDOAx\_VID[3:0] bits (registers 0x9A, 0x9B, and 0xAE). For LDOA2 and LDOA3 output voltage options, See 表 5-5.

表 5-4. LDOA1 Output Voltage Options

| VID Bits | V <sub>OUT</sub> | VID Bits | V <sub>OUT</sub> | VID Bits | V <sub>OUT</sub> | VID Bits | V <sub>OUT</sub> |
|----------|------------------|----------|------------------|----------|------------------|----------|------------------|
| 0000b    | 1.35             | 0100b    | 1.8              | 1000b    | 2.3              | 1100b    | 2.85             |
| 0001b    | 1.5              | 0101b    | 1.9              | 1001b    | 2.4              | 1101b    | 3.0              |
| 0010b    | 1.6              | 0110b    | 2.0              | 1010b    | 2.5              | 1110b    | 3.3              |
| 0011b    | 1.7              | 0111b    | 2.1              | 1011b    | 2.6              | 1111b    | Not Used         |

**表 5-5. LDOA2 and LDOA3 Output Voltage Options**

| VID Bits | V <sub>OUT</sub> | VID Bits | V <sub>OUT</sub> | VID Bits | V <sub>OUT</sub> | VID Bits | V <sub>OUT</sub> |
|----------|------------------|----------|------------------|----------|------------------|----------|------------------|
| 0000b    | 0.70             | 0100b    | 0.90             | 1000b    | 1.10             | 1100b    | 1.30             |
| 0001b    | 0.75             | 0101b    | 0.95             | 1001b    | 1.15             | 1101b    | 1.35             |
| 0010b    | 0.80             | 0110b    | 1.00             | 1010b    | 1.20             | 1110b    | 1.40             |
| 0011b    | 0.85             | 0111b    | 1.05             | 1011b    | 1.25             | 1111b    | 1.50             |

### 5.4.3 Load Switches

The PMIC features three general-purpose load switches. The SWA1 switch has a dedicated power input pin (PVINSWA1). The SWB1 and SWB2 pins share one power input pin (PVINSWB1\_B2). All switches have built-in slew-rate control during startup to limit the inrush current.

## 5.5 Power Good Information (PGOOD or PG) and GPO Pins

The device provides information on status of VRs through four GPO pins along with the power-good status registers defined in [Section 5.9.47](#) and [Section 5.9.48](#). Power good information of any individual VR and load switch can be assigned to be part of the PGOOD tree as defined from [Section 5.9.37](#) to [Section 5.9.44](#). PGOOD assertion delays are programmable from 0 ms to 15 ms for GPO1, 0 ms to 100 ms for GPO2 and GPO4, and 2.5 ms to 100 ms for GPO3 as defined in [Section 5.9.19](#) and [Section 5.9.31](#) (respectively).

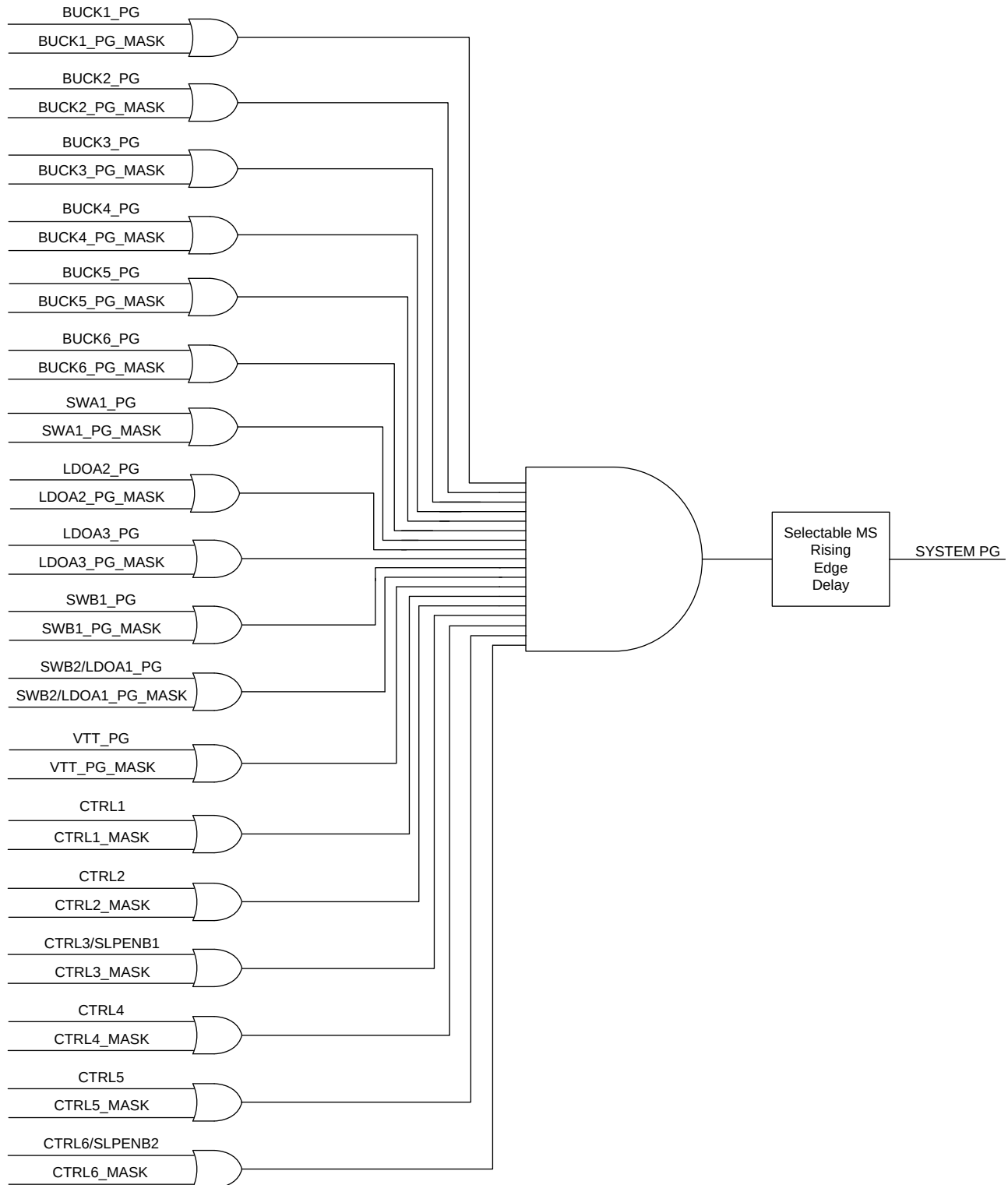


图 5-6. Power Good Tree

Alternatively, the GPOs can be used as general-purpose outputs controlled by the user through I<sup>2</sup>C. For more information on controlling the GPOs in I<sup>2</sup>C control mode, see [Section 5.9.34](#).

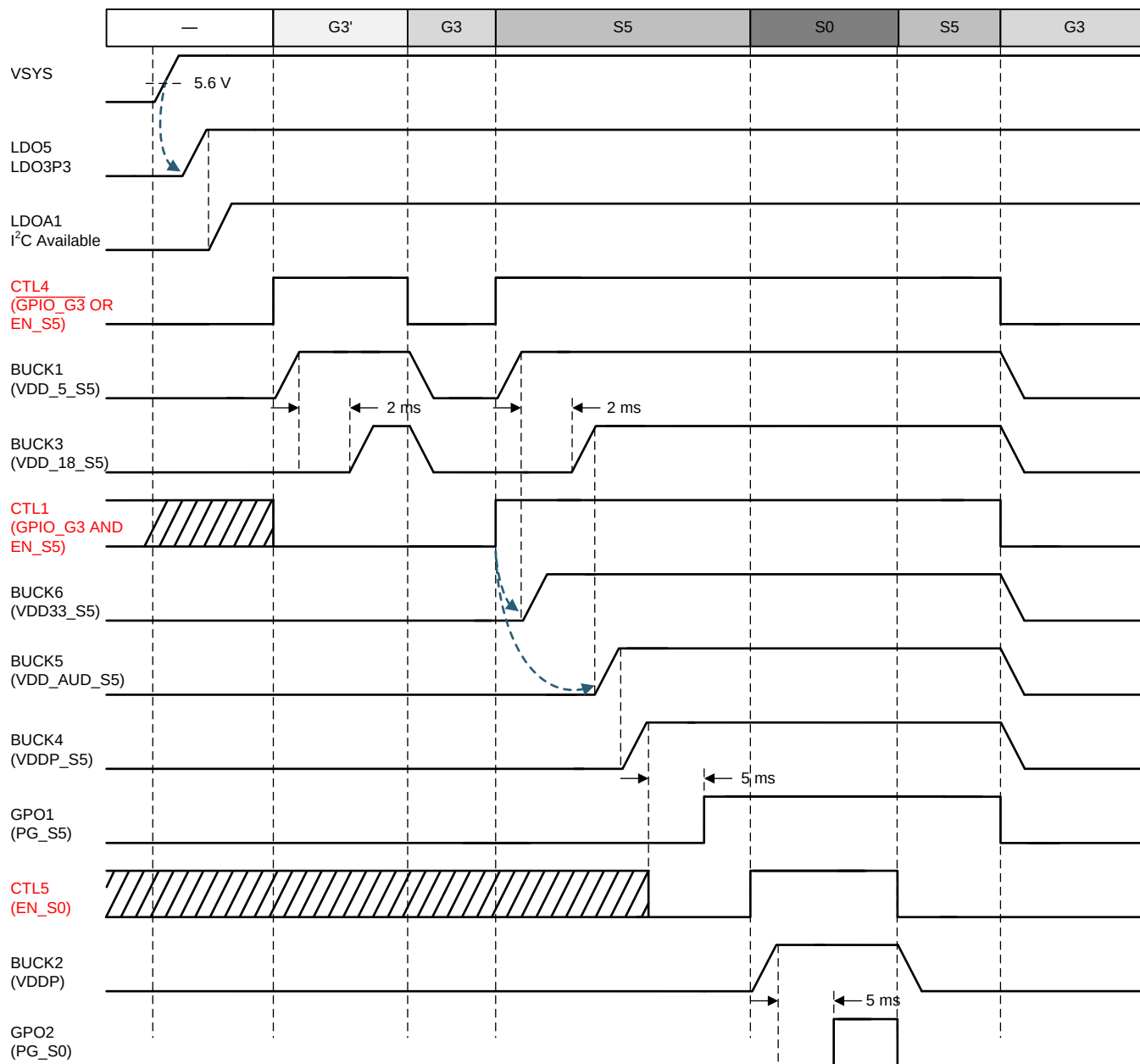
## 5.6 Power Sequencing and Voltage-Rail Control

When a valid power source is available at the VSYS pin ( $V_{SYS} \geq 5.6\text{ V}$ ), the internal analog blocks, including LDO5 and LDO3P3, are enabled. The device then has three ways of sequencing the rails during power up and power down:

- Rail enabled by CTLx pin
- Rail enabled by power good, (PG) of the previously enabled rail
- Rail enabled by I<sup>2</sup>C software command

### 5.6.1 Power-Up and Power-Down Sequencing

The power-up and power-down sequence uses the CTL1, CTL4, and CTL5 pins to enable and disable regulators as required by the system. [图 5-7](#) shows the sequencing of these enables in a typical power-up and power-down sequence.



- (1) CTLx are control signals from the discrete digital from the processor to enable the rails.
- (2) The power fault is masked for 10 ms when the regulator is enabled.

**图 5-7. Power-Up and Power-Down Sequence**

表 5-6 lists the system power states.

**表 5-6. System Power States**

| STATE    | GPIO_G3 | EN_S5 | CTL4 | CTL5 |
|----------|---------|-------|------|------|
| G3'      | 1       | 0     | 1    | 0    |
| G3'      | 1       | 1     | 1    | 0    |
| G3 state | 0       | 0     | 0    | 0    |
| S5 state | 0       | 1     | 1    | 1    |

## 5.6.2 Emergency Shutdown

图 5-8 shows the emergency shutdown sequence.

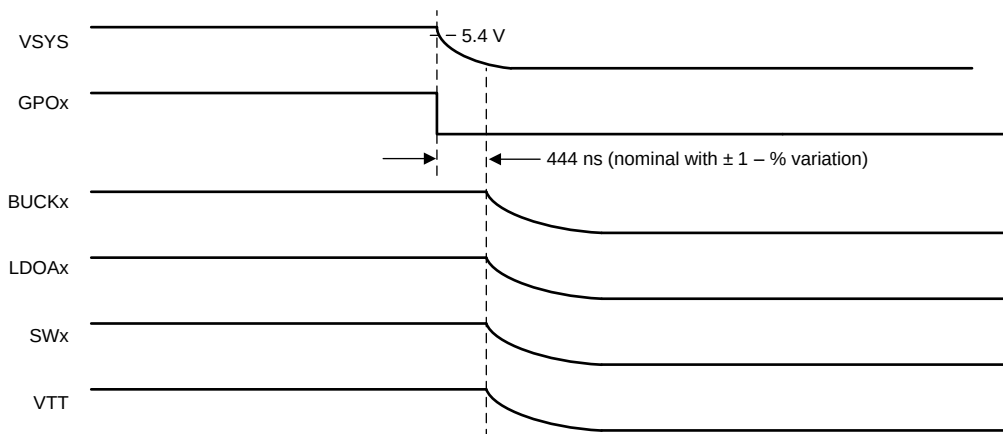


图 5-8. Emergency Shutdown Sequence

When the  $V_{SYS}$  voltage crosses below  $V_{SYS\_UVLO\_5V}$ , all power good pins are deasserted, and after 444 ns (nominal) of delay, all VRs shut down. Upon shutdown, all internal discharge resistors are set to 100  $\Omega$  to ensure timely decay of all VR outputs. Other conditions that cause emergency shutdown are the die temperature rising above the critical temperature threshold ( $T_{CRIT}$ ), and deassertion of the power good of any rail (configurable).

## 5.7 Device Functional Modes

### 5.7.1 Off Mode

When the power supply at the VSYS pin is less than  $V_{SYS\_UVLO\_5V}$  (5.4-V nominal) +  $V_{SYS\_UVLO\_5V\_HYS}$  (0.2-V nominal), the device is in off mode, where all output rails are disabled. If the supply voltage is greater than  $V_{SYS\_UVLO\_3V}$  (3.6-V nominal) +  $V_{SYS\_UVLO\_3V\_HYS}$  (0.15-V nominal) while the supply voltage is still less than  $V_{SYS\_UVLO\_5V} + V_{SYS\_UVLO\_5V\_HYS}$ , then the internal band-gap reference (VREF pin) along with LDO3P3 are enabled and regulated at target values.

### 5.7.2 Standby Mode

When the power supply at the VSYS pin rises above  $V_{SYS\_UVLO\_5V} + V_{SYS\_UVLO\_5V\_HYS}$ , the device enters standby mode, where all internal reference and regulators (LDO3P3 and LDO5) are up and running, and I<sup>2</sup>C interface and CTL pins are ready to respond. All default registers defined in Section 5.9.1 should have been loaded from one-time programmable (OTP) memory by now. Quiescent current consumption in standby mode is specified in Section 4.5.

### 5.7.3 Active Mode

The device proceeds to active mode when any output rail is enabled through an input pin as discussed in 节 5.6 or by writing to EN bits through I<sup>2</sup>C. The output regulation voltage can also be changed by writing to the VID bits defined in Section 5.9.1.

## 5.8 I<sup>2</sup>C Interface

The I<sup>2</sup>C interface is a 2-wire serial interface. The bus consists of a data line (SDA) and a clock line (SCL) with pullup structures. When the bus is idle, both SDA and SCL lines are pulled high. All the I<sup>2</sup>C compatible devices connect to the I<sup>2</sup>C bus through open drain I/O pins, DATA, and CLK. A master device, usually a microcontroller or a digital signal processor, controls the bus. The master is responsible for generating the SCL signal and device addresses. The master also generates specific conditions that indicate the START and STOP of data transfer. A slave device receives data, transmits data, or both on the bus under control of the master device.

The TPS6508700 device works as a slave and supports the following data transfer modes, as defined in the I<sup>2</sup>C-Bus Specification: standard mode (100 kbps), fast mode (400 kbps), and high-speed mode (1 Mbps). The interface adds flexibility to the power supply solution, enabling most functions to be programmed to new values depending on the instantaneous application requirements. Register contents are loaded when the  $V_{SYS}$  voltage is higher than  $V_{SYS\_UVLO\_5V}$  and is applied to the TPS6508700 device. The I<sup>2</sup>C interface is running from an internal oscillator that is automatically enabled when access to the interface is available.

The data transfer protocol for fast and standard modes are exactly the same, therefore, they are referred to as F/S-mode in this document. The protocol for high-speed mode is different from the F/S-mode, and it is referred to as H/S-mode.

The TPS6508700 device supports 7-bit addressing; however, 10-bit addressing and a general call address are not supported. The default device address is 0x5E.

### 5.8.1 F/S-Mode Protocol

The master initiates a data transfer by generating a start condition. The start condition is a high-to-low transition that occurs on the SDA line while SCL is high (see [图 5-9](#)). All I<sup>2</sup>C-compatible devices should recognize a start condition.

The master then generates the SCL pulses, and transmits the 7-bit address and the read-write direction bit, R/W, on the SDA line. During all transmissions, the master ensures that data is valid. A valid data condition requires the SDA line to be stable during the entire high period of the clock pulse (see [图 5-10](#)). All devices recognize the address sent by the master and compare it to their internal fixed addresses. Only the slave device with a matching address generates an acknowledge (see [图 5-11](#)) by pulling the SDA line low during the entire high period of the ninth SCL cycle. Upon detecting this acknowledge, the master identifies that the communication link with a slave has been established.

The master generates additional SCL cycles to either transmit data to the slave (R/W bit is 0b) or receive data from the slave (R/W bit is 1b). In either case, the receiver must acknowledge the data sent by the transmitter. An acknowledge signal can either be generated by the master or by the slave, depending on which one is the receiver. The 9-bit valid data sequences consisting of 8-bit data and 1-bit acknowledge can continue as long as required.

To signal the end of the data transfer, the master generates a stop condition by pulling the SDA line from low to high while the SCL line is high (see [图 5-9](#)). This process releases the bus and stops the communication link with the addressed slave. All I<sup>2</sup>C-compatible devices must recognize the stop condition. Upon receiving a stop condition, all devices identify that the bus is released, and wait for a start condition followed by a matching address.

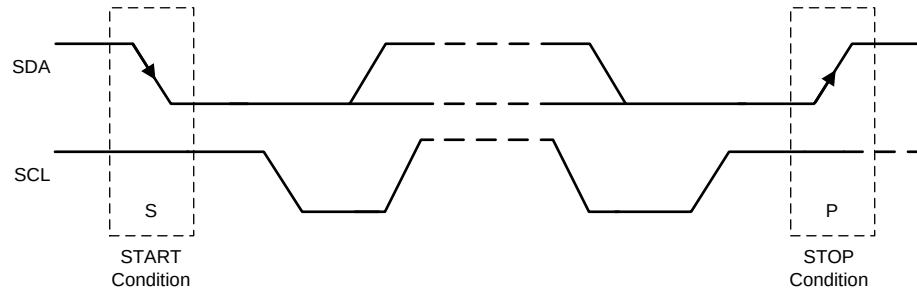


图 5-9. START and STOP Conditions

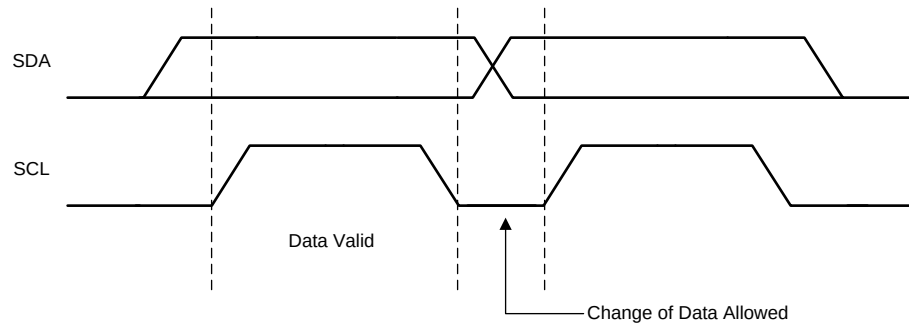


图 5-10. Bit Transfer on the I<sup>2</sup>C Bus

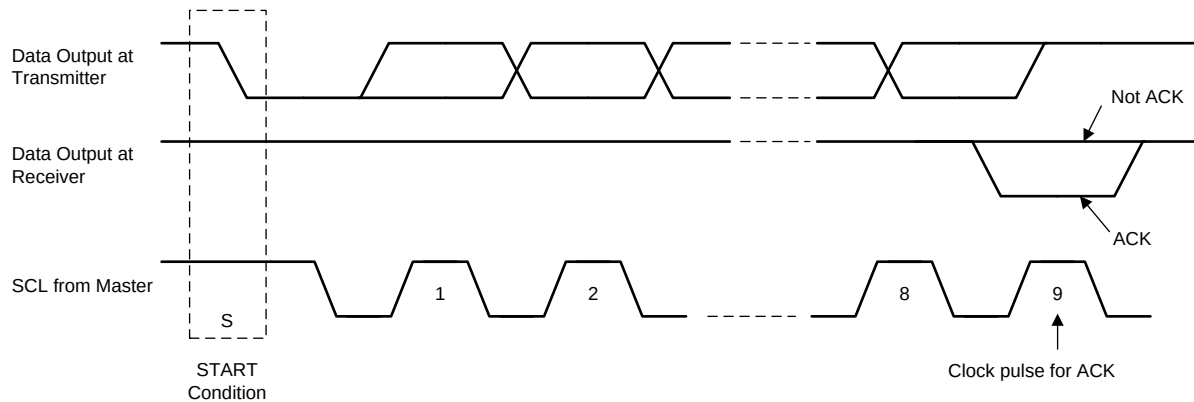


图 5-11. Acknowledge on the I<sup>2</sup>C Bus

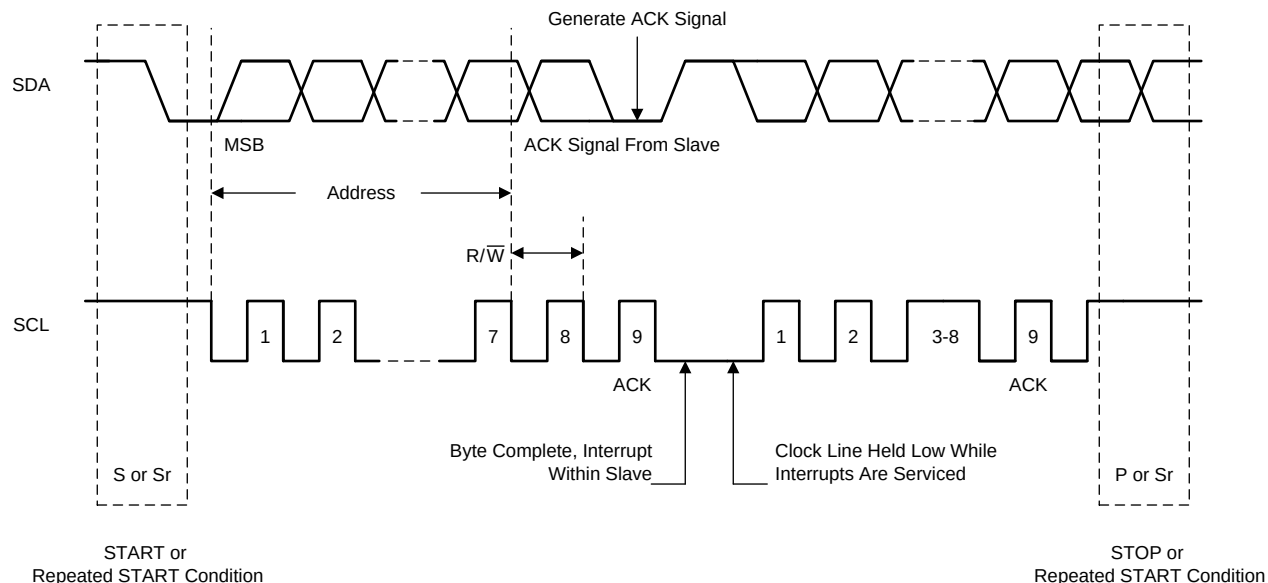


图 5-12. I²C Bus Protocol

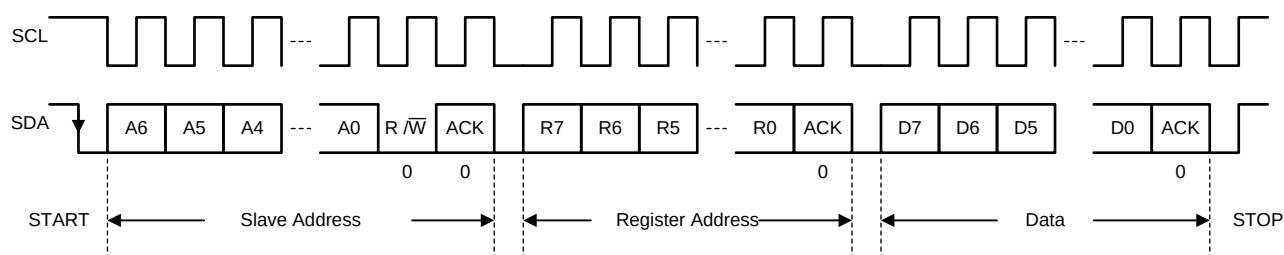


图 5-13. I²C Interface WRITE to TPS6508700 in F/S Mode

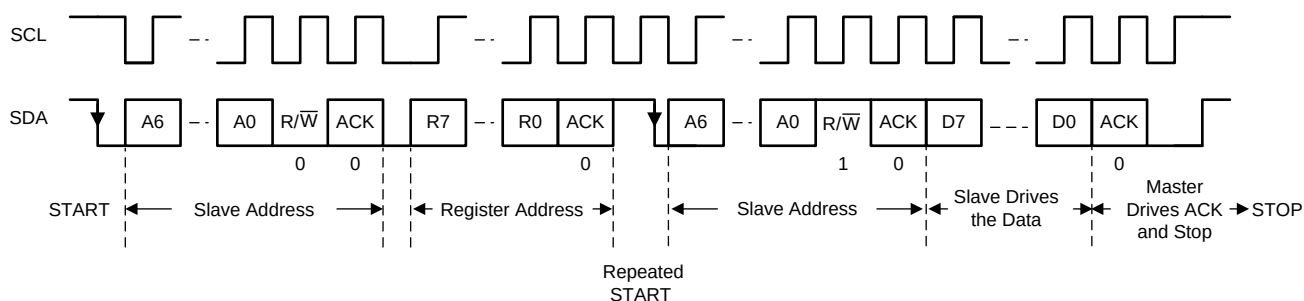


图 5-14. I²C Interface READ From TPS6508700 in F/S Mode (Only Repeated START is Supported)

## 5.9 Register Maps

### 5.9.1 Register Map Summary

Table 5-7 lists the memory-mapped registers for the TPS6508700. All register offset addresses not listed in Table 5-7 should be considered as reserved locations and the register contents should not be modified.

**Table 5-7. Register Map Summary**

| Offset | Acronym              | Short Description                                                                                     | Section            |
|--------|----------------------|-------------------------------------------------------------------------------------------------------|--------------------|
| 1h     | DEVICEID             | Device ID code indicating revision                                                                    | <a href="#">Go</a> |
| 2h     | IRQ                  | Interrupt statuses                                                                                    | <a href="#">Go</a> |
| 3h     | IRQ_MASK             | Interrupt masking                                                                                     | <a href="#">Go</a> |
| 4h     | PMICSTAT             | PMIC temperature indicator                                                                            | <a href="#">Go</a> |
| 5h     | SHUTDNSRC            | Shutdown root cause indicator bits                                                                    | <a href="#">Go</a> |
| 21h    | BUCK2CTRL            | BUCK2 decay control and voltage select                                                                | <a href="#">Go</a> |
| 22h    | BUCK3DECAY           | BUCK3 decay control                                                                                   | <a href="#">Go</a> |
| 23h    | BUCK3VID             | BUCK3 voltage select                                                                                  | <a href="#">Go</a> |
| 24h    | BUCK3SLPCTRL         | BUCK3 voltage select for SLEEP state                                                                  | <a href="#">Go</a> |
| 25h    | BUCK4CTRL            | BUCK4 control                                                                                         | <a href="#">Go</a> |
| 26h    | BUCK5CTRL            | BUCK5 control                                                                                         | <a href="#">Go</a> |
| 27h    | BUCK6CTRL            | BUCK6 control                                                                                         | <a href="#">Go</a> |
| 28h    | LDOA2CTRL            | LDOA2 control                                                                                         | <a href="#">Go</a> |
| 29h    | LDOA3CTRL            | LDOA3 control                                                                                         | <a href="#">Go</a> |
| 40h    | DISCHCTRL1           | Discharge resistors for each rail control                                                             | <a href="#">Go</a> |
| 41h    | DISCHCTRL2           | Discharge resistors for each rail control                                                             | <a href="#">Go</a> |
| 42h    | DISCHCTRL3           | Discharge resistors for each rail control                                                             | <a href="#">Go</a> |
| 43h    | PG_DELAY1            | System Power Good on GPO3 (if GPO3 is programmed to be system PG)                                     | <a href="#">Go</a> |
| 91h    | FORCESHUTDN          | Software force shutdown                                                                               | <a href="#">Go</a> |
| 93h    | BUCK2SLPCTRL         | BUCK2 voltage select for SLEEP state                                                                  | <a href="#">Go</a> |
| 94h    | BUCK4VID             | BUCK4 voltage select                                                                                  | <a href="#">Go</a> |
| 95h    | BUCK4SLPVID          | BUCK4 voltage select for SLEEP state                                                                  | <a href="#">Go</a> |
| 96h    | BUCK5VID             | BUCK5 voltage select                                                                                  | <a href="#">Go</a> |
| 97h    | BUCK5SLPVID          | BUCK5 voltage select for SLEEP state                                                                  | <a href="#">Go</a> |
| 98h    | BUCK6VID             | BUCK6 voltage select                                                                                  | <a href="#">Go</a> |
| 99h    | BUCK6SLPVID          | BUCK6 voltage select for SLEEP state                                                                  | <a href="#">Go</a> |
| 9Ah    | LDOA2VID             | LDOA2 voltage select                                                                                  | <a href="#">Go</a> |
| 9Bh    | LDOA3VID             | LDOA3 voltage select                                                                                  | <a href="#">Go</a> |
| 9Ch    | BUCK123CTRL          | BUCK1, 2, and 3 disable and PFM/PWM mode control                                                      | <a href="#">Go</a> |
| 9Dh    | PG_DELAY2            | System Power Good on GPO1, 2, and 4 (if GPOs are programmed to be system PG)                          | <a href="#">Go</a> |
| 9Fh    | SWVTT_DIS            | SWs and VTT I <sup>2</sup> C disable bits                                                             | <a href="#">Go</a> |
| A0h    | I2C_RAIL_EN1         | I <sup>2</sup> C enable control of individual rails                                                   | <a href="#">Go</a> |
| A1h    | I2C_RAIL_EN2/GPOCTRL | I <sup>2</sup> C enable control of individual rails and I <sup>2</sup> C controlled GPOs, high or low | <a href="#">Go</a> |
| A2h    | PWR_FAULT_MASK1      | Power fault masking for individual rails                                                              | <a href="#">Go</a> |
| A3h    | PWR_FAULT_MASK2      | Power fault masking for individual rails                                                              | <a href="#">Go</a> |
| A4h    | GPO1PG_CTRL1         | Power good tree control for GPO1                                                                      | <a href="#">Go</a> |
| A5h    | GPO1PG_CTRL2         | Power good tree control for GPO1                                                                      | <a href="#">Go</a> |
| A6h    | GPO4PG_CTRL1         | Power good tree control for GPO4                                                                      | <a href="#">Go</a> |
| A7h    | GPO4PG_CTRL2         | Power good tree control for GPO4                                                                      | <a href="#">Go</a> |
| A8h    | GPO2PG_CTRL1         | Power good tree control for GPO2                                                                      | <a href="#">Go</a> |

**Table 5-7. Register Map Summary (continued)**

| Offset | Acronym           | Short Description                                          | Section            |
|--------|-------------------|------------------------------------------------------------|--------------------|
| A9h    | GPO2PG_CTRL2      | Power good tree control for GPO2                           | <a href="#">Go</a> |
| AAh    | GPO3PG_CTRL1      | Power good tree control for GPO3                           | <a href="#">Go</a> |
| ABh    | GPO3PG_CTRL2      | Power good tree control for GPO3                           | <a href="#">Go</a> |
| ACh    | MISCSYSPG         | Power Good tree control with CTL3 and CTL6 for GPO         | <a href="#">Go</a> |
| A Eh   | LDOA1CTRL         | LDOA1 control for discharge, voltage selection, and enable | <a href="#">Go</a> |
| B0h    | PG_STATUS1        | Power Good statuses for individual rails                   | <a href="#">Go</a> |
| B1h    | PG_STATUS2        | Power Good statuses for individual rails                   | <a href="#">Go</a> |
| B2h    | PWR_FAULT_STATUS1 | Power fault statuses for individual rails                  | <a href="#">Go</a> |
| B3h    | PWR_FAULT_STATUS2 | Power fault statuses for individual rails                  | <a href="#">Go</a> |
| B4h    | TEMPCRIT          | Critical temperature indicators                            | <a href="#">Go</a> |
| B5h    | TEMPHOT           | Hot temperature indicators                                 | <a href="#">Go</a> |
| B6h    | OC_STATUS         | Overcurrent fault status                                   | <a href="#">Go</a> |

Complex bit access types are encoded to fit into small table cells. [Table 5-8](#) shows the codes that are used for access types in this section.

**Table 5-8. Access Type Codes**

| Access Type            | Code | Description                            |
|------------------------|------|----------------------------------------|
| Read Type              |      |                                        |
| R                      | R    | Read                                   |
| Write Type             |      |                                        |
| W                      | W    | Write                                  |
| Reset or Default Value |      |                                        |
| -nh                    |      | Value after reset or the default value |

### 5.9.2 DEVICEID: PMIC Device and Revision ID Register (offset = 1h) [reset = 10h]

DEVICEID is shown in [Figure 5-15](#) and described in [Table 5-9](#).

Return to [Summary Table](#).

**Figure 5-15. DEVICEID Register**

| 7          | 6 | 5                | 4 | 3                | 2 | 1 | 0 |
|------------|---|------------------|---|------------------|---|---|---|
| REVID[1:0] |   | OTP_VERSION[1:0] |   | PART_NUMBER[3:0] |   |   |   |
| R-0h       |   | R-1h             |   | R-0h             |   |   |   |

**Table 5-9. DEVICEID Field Descriptions**

| Bit | Field            | Type | Reset | Description                                                                    |
|-----|------------------|------|-------|--------------------------------------------------------------------------------|
| 7-6 | REVID[1:0]       | R    | 0h    | Silicon revision ID                                                            |
| 5-4 | OTP_VERSION[1:0] | R    | 1h    | OTP variation ID<br>0h = A<br>1h = B<br>2h = C<br>3h = D                       |
| 3-0 | PART_NUMBER[3:0] | R    | 0h    | Device part number ID<br>0h = TPS6508700<br>1h = TPS6508701<br>Fh = TPS650870F |

### 5.9.3 IRQ: PMIC Interrupt Register (offset = 2h) [reset = 0h]

IRQ is shown in [Figure 5-16](#) and described in [Table 5-10](#).

Return to [Summary Table](#).

**Figure 5-16. IRQ Register**

| 7      | 6        | 5 | 4 | 3      | 2        | 1 | 0       |
|--------|----------|---|---|--------|----------|---|---------|
| FAULT  | RESERVED |   |   | SHUTDN | RESERVED |   | DIETEMP |
| R/W-0h | R-0h     |   |   | R/W-0h | R-0h     |   | R/W-0h  |

**Table 5-10. IRQ Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                           |
|-----|----------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | FAULT    | R/W  | 0h    | <p>Fault interrupt. Asserted when either condition occurs: SYS &lt; UVLO, power fault of any rail, or die temperature crosses over the critical temperature threshold (<math>T_{CRIT}</math>). The user can read registers 0xB2 through 0xB6 to determine what has caused the interrupt.</p> <p>0h = Not asserted</p> <p>1h = Asserted. Host to write 1 to clear.</p> |
| 6-4 | RESERVED | R    | 0h    |                                                                                                                                                                                                                                                                                                                                                                       |
| 3   | SHUTDN   | R/W  | 0h    | <p>Asserted when PMIC shuts down. To clear indicator, SHUTDNSRC must be cleared first, see <a href="#">Section 5.9.6</a></p> <p>0h = Not asserted.</p> <p>1h = Asserted. Host to write 1 to clear.</p>                                                                                                                                                                |
| 2-1 | RESERVED | R    | 0h    |                                                                                                                                                                                                                                                                                                                                                                       |
| 0   | DIETEMP  | R/W  | 0h    | <p>Die temp interrupt. Asserted when PMIC die temperature crosses above the hot temperature threshold (<math>T_{HOT}</math>).</p> <p>0h = Not asserted.</p> <p>1h = Asserted. Host to write 1 to clear.</p>                                                                                                                                                           |

#### 5.9.4 IRQ\_MASK: PMIC Interrupt Mask Register (offset = 3h) [reset = FFh]

IRQ\_MASK is shown in [Figure 5-17](#) and described in [Table 5-11](#).

Return to [Summary Table](#).

**Figure 5-17. IRQ\_MASK Register**

| 7      | 6        | 5 | 4 | 3       | 2        | 1 | 0        |
|--------|----------|---|---|---------|----------|---|----------|
| MFAULT | RESERVED |   |   | MSHUTDN | RESERVED |   | MDIETEMP |
| R/W-1h | R-7h     |   |   | R/W-1h  | R-3h     |   | R/W-1h   |

**Table 5-11. IRQ\_MASK Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                            |
|-----|----------|------|-------|------------------------------------------------------------------------|
| 7   | MFAULT   | R/W  | 1h    | FAULT interrupt mask.<br>0h = Not masked.<br>1h = Masked.              |
| 6-4 | RESERVED | R    | 7h    |                                                                        |
| 3   | MSHUTDN  | R/W  | 1h    | PMIC shutdown event interrupt mask<br>0h = Not masked.<br>1h = Masked. |
| 2-1 | RESERVED | R    | 3h    |                                                                        |
| 0   | MDIETEMP | R/W  | 1h    | Die temp interrupt mask.<br>0h = Not masked.<br>1h = Masked.           |

#### 5.9.5 PMICSTAT: PMIC Status Register (offset = 4h) [reset = 0h]

PMICSTAT is shown in [Figure 5-18](#) and described in [Table 5-12](#).

Return to [Summary Table](#).

**Figure 5-18. PMICSTAT Register**

| 7        | 6 | 5 | 4 | 3 | 2 | 1 | 0        |
|----------|---|---|---|---|---|---|----------|
| RESERVED |   |   |   |   |   |   | SDIETEMP |
| R-0h     |   |   |   |   |   |   | R-0h     |

**Table 5-12. PMICSTAT Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                    |
|-----|----------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | RESERVED | R    | 0h    |                                                                                                                                                |
| 0   | SDIETEMP | R    | 0h    | PMIC die temperature status.<br>0h = PMIC die temperature is below T <sub>HOT</sub> .<br>1h = PMIC die temperature is above T <sub>HOT</sub> . |

### 5.9.6 SHUTDNSRC: PMIC Shut-Down Event Register (offset = 5h) [reset = 0h]

SHUTDNSRC is shown in [Figure 5-19](#) and described in [Table 5-13](#).

Return to [Summary Table](#).

**Figure 5-19. SHUTDNSRC Register**

| 7        | 6 | 5 | 4 | 3        | 2      | 1      | 0        |
|----------|---|---|---|----------|--------|--------|----------|
| RESERVED |   |   |   | COLD OFF | UVLO   | PWRFLT | CRITTEMP |
| R-0h     |   |   |   | R/W-0h   | R/W-0h | R/W-0h | R/W-0h   |

**Table 5-13. SHUTDNSRC Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                     |
|-----|----------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-4 | RESERVED | R    | 0h    |                                                                                                                                                                                                                                                                                 |
| 3   | COLD OFF | R/W  | 0h    | Set by PMIC cleared by host. Host to write 1 to clear. This bit is always 0h for TPS6508700.<br><br>0h = Cleared<br>1h = PMIC was shut down by pulling down <b>CTL1</b> pin.                                                                                                    |
| 2   | UVLO     | R/W  | 0h    | Set by PMIC cleared by host. Host to write 1 to clear.<br><br>0h = Cleared<br>1h = PMIC was shut down due to a UVLO event ( $V_{SYS}$ crosses below 5.4 V). Assertion of this bit sets the SHUTDN bit in <a href="#">Section 5.9.3</a> .                                        |
| 1   | PWRFLT   | R/W  | 0h    | Set by PMIC cleared by host. Host to write 1 to clear.<br><br>0h = Cleared<br>1h = PMIC was shut down due to a power fault on a rail with power fault not masked. Assertion of this bit sets the SHUTDN bit in <a href="#">Section 5.9.3</a> .                                  |
| 0   | CRITTEMP | R/W  | 0h    | Set by PMIC cleared by host. Host to write 1 to clear.<br><br>0h = Cleared<br>1h = PMIC was shut down due to the rise of PMIC die temperature above critical temperature threshold ( $T_{CRIT}$ ). Assertion of this bit sets the SHUTDN bit in <a href="#">Section 5.9.3</a> . |

### 5.9.7 BUCK2CTRL: BUCK2 Control Register (offset = 21h) [reset = 50h]

BUCK2CTRL is shown in [Figure 5-20](#) and described in [Table 5-14](#).

Return to [Summary Table](#).

**Figure 5-20. BUCK2CTRL Register**

| 7              | 6 | 5 | 4 | 3 | 2 | 1 | 0               |
|----------------|---|---|---|---|---|---|-----------------|
| BUCK2_VID[6:0] |   |   |   |   |   |   | BUCK2_DECA<br>Y |
| R/W-28h        |   |   |   |   |   |   | R/W-0h          |

**Table 5-14. BUCK2CTRL Field Descriptions**

| Bit | Field          | Type | Reset | Description                                                                                                                                                                                                                            |
|-----|----------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK2_VID[6:0] | R/W  | 28h   | This field sets the BUCK2 regulator output regulation voltage in normal mode.<br>See <a href="#">表 5-2</a> and <a href="#">表 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options.                                     |
| 0   | BUCK2_DECAY    | R/W  | 0h    | Decay bit<br><br>0h = The output slews down to a lower voltage set by the VID bits.<br><br>1h = The output decays down to a lower voltage set by the VID bits. Decay rate depends on total capacitance and load present at the output. |

### 5.9.8 BUCK3DECAY: BUCK3 Decay Control Register (offset = 22h) [reset = 70h]

BUCK3DECAY is shown in [Figure 5-21](#) and described in [Table 5-15](#).

Return to [Summary Table](#).

**Figure 5-21. BUCK3DECAY Register**

| 7        | 6 | 5 | 4 | 3 | 2 | 1 | 0               |
|----------|---|---|---|---|---|---|-----------------|
| RESERVED |   |   |   |   |   |   | BUCK3_DECA<br>Y |
| R/W-38h  |   |   |   |   |   |   | R/W-0h          |

**Table 5-15. BUCK3DECAY Field Descriptions**

| Bit | Field       | Type | Reset | Description                                                                                                                                                                                                                            |
|-----|-------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | RESERVED    | R/W  | 38h   | Reserved bits are don't care bits, can be 1h or 0h.                                                                                                                                                                                    |
| 0   | BUCK3_DECAY | R/W  | 0h    | Decay bit<br><br>0h = The output slews down to a lower voltage set by the VID bits.<br><br>1h = The output decays down to a lower voltage set by the VID bits. Decay rate depends on total capacitance and load present at the output. |

### 5.9.9 BUCK3VID: BUCK3 VID Register (offset = 23h) [reset = 70h]

BUCK3VID is shown in [Figure 5-22](#) and described in [Table 5-16](#).

Return to [Summary Table](#).

**Figure 5-22. BUCK3VID Register**

| 7              | 6 | 5 | 4 | 3 | 2 | 1 | 0        |
|----------------|---|---|---|---|---|---|----------|
| BUCK3_VID[6:0] |   |   |   |   |   |   | RESERVED |
| R/W-38h        |   |   |   |   |   |   | R/W-0h   |

**Table 5-16. BUCK3VID Field Descriptions**

| Bit | Field          | Type | Reset | Description                                                                                                                                                                                        |
|-----|----------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK3_VID[6:0] | R/W  | 38h   | This field sets the BUCK3 regulator output regulation voltage in normal mode.<br>See <a href="#">表 5-2</a> and <a href="#">表 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options. |
| 0   | RESERVED       | R/W  | 0h    |                                                                                                                                                                                                    |

### 5.9.10 BUCK3SLPCTRL: BUCK3 Sleep Control VID Register (offset = 24h) [reset = 70h]

BUCK3SLPCTRL is shown in [Figure 5-23](#) and described in [Table 5-17](#).

Return to [Summary Table](#).

**Figure 5-23. BUCK3SLPCTRL Register**

| 7                  | 6 | 5 | 4 | 3 | 2 | 1 | 0            |
|--------------------|---|---|---|---|---|---|--------------|
| BUCK3_SLP_VID[6:0] |   |   |   |   |   |   | BUCK3_SLP_EN |
| R/W-38h            |   |   |   |   |   |   | R/W-0h       |

**Table 5-17. BUCK3SLPCTRL Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                                                                                                               |
|-----|--------------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK3_SLP_VID[6:0] | R/W  | 38h   | This field sets the BUCK3 regulator output regulation voltage in sleep mode. BUCK3_SLP_VID bits are copied to BUCK3_VID bits upon enters sleep mode.<br>See <a href="#">表 5-2</a> and <a href="#">表 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options. |
| 0   | BUCK3_SLP_EN       | R/W  | 0h    | BUCK3 sleep mode enable. BUCK3 is factory configured to change to sleep mode voltage either by CTL3/SLPENB1 pin or by CTL6/SLPENB2 pin.<br><br>0h = Disable.<br>1h = Enable.                                                                                              |

### 5.9.11 BUCK4CTRL: BUCK4 Control Register (offset = 25h) [reset = Dh]

BUCK4CTRL is shown in [Figure 5-24](#) and described in [Table 5-18](#).

Return to [Summary Table](#).

**Figure 5-24. BUCK4CTRL Register**

| 7        | 6 | 5                 | 4 | 3        | 2 | 1          | 0         |
|----------|---|-------------------|---|----------|---|------------|-----------|
| RESERVED |   | BUCK4_SLP_EN[1:0] |   | RESERVED |   | BUCK4_MODE | BUCK4_DIS |
| R-0h     |   | R/W-0h            |   | R/W-3h   |   | R/W-0h     | R/W-1h    |

**Table 5-18. BUCK4CTRL Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                  |
|-----|-------------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | RESERVED          | R    | 0h    |                                                                                                                                                                                                              |
| 5-4 | BUCK4_SLP_EN[1:0] | R/W  | 0h    | BUCK4 sleep mode enable. BUCK4 is factory configured to change to sleep mode voltage either by CTL3/SLPENB1 pin or by CTL6/SLPENB2 pin.<br><br>0h = Disable.<br>1h = Enable.<br>2h = Enable.<br>3h = Enable. |
| 3-2 | RESERVED          | R/W  | 3h    | Reserved as 3h. 0h, 1h, and 2h will result in BUCK4 regulation ignoring BUCK4_VID and BUCK4_SLP_VID values.                                                                                                  |
| 1   | BUCK4_MODE        | R/W  | 0h    | This field sets the BUCK4 regulator operating mode.<br><br>0h = Automatic mode<br>1h = Forced PWM mode                                                                                                       |
| 0   | BUCK4_DIS         | R/W  | 1h    | BUCK4 disable bit. Writing 0 to this bit forces BUCK4 to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable<br>1h = Enable                                                 |

### 5.9.12 BUCK5CTRL: BUCK5 Control Register (offset = 26h) [reset = Dh]

BUCK5CTRL is shown in [Figure 5-25](#) and described in [Table 5-19](#).

Return to [Summary Table](#).

**Figure 5-25. BUCK5CTRL Register**

| 7        | 6 | 5                 | 4 | 3        | 2 | 1          | 0         |
|----------|---|-------------------|---|----------|---|------------|-----------|
| RESERVED |   | BUCK5_SLP_EN[1:0] |   | RESERVED |   | BUCK5_MODE | BUCK5_DIS |
| R-0h     |   | R/W-0h            |   | R/W-3h   |   | R/W-0h     | R/W-1h    |

**Table 5-19. BUCK5CTRL Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                  |
|-----|-------------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | RESERVED          | R    | 0h    |                                                                                                                                                                                                              |
| 5-4 | BUCK5_SLP_EN[1:0] | R/W  | 0h    | BUCK5 sleep mode enable. BUCK5 is factory configured to change to sleep mode voltage either by CTL3/SLPENB1 pin or by CTL6/SLPENB2 pin.<br><br>0h = Disable.<br>1h = Enable.<br>2h = Enable.<br>3h = Enable. |
| 3-2 | RESERVED          | R/W  | 3h    | Reserved as 3h. 0h, 1h, and 2h will result in BUCK5 regulation ignoring BUCK5_VID and BUCK5_SLP_VID values.                                                                                                  |
| 1   | BUCK5_MODE        | R/W  | 0h    | This field sets the BUCK5 regulator operating mode.<br><br>0h = Automatic mode<br>1h = Forced PWM mode                                                                                                       |
| 0   | BUCK5_DIS         | R/W  | 1h    | BUCK5 disable bit. Writing 0 to this bit forces BUCK5 to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable.<br>1h = Enable.                                               |

### 5.9.13 BUCK6CTRL: BUCK6 Control Register (offset = 27h) [reset = Dh]

BUCK6CTRL is shown in [Figure 5-26](#) and described in [Table 5-20](#).

Return to [Summary Table](#).

**Figure 5-26. BUCK6CTRL Register**

| 7        | 6 | 5                 | 4 | 3        | 2 | 1          | 0         |
|----------|---|-------------------|---|----------|---|------------|-----------|
| RESERVED |   | BUCK6_SLP_EN[1:0] |   | RESERVED |   | BUCK6_MODE | BUCK6_DIS |
| R-0h     |   | R/W-0h            |   | R/W-3h   |   | R/W-0h     | R/W-1h    |

**Table 5-20. BUCK6CTRL Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                  |
|-----|-------------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | RESERVED          | R    | 0h    |                                                                                                                                                                                                              |
| 5-4 | BUCK6_SLP_EN[1:0] | R/W  | 0h    | BUCK6 sleep mode enable. BUCK6 is factory configured to change to sleep mode voltage either by CTL3/SLPENB1 pin or by CTL6/SLPENB2 pin.<br><br>0h = Disable.<br>1h = Enable.<br>2h = Enable.<br>3h = Enable. |
| 3-2 | RESERVED          | R/W  | 3h    | Reserved as 3h. 0h, 1h, and 2h will result in BUCK6 regulation ignoring BUCK6_VID and BUCK6_SLP_VID values.                                                                                                  |
| 1   | BUCK6_MODE        | R/W  | 0h    | This field sets the BUCK6 regulator operating mode.<br><br>0h = Automatic mode<br>1h = Forced PWM mode                                                                                                       |
| 0   | BUCK6_DIS         | R/W  | 1h    | BUCK6 disable bit. Writing 0 to this bit forces BUCK6 to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable.<br>1h = Enable.                                               |

### 5.9.14 LDOA2CTRL: LDOA2 Control Register (offset = 28h) [reset = Ch]

LDOA2CTRL is shown in [Figure 5-27](#) and described in [Table 5-21](#).

Return to [Summary Table](#).

**Figure 5-27. LDOA2CTRL Register**

| 7        | 6 | 5                 | 4 | 3        | 2 | 1         | 0 |
|----------|---|-------------------|---|----------|---|-----------|---|
| RESERVED |   | LDOA2_SLP_EN[1:0] |   | RESERVED |   | LDOA2_DIS |   |
| R-0h     |   | R/W-0h            |   | R/W-6h   |   | R/W-0h    |   |

**Table 5-21. LDOA2CTRL Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                  |
|-----|-------------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | RESERVED          | R    | 0h    |                                                                                                                                                                                                              |
| 5-4 | LDOA2_SLP_EN[1:0] | R/W  | 0h    | LDOA2 sleep mode enable. LDOA2 is factory configured to change to sleep mode voltage either by CTL3/SLPENB1 pin or by CTL6/SLPENB2 pin.<br><br>0h = Disable.<br>1h = Enable.<br>2h = Enable.<br>3h = Enable. |
| 3-1 | RESERVED          | R/W  | 6h    | Reserved as 3h. 0h, 1h, and 2h will result in LDOA2 regulation ignoring LDOA2_VID and LDOA2_SLP_VID values.                                                                                                  |
| 0   | LDOA2_DIS         | R/W  | 0h    | LDOA2 disable bit. Writing 0 to this bit forces LDOA2 to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable.<br>1h = Enable.                                               |

### 5.9.15 LDOA3CTRL: LDOA3 Control Register (offset = 29h) [reset = 3Ch]

LDOA3CTRL is shown in [Figure 5-28](#) and described in [Table 5-22](#).

Return to [Summary Table](#).

**Figure 5-28. LDOA3CTRL Register**

| 7        | 6 | 5                 | 4 | 3        | 2 | 1         | 0 |
|----------|---|-------------------|---|----------|---|-----------|---|
| RESERVED |   | LDOA3_SLP_EN[1:0] |   | RESERVED |   | LDOA3_DIS |   |
| R-0h     |   | R/W-3h            |   | R/W-6h   |   | R/W-0h    |   |

**Table 5-22. LDOA3CTRL Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                  |
|-----|-------------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | RESERVED          | R    | 0h    |                                                                                                                                                                                                              |
| 5-4 | LDOA3_SLP_EN[1:0] | R/W  | 3h    | LDOA3 sleep mode enable. LDOA3 is factory configured to change to sleep mode voltage either by CTL3/SLPENB1 pin or by CTL6/SLPENB2 pin.<br><br>0h = Disable.<br>1h = Enable.<br>2h = Enable.<br>3h = Enable. |
| 3-1 | RESERVED          | R/W  | 6h    | Reserved as 3h. 0h, 1h, and 2h will result in LDOA3 regulation ignoring LDOA3_VID and LDOA3_SLP_VID values.                                                                                                  |
| 0   | LDOA3_DIS         | R/W  | 0h    | LDOA3 disable bit. Writing 0h to this bit forces LDOA3 to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable<br>1h = Enable                                                |

### 5.9.16 DISCHCTRL1: Discharge Control1 Register (offset = 40h) [reset = 55h]

DISCHCTRL1 is shown in [Figure 5-29](#) and described in [Table 5-23](#).

Return to [Summary Table](#).

All xx\_DISCHG[1:0] bits internally set to 0h whenever the corresponding VR is enabled.

**Figure 5-29. DISCHCTRL1 Register**

| 7                 | 6 | 5                 | 4 | 3                 | 2 | 1                 | 0 |
|-------------------|---|-------------------|---|-------------------|---|-------------------|---|
| BUCK4_DISCHG[1:0] |   | BUCK3_DISCHG[1:0] |   | BUCK2_DISCHG[1:0] |   | BUCK1_DISCHG[1:0] |   |
| R/W-1h            |   | R/W-1h            |   | R/W-1h            |   | R/W-1h            |   |

**Table 5-23. DISCHCTRL1 Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                    |
|-----|-------------------|------|-------|----------------------------------------------------------------------------------------------------------------|
| 7-6 | BUCK4_DISCHG[1:0] | R/W  | 1h    | BUCK4 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$ |
| 5-4 | BUCK3_DISCHG[1:0] | R/W  | 1h    | BUCK3 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$ |
| 3-2 | BUCK2_DISCHG[1:0] | R/W  | 1h    | BUCK2 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$ |
| 1-0 | BUCK1_DISCHG[1:0] | R/W  | 1h    | BUCK1 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$ |

### 5.9.17 DISCHCTRL2: Discharge Control2 Register (offset = 41h) [reset = 55h]

DISCHCTRL2 is shown in [Figure 5-30](#) and described in [Table 5-24](#).

Return to [Summary Table](#).

All xx\_DISCHG[1:0] bits internally set to 0h whenever the corresponding VR is enabled.

**Figure 5-30. DISCHCTRL2 Register**

| 7                 | 6 | 5                | 4 | 3                 | 2 | 1                 | 0 |
|-------------------|---|------------------|---|-------------------|---|-------------------|---|
| LDOA2_DISCHG[1:0] |   | SWA1_DISCHG[1:0] |   | BUCK6_DISCHG[1:0] |   | BUCK5_DISCHG[1:0] |   |
| R/W-1h            |   | R/W-1h           |   | R/W-1h            |   | R/W-1h            |   |

**Table 5-24. DISCHCTRL2 Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                    |
|-----|-------------------|------|-------|----------------------------------------------------------------------------------------------------------------|
| 7-6 | LDOA2_DISCHG[1:0] | R/W  | 1h    | LDOA2 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$ |
| 5-4 | SWA1_DISCHG[1:0]  | R/W  | 1h    | SWA1 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$  |
| 3-2 | BUCK6_DISCHG[1:0] | R/W  | 1h    | BUCK6 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$ |
| 1-0 | BUCK5_DISCHG[1:0] | R/W  | 1h    | BUCK5 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$ |

### 5.9.18 DISCHCTRL3: Discharge Control3 Register (offset = 42h) [reset = 15h]

DISCHCTRL3 is shown in [Figure 5-31](#) and described in [Table 5-25](#).

Return to [Summary Table](#).

All xx\_DISCHG[1:0] bits internally set to 0h whenever the corresponding VR is enabled.

**Figure 5-31. DISCHCTRL3 Register**

| 7        | 6 | 5                | 4 | 3                | 2 | 1                 | 0 |
|----------|---|------------------|---|------------------|---|-------------------|---|
| RESERVED |   | SWB2_DISCHG[1:0] |   | SWB1_DISCHG[1:0] |   | LDOA3_DISCHG[1:0] |   |
| R-0h     |   | R/W-1h           |   | R/W-1h           |   | R/W-1h            |   |

**Table 5-25. DISCHCTRL3 Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                    |
|-----|-------------------|------|-------|----------------------------------------------------------------------------------------------------------------|
| 7-6 | RESERVED          | R    | 0h    |                                                                                                                |
| 5-4 | SWB2_DISCHG[1:0]  | R/W  | 1h    | SWB2 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$  |
| 3-2 | SWB1_DISCHG[1:0]  | R/W  | 1h    | SWB1 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$  |
| 1-0 | LDOA3_DISCHG[1:0] | R/W  | 1h    | LDOA3 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$ |

### 5.9.19 PG\_DELAY1: Power Good Delay1 Register (offset = 43h) [reset = 0h]

PG\_DELAY1 is shown in [Figure 5-32](#) and described in [Table 5-26](#).

Return to [Summary Table](#).

Programmable power good delay for GPO3 pin, measured from the moment when all VRs assigned to GPO3 pin reach their regulation range to power good assertion. This register is optional as the PMIC can be programmed for system PG, level shifter or I<sup>2</sup>C controller GPO.

**Figure 5-32. PG\_DELAY1 Register**

| 7        | 6 | 5 | 4 | 3 | 2                  | 1 | 0 |
|----------|---|---|---|---|--------------------|---|---|
| RESERVED |   |   |   |   | GPO3_PG_DELAY[2:0] |   |   |
| R-0h     |   |   |   |   | R/W-0h             |   |   |

**Table 5-26. PG\_DELAY1 Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                             |
|-----|--------------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-3 | RESERVED           | R    | 0h    |                                                                                                                                                                                                                                                                                                                                                                                                         |
| 2-0 | GPO3_PG_DELAY[2:0] | R/W  | 0h    | <p>Programmable delay power good or level shifter for GPO3 pin. Measured from the moment when all rails grouped to this pin reach their regulation range. All values have <math>\pm 10\%</math> variation. Register not used (GPO3 controlled by I<sup>2</sup>C)</p> <p>0h = 2.5 ms<br/> 1h = 5 ms<br/> 2h = 10 ms<br/> 3h = 15 ms<br/> 4h = 20 ms<br/> 5h = 50 ms<br/> 6h = 75 ms<br/> 7h = 100 ms</p> |

### 5.9.20 **FORCESHUTDN: Force Emergency Shutdown Control Register (offset = 91h) [reset = 0h]**

FORCESHUTDN is shown in [Figure 5-33](#) and described in [Table 5-27](#).

Return to [Summary Table](#).

**Figure 5-33. FORCESHUTDN Register**

| 7        | 6 | 5 | 4 | 3 | 2 | 1 | 0      |
|----------|---|---|---|---|---|---|--------|
| RESERVED |   |   |   |   |   |   | SDWN   |
| R-0h     |   |   |   |   |   |   | R/W-0h |

**Table 5-27. FORCESHUTDN Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                           |
|-----|----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | RESERVED | R    | 0h    |                                                                                                                                                       |
| 0   | SDWN     | R/W  | 0h    | <p>Forces reset of the PMIC and reset of all registers. The bit is self-clearing.</p> <p>0h = No action.</p> <p>1h = PMIC is forced to shut down.</p> |

### 5.9.21 BUCK2SLPCTRL: BUCK2 Sleep Control Register (offset = 93h) [reset = 50h]

BUCK2SLPCTRL is shown in [Figure 5-34](#) and described in [Table 5-28](#).

Return to [Summary Table](#).

**Figure 5-34. BUCK2SLPCTRL Register**

| 7                  | 6 | 5 | 4 | 3 | 2 | 1 | 0            |
|--------------------|---|---|---|---|---|---|--------------|
| BUCK2_SLP_VID[6:0] |   |   |   |   |   |   | BUCK2_SLP_EN |
| R/W-28h            |   |   |   |   |   |   | R/W-0h       |

**Table 5-28. BUCK2SLPCTRL Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                  |
|-----|--------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK2_SLP_VID[6:0] | R/W  | 28h   | This field sets the BUCK2 regulator output regulation voltage in sleep mode. Mapping between bits and output voltage is defined as in <a href="#">Section 5.9.7</a> .        |
| 0   | BUCK2_SLP_EN       | R/W  | 0h    | BUCK2 sleep mode enable. BUCK2 is factory configured to change to sleep mode voltage either by CTL3/SLPENB1 pin or by CTL6/SLPENB2 pin.<br><br>0h = Disable.<br>1h = Enable. |

### 5.9.22 BUCK4VID: BUCK4 VID Register (offset = 94h) [reset = 20h]

BUCK4VID is shown in [Figure 5-35](#) and described in [Table 5-29](#).

Return to [Summary Table](#).

**Figure 5-35. BUCK4VID Register**

| 7              | 6 | 5 | 4 | 3 | 2 | 1 | 0           |
|----------------|---|---|---|---|---|---|-------------|
| BUCK4_VID[6:0] |   |   |   |   |   |   | BUCK4_DECAY |
| R/W-10h        |   |   |   |   |   |   | R/W-0h      |

**Table 5-29. BUCK4VID Field Descriptions**

| Bit | Field          | Type | Reset | Description                                                                                                                                                                                                                            |
|-----|----------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK4_VID[6:0] | R/W  | 10h   | This field sets the BUCK4 regulator output regulation voltage in normal mode.<br>See <a href="#">Table 5-2</a> and <a href="#">Table 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options.                             |
| 0   | BUCK4_DECAY    | R/W  | 0h    | Decay bit<br><br>0h = The output slews down to a lower voltage set by the VID bits.<br><br>1h = The output decays down to a lower voltage set by the VID bits. Decay rate depends on total capacitance and load present at the output. |

### 5.9.23 BUCK4SLPVID: BUCK4 Sleep VID Register (offset = 95h) [reset = 20h]

BUCK4SLPVID is shown in [Figure 5-36](#) and described in [Table 5-30](#).

Return to [Summary Table](#).

**Figure 5-36. BUCK4SLPVID Register**

| 7                  | 6 | 5 | 4 | 3 | 2 | 1 | 0        |
|--------------------|---|---|---|---|---|---|----------|
| BUCK4_SLP_VID[6:0] |   |   |   |   |   |   | RESERVED |
| R/W-10h            |   |   |   |   |   |   | R-0h     |

**Table 5-30. BUCK4SLPVID Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                                    |
|-----|--------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK4_SLP_VID[6:0] | R/W  | 10h   | This field sets the BUCK4 regulator output regulation voltage in sleep mode. See <a href="#">表 5-2</a> and <a href="#">表 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options. |
| 0   | RESERVED           | R    | 0h    |                                                                                                                                                                                                |

### 5.9.24 BUCK5VID: BUCK5 VID Register (offset = 96h) [reset = 70h]

BUCK5VID is shown in [Figure 5-37](#) and described in [Table 5-31](#).

Return to [Summary Table](#).

**Figure 5-37. BUCK5VID Register**

| 7              | 6 | 5 | 4 | 3 | 2 | 1 | 0           |
|----------------|---|---|---|---|---|---|-------------|
| BUCK5_VID[6:0] |   |   |   |   |   |   | BUCK5_DECAY |
| R/W-38h        |   |   |   |   |   |   | R/W-0h      |

**Table 5-31. BUCK5VID Field Descriptions**

| Bit | Field          | Type | Reset | Description                                                                                                                                                                                                                    |
|-----|----------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK5_VID[6:0] | R/W  | 38h   | This field sets the BUCK5 regulator output regulation voltage in normal mode. See <a href="#">表 5-2</a> and <a href="#">表 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options.                                |
| 0   | BUCK5_DECAY    | R/W  | 0h    | Decay bit<br>0h = The output slews down to a lower voltage set by the VID bits.<br>1h = The output decays down to a lower voltage set by the VID bits. Decay rate depends on total capacitance and load present at the output. |

### 5.9.25 BUCK5SLPVID: BUCK5 Sleep VID Register (offset = 97h) [reset = E8h]

BUCK5SLPVID is shown in [Figure 5-38](#) and described in [Table 5-32](#).

Return to [Summary Table](#).

**Figure 5-38. BUCK5SLPVID Register**

| 7                  | 6 | 5 | 4 | 3 | 2 | 1 | 0        |
|--------------------|---|---|---|---|---|---|----------|
| BUCK5_SLP_VID[6:0] |   |   |   |   |   |   | RESERVED |
| R/W-74h            |   |   |   |   |   |   | R-0h     |

**Table 5-32. BUCK5SLPVID Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                                       |
|-----|--------------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK5_SLP_VID[6:0] | R/W  | 74h   | This field sets the BUCK5 regulator output regulation voltage in sleep mode.<br>See <a href="#">表 5-2</a> and <a href="#">表 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options. |
| 0   | RESERVED           | R    | 0h    |                                                                                                                                                                                                   |

### 5.9.26 BUCK6VID: BUCK6 VID Register (offset = 98h) [reset = E8h]

BUCK6VID is shown in [Figure 5-39](#) and described in [Table 5-33](#).

Return to [Summary Table](#).

**Figure 5-39. BUCK6VID Register**

| 7              | 6 | 5 | 4 | 3 | 2 | 1 | 0           |
|----------------|---|---|---|---|---|---|-------------|
| BUCK6_VID[6:0] |   |   |   |   |   |   | BUCK6_DECAY |
| R/W-74h        |   |   |   |   |   |   | R/W-0h      |

**Table 5-33. BUCK6VID Field Descriptions**

| Bit | Field          | Type | Reset | Description                                                                                                                                                                                                                            |
|-----|----------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK6_VID[6:0] | R/W  | 74h   | This field sets the BUCK6 regulator output regulation voltage in normal mode.<br>See <a href="#">表 5-2</a> and <a href="#">表 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options.                                     |
| 0   | BUCK6_DECAY    | R/W  | 0h    | Decay bit<br><br>0h = The output slews down to a lower voltage set by the VID bits.<br><br>1h = The output decays down to a lower voltage set by the VID bits. Decay rate depends on total capacitance and load present at the output. |

### 5.9.27 BUCK6SLPVID: BUCK6 Sleep VID Register (offset = 99h) [reset = E8h]

BUCK6SLPVID is shown in [Figure 5-40](#) and described in [Table 5-34](#).

Return to [Summary Table](#).

**Figure 5-40. BUCK6SLPVID Register**

| 7                  | 6 | 5 | 4 | 3 | 2 | 1 | 0        |
|--------------------|---|---|---|---|---|---|----------|
| BUCK6_SLP_VID[6:0] |   |   |   |   |   |   | RESERVED |
| R/W-74h            |   |   |   |   |   |   | R-0h     |

**Table 5-34. BUCK6SLPVID Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                                        |
|-----|--------------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | BUCK6_SLP_VID[6:0] | R/W  | 74h   | This field sets the BUCK6 regulator output regulation voltage in normal mode.<br>See <a href="#">表 5-2</a> and <a href="#">表 5-3</a> for 10-mV and 25-mV step ranges for V <sub>OUT</sub> options. |
| 0   | RESERVED           | R    | 0h    |                                                                                                                                                                                                    |

### 5.9.28 LDOA2VID: LDOA2 VID Register (offset = 9Ah) [reset = FFh]

LDOA2VID is shown in [Figure 5-41](#) and described in [Table 5-35](#).

Return to [Summary Table](#).

**Figure 5-41. LDOA2VID Register**

| 7                  | 6 | 5 | 4 | 3              | 2 | 1 | 0 |
|--------------------|---|---|---|----------------|---|---|---|
| LDOA2_SLP_VID[3:0] |   |   |   | LDOA2_VID[3:0] |   |   |   |
| R/W-Fh             |   |   |   | R/W-Fh         |   |   |   |

**Table 5-35. LDOA2VID Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                              |
|-----|--------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------|
| 7-4 | LDOA2_SLP_VID[3:0] | R/W  | Fh    | This field sets the LDOA2 regulator output regulation voltage in sleep mode.<br>See <a href="#">表 5-5</a> for V <sub>OUT</sub> options.  |
| 3-0 | LDOA2_VID[3:0]     | R/W  | Fh    | This field sets the LDOA2 regulator output regulation voltage in normal mode.<br>See <a href="#">表 5-5</a> for V <sub>OUT</sub> options. |

### 5.9.29 LDOA3VID: LDOA3 VID Register (offset = 9Bh) [reset = AAh]

LDOA3VID is shown in [Figure 5-42](#) and described in [Table 5-36](#).

Return to [Summary Table](#).

**Figure 5-42. LDOA3VID Register**

| 7                  | 6 | 5 | 4 | 3              | 2 | 1 | 0 |
|--------------------|---|---|---|----------------|---|---|---|
| LDOA3_SLP_VID[3:0] |   |   |   | LDOA3_VID[3:0] |   |   |   |
| R/W-Ah             |   |   |   | R/W-Ah         |   |   |   |

**Table 5-36. LDOA3VID Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                              |
|-----|--------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------|
| 7-4 | LDOA3_SLP_VID[3:0] | R/W  | Ah    | This field sets the LDOA3 regulator output regulation voltage in sleep mode.<br>See <a href="#">表 5-5</a> for V <sub>OUT</sub> options.  |
| 3-0 | LDOA3_VID[3:0]     | R/W  | Ah    | This field sets the LDOA3 regulator output regulation voltage in normal mode.<br>See <a href="#">表 5-5</a> for V <sub>OUT</sub> options. |

### 5.9.30 BUCK123CTRL: BUCK1-3 Control Register (offset = 9Ch) [reset = 7h]

BUCK123CTRL is shown in [Figure 5-43](#) and described in [Table 5-37](#).

Return to [Summary Table](#).

**Figure 5-43. BUCK123CTRL Register**

| 7      | 6          | 5          | 4          | 3         | 2         | 1         | 0 |
|--------|------------|------------|------------|-----------|-----------|-----------|---|
| SPARE  | BUCK3_MODE | BUCK2_MODE | BUCK1_MODE | BUCK3_DIS | BUCK2_DIS | BUCK1_DIS |   |
| R/W-0h | R/W-0h     | R/W-0h     | R/W-0h     | R/W-1h    | R/W-1h    | R/W-1h    |   |

**Table 5-37. BUCK123CTRL Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                                              |
|-----|------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | SPARE      | R/W  | 0h    | Spare bits.                                                                                                                                              |
| 5   | BUCK3_MODE | R/W  | 0h    | This field sets the BUCK3 regulator operating mode.<br>0h = Automatic mode<br>1h = Forced PWM mode                                                       |
| 4   | BUCK2_MODE | R/W  | 0h    | This field sets the BUCK2 regulator operating mode.<br>0h = Automatic mode<br>1h = Forced PWM mode                                                       |
| 3   | BUCK1_MODE | R/W  | 0h    | This field sets the BUCK1 regulator operating mode.<br>0h = Automatic mode<br>1h = Forced PWM mode                                                       |
| 2   | BUCK3_DIS  | R/W  | 1h    | BUCK3 disable bit. Writing 0 to this bit forces BUCK3 to turn off regardless of any control input pin (CTL1–CTL6) status.<br>0h = Disable<br>1h = Enable |
| 1   | BUCK2_DIS  | R/W  | 1h    | BUCK2 disable bit. Writing 0 to this bit forces BUCK2 to turn off regardless of any control input pin (CTL1–CTL6) status.<br>0h = Disable<br>1h = Enable |
| 0   | BUCK1_DIS  | R/W  | 1h    | BUCK1 disable bit. Writing 0 to this bit forces BUCK1 to turn off regardless of any control input pin (CTL1–CTL6) status.<br>0h = Disable<br>1h = Enable |

### 5.9.31 PG\_DELAY2: Power Good Delay2 Register (offset = 9Dh) [reset = 21h]

PG\_DELAY2 is shown in [Figure 5-44](#) and described in [Table 5-38](#).

Return to [Summary Table](#).

Programmable Power Good delay for GPO1, GPO2, and GPO4 pins, measured from the moment when all VRs assigned to respective GPO reach their regulation range to Power Good assertion. This is an optional register as the PMIC can be programmed for system PG, level shifter or I<sup>2</sup>C controller GPO.

**Figure 5-44. PG\_DELAY2 Register**

| 7                  | 6 | 5 | 4                  | 3 | 2 | 1                  | 0 |
|--------------------|---|---|--------------------|---|---|--------------------|---|
| GPO2_PG_DELAY[2:0] |   |   | GPO4_PG_DELAY[2:0] |   |   | GPO1_PG_DELAY[1:0] |   |
| R/W-1h             |   |   | R/W-0h             |   |   | R/W-1h             |   |

**Table 5-38. PG\_DELAY2 Field Descriptions**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                                                                                                                                                     |
|-----|--------------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-5 | GPO2_PG_DELAY[2:0] | R/W  | 1h    | Programmable delay power good or level shifter for GPO2 pin. Measured from the moment when all rails grouped to this pin reach their regulation range. All values have $\pm 10\%$ variation.<br><br>0h = 0 ms<br>1h = 5 ms<br>2h = 10 ms<br>3h = 15 ms<br>4h = 20 ms<br>5h = 50 ms<br>6h = 75 ms<br>7h = 100 ms |
| 4-2 | GPO4_PG_DELAY[2:0] | R/W  | 0h    | Programmable delay power good or level shifter for GPO4 pin. Measured from the moment when all rails grouped to this pin reach their regulation range. All values have $\pm 10\%$ variation<br><br>0h = 0 ms<br>1h = 5 ms<br>2h = 10 ms<br>3h = 15 ms<br>4h = 20 ms<br>5h = 50 ms<br>6h = 75 ms<br>7h = 100 ms  |
| 1-0 | GPO1_PG_DELAY[1:0] | R/W  | 1h    | Programmable delay power good or level shifter for GPO1 pin. Measured from the moment when all rails grouped to this pin reach their regulation range. All values have $\pm 10\%$ variation<br><br>0h = 0 ms<br>1h = 5 ms<br>2h = 10 ms<br>3h = 15 ms                                                           |

### 5.9.32 SWVTT\_DIS: SWVTT Disable Register (offset = 9Fh) [reset = 0h]

SWVTT\_DIS is shown in [Figure 5-45](#) and described in [Table 5-39](#).

Return to [Summary Table](#).

**Figure 5-45. SWVTT\_DIS Register**

| 7        | 6        | 5        | 4       | 3        | 2 | 1 | 0 |
|----------|----------|----------|---------|----------|---|---|---|
| SWB2_DIS | SWB1_DIS | SWA1_DIS | VTT_DIS | RESERVED |   |   |   |
| R/W-0h   | R/W-0h   | R/W-0h   | R/W-0h  | R/W-0h   |   |   |   |

**Table 5-39. SWVTT\_DIS Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                   |
|-----|----------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | SWB2_DIS | R/W  | 0h    | SWB2 disable bit. Writing 0h to this bit forces SWB2 to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable.<br>1h = Enable. |
| 6   | SWB1_DIS | R/W  | 0h    | SWB1 disable bit. Writing 0 to this bit forces SWB1 to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable.<br>1h = Enable.  |
| 5   | SWA1_DIS | R/W  | 0h    | SWA1 disable bit. Writing 0 to this bit forces SWA1 to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable.<br>1h = Enable.  |
| 4   | VTT_DIS  | R/W  | 0h    | VTT Disable Bit. Writing 0 to this bit forces VTT to turn off regardless of any control input pin (CTL1–CTL6) status.<br><br>0h = Disable.<br>1h = Enable.    |
| 3-0 | Reserved | R/W  | 0h    | Reserved, Keep bit set to 0h at all times. Do not write to 1h.                                                                                                |

### 5.9.33 I2C\_RAIL\_EN1: VR Pin Enable Override1 Register (offset = A0h) [reset = 80h]

I2C\_RAIL\_EN1 is shown in [Figure 5-46](#) and described in [Table 5-40](#).

Return to [Summary Table](#).

**Figure 5-46. I2C\_RAIL\_EN1 Register**

| 7        | 6       | 5        | 4        | 3        | 2        | 1        | 0        |
|----------|---------|----------|----------|----------|----------|----------|----------|
| LDOA2_EN | SWA1_EN | BUCK6_EN | BUCK5_EN | BUCK4_EN | BUCK3_EN | BUCK2_EN | BUCK1_EN |
| R/W-1h   | R/W-0h  | R/W-0h   | R/W-0h   | R/W-0h   | R/W-0h   | R/W-0h   | R/W-0h   |

**Table 5-40. I2C\_RAIL\_EN1 Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                 |
|-----|----------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | LDOA2_EN | R/W  | 1h    | LDOA2 I <sup>2</sup> C enable<br>0h = LDOA2 is enabled or disabled by one of the control input pins or internal PG signal.<br>1h = LDOA2 is forced on unless LDOA2_DIS = 0. |
| 6   | SWA1_EN  | R/W  | 0h    | SWA1 I <sup>2</sup> C enable<br>0h = SWA1 is enabled or disabled by one of the control input pins or internal PG signal.<br>1h = SWA1 is forced on unless SWA1_DIS = 0.     |
| 5   | BUCK6_EN | R/W  | 0h    | BUCK6 I <sup>2</sup> C enable<br>0h = BUCK6 is enabled or disabled by one of the control input pins or internal PG signal.<br>1h = BUCK6 is forced on unless BUCK6_DIS = 0. |
| 4   | BUCK5_EN | R/W  | 0h    | BUCK5 I <sup>2</sup> C enable<br>0h = BUCK5 is enabled or disabled by one of the control input pins or internal PG signal.<br>1h = BUCK5 is forced on unless BUCK5_DIS = 0. |
| 3   | BUCK4_EN | R/W  | 0h    | BUCK4 I <sup>2</sup> C enable<br>0h = BUCK4 is enabled or disabled by one of the control input pins or internal PG signal.<br>1h = BUCK4 is forced on unless BUCK4_DIS = 0. |
| 2   | BUCK3_EN | R/W  | 0h    | BUCK3 I <sup>2</sup> C enable<br>0h = BUCK3 is enabled or disabled by one of the control input pins or internal PG signal.<br>1h = BUCK3 is forced on unless BUCK3_DIS = 0. |
| 1   | BUCK2_EN | R/W  | 0h    | BUCK2 I <sup>2</sup> C enable<br>0h = BUCK2 is enabled or disabled by one of the control input pins or internal PG signal.<br>1h = BUCK2 is forced on unless BUCK2_DIS = 0. |
| 0   | BUCK1_EN | R/W  | 0h    | BUCK1 I <sup>2</sup> C enable<br>0h = BUCK1 is enabled or disabled by one of the control input pins or internal PG signal.<br>1h = BUCK1 is forced on unless BUCK1_DIS = 0. |

### 5.9.34 I2C\_RAIL\_EN2/GPOCTRL: VR Pin Enable Override2/GPO Control Register (offset = A1h) [reset = 89h]

I2C\_RAIL\_EN2/GPOCTRL is shown in [Figure 5-47](#) and described in [Table 5-41](#).

Return to [Summary Table](#).

**Figure 5-47. I2C\_RAIL\_EN2/GPOCTRL Register**

| 7        | 6        | 5        | 4        | 3      | 2       | 1       | 0        |
|----------|----------|----------|----------|--------|---------|---------|----------|
| GPO4_LVL | GPO3_LVL | GPO2_LVL | GPO1_LVL | VTT_EN | SWB2_EN | SWB1_EN | LDOA3_EN |
| R/W-1h   | R/W-0h   | R/W-0h   | R/W-0h   | R/W-1h | R/W-0h  | R/W-0h  | R/W-1h   |

**Table 5-41. I2C\_RAIL\_EN2/GPOCTRL Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                                                                                                                          |
|-----|----------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | GPO4_LVL | R/W  | 1h    | The field is to set GPO4 pin output if the pin is factory-configured as an open-drain general-purpose output.<br>0h = The pin is driven to logic low.<br>1h = The pin is driven to logic high.                       |
| 6   | GPO3_LVL | R/W  | 0h    | The field is to set GPO3 pin output if the pin is factory-configured as either an open-drain or a push-pull general-purpose output.<br>0h = The pin is driven to logic low.<br>1h = The pin is driven to logic high. |
| 5   | GPO2_LVL | R/W  | 0h    | The field is to set GPO2 pin output if the pin is factory-configured as either an open-drain or a push-pull general-purpose output.<br>0h = The pin is driven to logic low.<br>1h = The pin is driven to logic high. |
| 4   | GPO1_LVL | R/W  | 0h    | The field is to set GPO1 pin output if the pin is factory-configured as either an open-drain or a push-pull general-purpose output.<br>0h = The pin is driven to logic low.<br>1h = The pin is driven to logic high. |
| 3   | VTT_EN   | R/W  | 1h    | VTT LDO I <sup>2</sup> C enable<br>0h = VTT LDO is enabled or disabled by one of the control input pins or internal PG signals.<br>1h = VTT LDO is forced on unless VTT_DIS = 0.                                     |
| 2   | SWB2_EN  | R/W  | 0h    | SWB2 I <sup>2</sup> C enable<br>0h = SWB2 is enabled or disabled by one of the control input pins or internal PG signals.<br>1h = SWB2 is forced on unless SWB2_DIS = 0.                                             |
| 1   | SWB1_EN  | R/W  | 0h    | SWB1 I <sup>2</sup> C enable<br>0h = SWB1 is enabled or disabled by one of the control input pins or internal PG signals.<br>1h = SWB1 is forced on unless SWB1_DIS = 0.                                             |
| 0   | LDOA3_EN | R/W  | 1h    | LDOA3 I <sup>2</sup> C enable<br>0h = LDOA3 is enabled or disabled by one of the control input pins or internal PG signals.<br>1h = LDOA3 is forced on unless LDOA3_DIS = 0.                                         |

### 5.9.35 PWR\_FAULT\_MASK1: VR Power Fault Mask1 Register (offset = A2h) [reset = C0h]

PWR\_FAULT\_MASK1 is shown in [Figure 5-48](#) and described in [Table 5-42](#).

Return to [Summary Table](#).

**Figure 5-48. PWR\_FAULT\_MASK1 Register**

| 7            | 6           | 5            | 4            | 3            | 2            | 1            | 0            |
|--------------|-------------|--------------|--------------|--------------|--------------|--------------|--------------|
| LDOA2_FLTMSK | SWA1_FLTMSK | BUCK6_FLTMSK | BUCK5_FLTMSK | BUCK4_FLTMSK | BUCK3_FLTMSK | BUCK2_FLTMSK | BUCK1_FLTMSK |
| R/W-1h       | R/W-0h      | R/W-0h       | R/W-0h       | R/W-0h       | R/W-0h       | R/W-0h       | R/W-0h       |

**Table 5-42. PWR\_FAULT\_MASK1 Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                        |
|-----|--------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------|
| 7   | LDOA2_FLTMSK | R/W  | 1h    | LDOA2 power fault mask. When masked, power fault from LDOA2 does not cause PMIC to shutdown.<br><br>0h = Not masked<br>1h = Masked |
| 6   | SWA1_FLTMSK  | R/W  | 0h    | SWA1 power fault mask. When masked, power fault from SWA1 does not cause PMIC to shutdown.<br><br>0h = Not masked<br>1h = Masked   |
| 5   | BUCK6_FLTMSK | R/W  | 0h    | BUCK6 power fault mask. When masked, power fault from BUCK6 does not cause PMIC to shutdown.<br><br>0h = Not masked<br>1h = Masked |
| 4   | BUCK5_FLTMSK | R/W  | 0h    | BUCK5 power fault mask. When masked, power fault from BUCK5 does not cause PMIC to shutdown.<br><br>0h = Not masked<br>1h = Masked |
| 3   | BUCK4_FLTMSK | R/W  | 0h    | BUCK4 power fault mask. When masked, power fault from BUCK4 does not cause PMIC to shutdown.<br><br>0h = Not masked<br>1h = Masked |
| 2   | BUCK3_FLTMSK | R/W  | 0h    | BUCK3 power fault mask. When masked, power fault from BUCK3 does not cause PMIC to shutdown.<br><br>0h = Not masked<br>1h = Masked |
| 1   | BUCK2_FLTMSK | R/W  | 0h    | BUCK2 power fault mask. When masked, power fault from BUCK2 does not cause PMIC to shutdown.<br><br>0h = Not masked<br>1h = Masked |
| 0   | BUCK1_FLTMSK | R/W  | 0h    | BUCK1 power fault mask. When masked, power fault from BUCK1 does not cause PMIC to shutdown.<br><br>0h = Not masked<br>1h = Masked |

### 5.9.36 PWR\_FAULT\_MASK2: VR Power Fault Mask2 Register (offset = A3h) [reset = 3Fh]

PWR\_FAULT\_MASK2 is shown in [Figure 5-49](#) and described in [Table 5-43](#).

Return to [Summary Table](#).

**Figure 5-49. PWR\_FAULT\_MASK2 Register**

| 7        | 6 | 5 | 4                | 3          | 2               | 1               | 0                |
|----------|---|---|------------------|------------|-----------------|-----------------|------------------|
| RESERVED |   |   | LDOA1_FLTMS<br>K | VTT_FLTMSK | SWB2_FLTMS<br>K | SWB1_FLTMS<br>K | LDOA3_FLTMS<br>K |
| R-1h     |   |   | R/W-1h           | R/W-1h     | R/W-1h          | R/W-1h          | R/W-1h           |

**Table 5-43. PWR\_FAULT\_MASK2 Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                        |
|-----|--------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------|
| 7-5 | RESERVED     | R    | 1h    |                                                                                                                                    |
| 4   | LDOA1_FLTMSK | R/W  | 1h    | LDOA1 power fault mask. When masked, power fault from LDOA1 does not cause PMIC to shutdown.<br>0h = Not masked<br>1h = Masked     |
| 3   | VTT_FLTMSK   | R/W  | 1h    | VTT LDO Power Fault Mask. When masked, power fault from VTT LDO does not cause PMIC to shutdown.<br>0h = Not masked<br>1h = Masked |
| 2   | SWB2_FLTMSK  | R/W  | 1h    | SWB2 power fault mask. When masked, power fault from SWB2 does not cause PMIC to shutdown.<br>0h = Not masked<br>1h = Masked       |
| 1   | SWB1_FLTMSK  | R/W  | 1h    | SWB1 power fault mask. When masked, power fault from SWB1 does not cause PMIC to shutdown.<br>0h = Not masked<br>1h = Masked       |
| 0   | LDOA3_FLTMSK | R/W  | 1h    | LDOA3 power fault mask. When masked, power fault from LDOA3 does not cause PMIC to shutdown.<br>0h = Not masked<br>1h = Masked     |

### 5.9.37 GPO1PG\_CTRL1: GPO1 PG Control1 Register (offset = A4h) [reset = C2h]

GPO1PG\_CTRL1 is shown in [Figure 5-50](#) and described in [Table 5-44](#).

Return to [Summary Table](#).

**Figure 5-50. GPO1PG\_CTRL1 Register**

| 7         | 6        | 5         | 4         | 3         | 2         | 1         | 0         |
|-----------|----------|-----------|-----------|-----------|-----------|-----------|-----------|
| LDOA2_MSK | SWA1_MSK | BUCK6_MSK | BUCK5_MSK | BUCK4_MSK | BUCK3_MSK | BUCK2_MSK | BUCK1_MSK |
| R/W-1h    | R/W-1h   | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    | R/W-1h    | R/W-0h    |

**Table 5-44. GPO1PG\_CTRL1 Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                       |
|-----|-----------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------|
| 7   | LDOA2_MSK | R/W  | 1h    | 0h = LDOA2 PG is part of power good tree of GPO1 pin.<br>1h = LDOA2 PG is NOT part of power good tree of GPO1 pin and is ignored. |
| 6   | SWA1_MSK  | R/W  | 1h    | 0h = SWA1 PG is part of power good tree of GPO1 pin.<br>1h = SWA1 PG is NOT part of power good tree of GPO1 pin and is ignored.   |
| 5   | BUCK6_MSK | R/W  | 0h    | 0h = BUCK6 PG is part of power good tree of GPO1 pin.<br>1h = BUCK6 PG is NOT part of power good tree of GPO1 pin and is ignored. |
| 4   | BUCK5_MSK | R/W  | 0h    | 0h = BUCK5 PG is part of power good tree of GPO1 pin.<br>1h = BUCK5 PG is NOT part of power good tree of GPO1 pin and is ignored. |
| 3   | BUCK4_MSK | R/W  | 0h    | 0h = BUCK4 PG is part of power good tree of GPO1 pin.<br>1h = BUCK4 PG is NOT part of power good tree of GPO1 pin and is ignored. |
| 2   | BUCK3_MSK | R/W  | 0h    | 0h = BUCK3 PG is part of power good tree of GPO1 pin.<br>1h = BUCK3 PG is NOT part of power good tree of GPO1 pin and is ignored. |
| 1   | BUCK2_MSK | R/W  | 1h    | 0h = BUCK2 PG is part of power good tree of GPO1 pin.<br>1h = BUCK2 PG is NOT part of power good tree of GPO1 pin and is ignored. |
| 0   | BUCK1_MSK | R/W  | 0h    | 0h = BUCK1 PG is part of power good tree of GPO1 pin.<br>1h = BUCK1 PG is NOT part of power good tree of GPO1 pin and is ignored. |

### 5.9.38 GPO1PG\_CTRL2: GPO1 PG Control2 Register (offset = A5h) [reset = AFh]

GPO1PG\_CTRL2 is shown in [Figure 5-51](#) and described in [Table 5-45](#).

Return to [Summary Table](#).

**Figure 5-51. GPO1PG\_CTRL2 Register**

| 7        | 6        | 5        | 4        | 3       | 2        | 1        | 0         |
|----------|----------|----------|----------|---------|----------|----------|-----------|
| CTL5_MSK | CTL4_MSK | CTL2_MSK | CTL1_MSK | VTT_MSK | SWB2_MSK | SWB1_MSK | LDOA3_MSK |
| R/W-1h   | R/W-0h   | R/W-1h   | R/W-0h   | R/W-1h  | R/W-1h   | R/W-1h   | R/W-1h    |

**Table 5-45. GPO1PG\_CTRL2 Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                                     |
|-----|-----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | CTL5_MSK  | R/W  | 1h    | 0h = CTL5 pin status is part of power good tree of GPO1 pin.<br>1h = CTL5 pin status is NOT part of power good tree of GPO1 pin and is ignored. |
| 6   | CTL4_MSK  | R/W  | 0h    | 0h = CTL4 pin status is part of power good tree of GPO1 pin.<br>1h = CTL4 pin status is NOT part of power good tree of GPO1 pin and is ignored. |
| 5   | CTL2_MSK  | R/W  | 1h    | 0h = CTL2 pin status is part of power good tree of GPO1 pin.<br>1h = CTL2 pin status is NOT part of power good tree of GPO1 pin and is ignored. |
| 4   | CTL1_MSK  | R/W  | 0h    | 0h = CTL1 pin status is part of power good tree of GPO1 pin.<br>1h = CTL1 pin status is NOT part of power good tree of GPO1 pin and is ignored. |
| 3   | VTT_MSK   | R/W  | 1h    | 0h = VTT LDO PG is part of power good tree of GPO1 pin.<br>1h = VTT LDO PG is NOT part of power good tree of GPO1 pin and is ignored.           |
| 2   | SWB2_MSK  | R/W  | 1h    | 0h = SWB2 pin status is part of power good tree of GPO1 pin.<br>1h = SWB2 pin status is NOT part of power good tree of GPO1 pin and is ignored. |
| 1   | SWB1_MSK  | R/W  | 1h    | 0h = SWB1 PG is part of power good tree of GPO1 pin.<br>1h = SWB1 PG is NOT part of power good tree of GPO1 pin and is ignored.                 |
| 0   | LDOA3_MSK | R/W  | 1h    | 0h = LDOA3 PG is part of power good tree of GPO1 pin.<br>1h = LDOA3 PG is NOT part of power good tree of GPO1 pin and is ignored.               |

### 5.9.39 GPO4PG\_CTRL1: GPO4 PG Control1 Register (offset = A6h) [reset = 0h]

GPO4PG\_CTRL1 is shown in [Figure 5-52](#) and described in [Table 5-46](#).

Return to [Summary Table](#).

**Figure 5-52. GPO4PG\_CTRL1 Register**

| 7         | 6        | 5         | 4         | 3         | 2         | 1         | 0         |
|-----------|----------|-----------|-----------|-----------|-----------|-----------|-----------|
| LDOA2_MSK | SWA1_MSK | BUCK6_MSK | BUCK5_MSK | BUCK4_MSK | BUCK3_MSK | BUCK2_MSK | BUCK1_MSK |
| R/W-0h    | R/W-0h   | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    |

**Table 5-46. GPO4PG\_CTRL1 Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                       |
|-----|-----------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------|
| 7   | LDOA2_MSK | R/W  | 0h    | 0h = LDOA2 PG is part of power good tree of GPO4 pin.<br>1h = LDOA2 PG is NOT part of power good tree of GPO4 pin and is ignored. |
| 6   | SWA1_MSK  | R/W  | 0h    | 0h = SWA1 PG is part of power good tree of GPO4 pin.<br>1h = SWA1 PG is NOT part of power good tree of GPO4 pin and is ignored.   |
| 5   | BUCK6_MSK | R/W  | 0h    | 0h = BUCK6 PG is part of power good tree of GPO4 pin.<br>1h = BUCK6 PG is NOT part of power good tree of GPO4 pin and is ignored. |
| 4   | BUCK5_MSK | R/W  | 0h    | 0h = BUCK5 PG is part of power good tree of GPO4 pin.<br>1h = BUCK5 PG is NOT part of power good tree of GPO4 pin and is ignored. |
| 3   | BUCK4_MSK | R/W  | 0h    | 0h = BUCK4 PG is part of power good tree of GPO4 pin.<br>1h = BUCK4 PG is NOT part of power good tree of GPO4 pin and is ignored. |
| 2   | BUCK3_MSK | R/W  | 0h    | 0h = BUCK3 PG is part of power good tree of GPO4 pin.<br>1h = BUCK3 PG is NOT part of power good tree of GPO4 pin and is ignored. |
| 1   | BUCK2_MSK | R/W  | 0h    | 0h = BUCK2 PG is part of power good tree of GPO4 pin.<br>1h = BUCK2 PG is NOT part of power good tree of GPO4 pin and is ignored. |
| 0   | BUCK1_MSK | R/W  | 0h    | 0h = BUCK1 PG is part of power good tree of GPO4 pin.<br>1h = BUCK1 PG is NOT part of power good tree of GPO4 pin and is ignored. |

### 5.9.40 GPO4PG\_CTRL2: GPO4 PG Control2 Register (offset = A7h) [reset = 0h]

GPO4PG\_CTRL2 is shown in [Figure 5-53](#) and described in [Table 5-47](#).

Return to [Summary Table](#).

**Figure 5-53. GPO4PG\_CTRL2 Register**

| 7        | 6        | 5        | 4        | 3       | 2        | 1        | 0         |
|----------|----------|----------|----------|---------|----------|----------|-----------|
| CTL5_MSK | CTL4_MSK | CTL2_MSK | CTL1_MSK | VTT_MSK | SWB2_MSK | SWB1_MSK | LDOA3_MSK |
| R/W-0h   | R/W-0h   | R/W-0h   | R/W-0h   | R/W-0h  | R/W-0h   | R/W-0h   | R/W-0h    |

**Table 5-47. GPO4PG\_CTRL2 Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                                     |
|-----|-----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | CTL5_MSK  | R/W  | 0h    | 0h = CTL5 pin status is part of power good tree of GPO4 pin.<br>1h = CTL5 pin status is NOT part of power good tree of GPO4 pin and is ignored. |
| 6   | CTL4_MSK  | R/W  | 0h    | 0h = CTL4 pin status is part of power good tree of GPO4 pin.<br>1h = CTL4 pin status is NOT part of power good tree of GPO4 pin and is ignored. |
| 5   | CTL2_MSK  | R/W  | 0h    | 0h = CTL2 pin status is part of power good tree of GPO4 pin.<br>1h = CTL2 pin status is NOT part of power good tree of GPO4 pin and is ignored. |
| 4   | CTL1_MSK  | R/W  | 0h    | 0h = CTL1 pin status is part of power good tree of GPO4 pin.<br>1h = CTL1 pin status is NOT part of power good tree of GPO4 pin and is ignored. |
| 3   | VTT_MSK   | R/W  | 0h    | 0h = VTT LDO PG is part of power good tree of GPO4 pin.<br>1h = VTT LDO PG is NOT part of power good tree of GPO4 pin and is ignored.           |
| 2   | SWB2_MSK  | R/W  | 0h    | 0h = SWB2 pin status is part of power good tree of GPO4 pin.<br>1h = SWB2 pin status is NOT part of power good tree of GPO4 pin and is ignored. |
| 1   | SWB1_MSK  | R/W  | 0h    | 0h = SWB1 PG is part of power good tree of GPO4 pin.<br>1h = SWB1 PG is NOT part of power good tree of GPO4 pin and is ignored.                 |
| 0   | LDOA3_MSK | R/W  | 0h    | 0h = LDOA3 PG is part of power good tree of GPO4 pin.<br>1h = LDOA3 PG is NOT part of power good tree of GPO4 pin and is ignored.               |

### 5.9.41 GPO2PG\_CTRL1: GPO2 PG Control1 Register (offset = A8h) [reset = C0h]

GPO2PG\_CTRL1 is shown in [Figure 5-54](#) and described in [Table 5-48](#).

Return to [Summary Table](#).

**Figure 5-54. GPO2PG\_CTRL1 Register**

| 7         | 6        | 5         | 4         | 3         | 2         | 1         | 0         |
|-----------|----------|-----------|-----------|-----------|-----------|-----------|-----------|
| LDOA2_MSK | SWA1_MSK | BUCK6_MSK | BUCK5_MSK | BUCK4_MSK | BUCK3_MSK | BUCK2_MSK | BUCK1_MSK |
| R/W-1h    | R/W-1h   | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    |

**Table 5-48. GPO2PG\_CTRL1 Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                       |
|-----|-----------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------|
| 7   | LDOA2_MSK | R/W  | 1h    | 0h = LDOA2 PG is part of power good tree of GPO2 pin.<br>1h = LDOA2 PG is NOT part of power good tree of GPO2 pin and is ignored. |
| 6   | SWA1_MSK  | R/W  | 1h    | 0h = SWA1 PG is part of power good tree of GPO2 pin.<br>1h = SWA1 PG is NOT part of power good tree of GPO2 pin and is ignored.   |
| 5   | BUCK6_MSK | R/W  | 0h    | 0h = BUCK6 PG is part of power good tree of GPO2 pin.<br>1h = BUCK6 PG is NOT part of power good tree of GPO2 pin and is ignored. |
| 4   | BUCK5_MSK | R/W  | 0h    | 0h = BUCK5 PG is part of power good tree of GPO2 pin.<br>1h = BUCK5 PG is NOT part of power good tree of GPO2 pin and is ignored. |
| 3   | BUCK4_MSK | R/W  | 0h    | 0h = BUCK4 PG is part of power good tree of GPO2 pin.<br>1h = BUCK4 PG is NOT part of power good tree of GPO2 pin and is ignored. |
| 2   | BUCK3_MSK | R/W  | 0h    | 0h = BUCK3 PG is part of power good tree of GPO2 pin.<br>1h = BUCK3 PG is NOT part of power good tree of GPO2 pin and is ignored. |
| 1   | BUCK2_MSK | R/W  | 0h    | 0h = BUCK2 PG is part of power good tree of GPO2 pin.<br>1h = BUCK2 PG is NOT part of power good tree of GPO2 pin and is ignored. |
| 0   | BUCK1_MSK | R/W  | 0h    | 0h = BUCK1 PG is part of power good tree of GPO2 pin.<br>1h = BUCK1 PG is NOT part of power good tree of GPO2 pin and is ignored. |

### 5.9.42 GPO2PG\_CTRL2: GPO2 PG Control2 Register (offset = A9h) [reset = 2Fh]

GPO2PG\_CTRL2 is shown in [Figure 5-55](#) and described in [Table 5-49](#).

Return to [Summary Table](#).

**Figure 5-55. GPO2PG\_CTRL2 Register**

| 7        | 6        | 5        | 4        | 3       | 2        | 1        | 0         |
|----------|----------|----------|----------|---------|----------|----------|-----------|
| CTL5_MSK | CTL4_MSK | CTL2_MSK | CTL1_MSK | VTT_MSK | SWB2_MSK | SWB1_MSK | LDOA3_MSK |
| R/W-0h   | R/W-0h   | R/W-1h   | R/W-0h   | R/W-1h  | R/W-1h   | R/W-1h   | R/W-1h    |

**Table 5-49. GPO2PG\_CTRL2 Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                                     |
|-----|-----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | CTL5_MSK  | R/W  | 0h    | 0h = CTL5 pin status is part of power good tree of GPO2 pin.<br>1h = CTL5 pin status is NOT part of power good tree of GPO2 pin and is ignored. |
| 6   | CTL4_MSK  | R/W  | 0h    | 0h = CTL4 pin status is part of power good tree of GPO2 pin.<br>1h = CTL4 pin status is NOT part of power good tree of GPO2 pin and is ignored. |
| 5   | CTL2_MSK  | R/W  | 1h    | 0h = CTL2 pin status is part of power good tree of GPO2 pin.<br>1h = CTL2 pin status is NOT part of power good tree of GPO2 pin and is ignored. |
| 4   | CTL1_MSK  | R/W  | 0h    | 0h = CTL1 pin status is part of power good tree of GPO2 pin.<br>1h = CTL1 pin status is NOT part of power good tree of GPO2 pin and is ignored. |
| 3   | VTT_MSK   | R/W  | 1h    | 0h = VTT LDO PG is part of power good tree of GPO2 pin.<br>1h = VTT LDO PG is NOT part of power good tree of GPO2 pin and is ignored.           |
| 2   | SWB2_MSK  | R/W  | 1h    | 0h = SWB2 pin status is part of power good tree of GPO2 pin.<br>1h = SWB2 pin status is NOT part of power good tree of GPO2 pin and is ignored. |
| 1   | SWB1_MSK  | R/W  | 1h    | 0h = SWB1 PG is part of power good tree of GPO2 pin.<br>1h = SWB1 PG is NOT part of power good tree of GPO2 pin and is ignored.                 |
| 0   | LDOA3_MSK | R/W  | 1h    | 0h = LDOA3 PG is part of power good tree of GPO2 pin.<br>1h = LDOA3 PG is NOT part of power good tree of GPO2 pin and is ignored.               |

### 5.9.43 GPO3PG\_CTRL1: GPO3 PG Control1 Register (offset = AAh) [reset = 0h]

GPO3PG\_CTRL1 is shown in [Figure 5-56](#) and described in [Table 5-50](#).

Return to [Summary Table](#).

**Figure 5-56. GPO3PG\_CTRL1 Register**

| 7         | 6        | 5         | 4         | 3         | 2         | 1         | 0         |
|-----------|----------|-----------|-----------|-----------|-----------|-----------|-----------|
| LDOA2_MSK | SWA1_MSK | BUCK6_MSK | BUCK5_MSK | BUCK4_MSK | BUCK3_MSK | BUCK2_MSK | BUCK1_MSK |
| R/W-0h    | R/W-0h   | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    | R/W-0h    |

**Table 5-50. GPO3PG\_CTRL1 Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                       |
|-----|-----------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------|
| 7   | LDOA2_MSK | R/W  | 0h    | 0h = LDOA2 PG is part of power good tree of GPO3 pin.<br>1h = LDOA2 PG is NOT part of power good tree of GPO3 pin and is ignored. |
| 6   | SWA1_MSK  | R/W  | 0h    | 0h = SWA1 PG is part of power good tree of GPO3 pin.<br>1h = SWA1 PG is NOT part of power good tree of GPO3 pin and is ignored.   |
| 5   | BUCK6_MSK | R/W  | 0h    | 0h = BUCK6 PG is part of power good tree of GPO3 pin.<br>1h = BUCK6 PG is NOT part of power good tree of GPO3 pin and is ignored. |
| 4   | BUCK5_MSK | R/W  | 0h    | 0h = BUCK5 PG is part of power good tree of GPO3 pin.<br>1h = BUCK5 PG is NOT part of power good tree of GPO3 pin and is ignored. |
| 3   | BUCK4_MSK | R/W  | 0h    | 0h = BUCK4 PG is part of power good tree of GPO3 pin.<br>1h = BUCK4 PG is NOT part of power good tree of GPO3 pin and is ignored. |
| 2   | BUCK3_MSK | R/W  | 0h    | 0h = BUCK3 PG is part of power good tree of GPO3 pin.<br>1h = BUCK3 PG is NOT part of power good tree of GPO3 pin and is ignored. |
| 1   | BUCK2_MSK | R/W  | 0h    | 0h = BUCK2 PG is part of power good tree of GPO3 pin.<br>1h = BUCK2 PG is NOT part of power good tree of GPO3 pin and is ignored. |
| 0   | BUCK1_MSK | R/W  | 0h    | 0h = BUCK1 PG is part of power good tree of GPO3 pin.<br>1h = BUCK1 PG is NOT part of power good tree of GPO3 pin and is ignored. |

#### 5.9.44 GPO3PG\_CTRL2: GPO3 PG Control2 Register (offset = ABh) [reset = 0h]

GPO3PG\_CTRL2 is shown in [Figure 5-57](#) and described in [Table 5-51](#).

Return to [Summary Table](#).

**Figure 5-57. GPO3PG\_CTRL2 Register**

| 7        | 6        | 5        | 4        | 3       | 2        | 1        | 0         |
|----------|----------|----------|----------|---------|----------|----------|-----------|
| CTL5_MSK | CTL4_MSK | CTL2_MSK | CTL1_MSK | VTT_MSK | SWB2_MSK | SWB1_MSK | LDOA3_MSK |
| R/W-0h   | R/W-0h   | R/W-0h   | R/W-0h   | R/W-0h  | R/W-0h   | R/W-0h   | R/W-0h    |

**Table 5-51. GPO3PG\_CTRL2 Field Descriptions**

| Bit | Field     | Type | Reset | Description                                                                                                                                     |
|-----|-----------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | CTL5_MSK  | R/W  | 0h    | 0h = CTL5 pin status is part of power good tree of GPO3 pin.<br>1h = CTL5 pin status is NOT part of power good tree of GPO3 pin and is ignored. |
| 6   | CTL4_MSK  | R/W  | 0h    | 0h = CTL4 pin status is part of power good tree of GPO3 pin.<br>1h = CTL4 pin status is NOT part of power good tree of GPO3 pin and is ignored. |
| 5   | CTL2_MSK  | R/W  | 0h    | 0h = CTL2 pin status is part of power good tree of GPO3 pin.<br>1h = CTL2 pin status is NOT part of power good tree of GPO3 pin and is ignored. |
| 4   | CTL1_MSK  | R/W  | 0h    | 0h = CTL1 pin status is part of power good tree of GPO3 pin.<br>1h = CTL1 pin status is NOT part of power good tree of GPO3 pin and is ignored. |
| 3   | VTT_MSK   | R/W  | 0h    | 0h = VTT LDO PG is part of power good tree of GPO3 pin.<br>1h = VTT LDO PG is NOT part of power good tree of GPO3 pin and is ignored.           |
| 2   | SWB2_MSK  | R/W  | 0h    | 0h = SWB2 pin status is part of power good tree of GPO3 pin.<br>1h = SWB2 pin status is NOT part of power good tree of GPO3 pin and is ignored. |
| 1   | SWB1_MSK  | R/W  | 0h    | 0h = SWB1 PG is part of power good tree of GPO3 pin.<br>1h = SWB1 PG is NOT part of power good tree of GPO3 pin and is ignored.                 |
| 0   | LDOA3_MSK | R/W  | 0h    | 0h = LDOA3 PG is part of power good tree of GPO3 pin.<br>1h = LDOA3 PG is NOT part of power good tree of GPO3 pin and is ignored.               |

### 5.9.45 MISCSYSPG Register (offset = ACh) [reset = FFh]

MISCSYSPG is shown in [Figure 5-58](#) and described in [Table 5-52](#).

Return to [Summary Table](#).

**Figure 5-58. MISCSYSPG Register**

| 7             | 6             | 5             | 4             | 3             | 2             | 1             | 0             |
|---------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|
| GPO1_CTL3_MSK | GPO1_CTL6_MSK | GPO4_CTL3_MSK | GPO4_CTL6_MSK | GPO2_CTL3_MSK | GPO2_CTL6_MSK | GPO3_CTL3_MSK | GPO3_CTL6_MSK |
| R/W-1h        | R/W-1h        | R/W-1h        | R/W-1h        | R/W-1h        | R/W-1h        | R/W-1h        | R/W-1h        |

**Table 5-52. MISCSYSPG Field Descriptions**

| Bit | Field         | Type | Reset | Description                                                                                                                      |
|-----|---------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------|
| 7   | GPO1_CTL3_MSK | R/W  | 1h    | 0h = CTL3 pin status is part of power good tree of GPO1 pin.<br>1h = CTL3 pin status is NOT part of power good tree of GPO1 pin. |
| 6   | GPO1_CTL6_MSK | R/W  | 1h    | 0h = CTL6 pin status is part of power good tree of GPO1 pin.<br>1h = CTL6 pin status is NOT part of power good tree of GPO1 pin. |
| 5   | GPO4_CTL3_MSK | R/W  | 1h    | 0h = CTL3 pin status is part of power good tree of GPO4 pin.<br>1h = CTL3 pin status is NOT part of power good tree of GPO4 pin. |
| 4   | GPO4_CTL6_MSK | R/W  | 1h    | 0h = CTL6 pin status is part of power good tree of GPO4 pin.<br>1h = CTL6 pin status is NOT part of power good tree of GPO4 pin. |
| 3   | GPO2_CTL3_MSK | R/W  | 1h    | 0h = CTL3 pin status is part of power good tree of GPO2 pin.<br>1h = CTL3 pin status is NOT part of power good tree of GPO2 pin. |
| 2   | GPO2_CTL6_MSK | R/W  | 1h    | 0h = CTL6 pin status is part of power good tree of GPO2 pin.<br>1h = CTL6 pin status is NOT part of power good tree of GPO2 pin. |
| 1   | GPO3_CTL3_MSK | R/W  | 1h    | 0h = CTL3 pin status is part of power good tree of GPO3 pin.<br>1h = CTL3 pin status is NOT part of power good tree of GPO3 pin. |
| 0   | GPO3_CTL6_MSK | R/W  | 1h    | 0h = CTL6 pin status is part of power good tree of GPO3 pin.<br>1h = CTL6 pin status is NOT part of power good tree of GPO3 pin. |

### 5.9.46 LDOA1CTRL: LDOA1 Control Register (offset = AEh) [reset = 7Dh]

LDOA1CTRL is shown in [Figure 5-59](#) and described in [Table 5-53](#).

Return to [Summary Table](#).

**Figure 5-59. LDOA1CTRL Register**

| 7                 | 6 | 5                 | 4              | 3 | 2 | 1        | 0 |
|-------------------|---|-------------------|----------------|---|---|----------|---|
| LDOA1_DISCHG[1:0] |   | LDOA1_SDWN_CONFIG | LDOA1_VID[3:0] |   |   | LDOA1_EN |   |
| R/W-1h            |   | R/W-1h            | R/W-Eh         |   |   | R/W-1h   |   |

**Table 5-53. LDOA1CTRL Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                                      |
|-----|-------------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | LDOA1_DISCHG[1:0] | R/W  | 1h    | LDOA1 discharge resistance<br>0h = no discharge<br>1h = 100 $\Omega$<br>2h = 200 $\Omega$<br>3h = 500 $\Omega$                                                                                                                   |
| 5   | LDOA1_SDWN_CONFIG | R/W  | 1h    | Control for Disabling LDOA1 during Emergency Shutdown<br>0h = LDOA1 will turn off during Emergency Shutdown for factory-programmable duration of 1 ms, 5 ms, 10 ms, or 100 ms.<br>1h = LDOA1 is controlled by LDOA1_EN bit only. |
| 4-1 | LDOA1_VID[3:0]    | R/W  | Eh    | This field sets the LDOA1 regulator output regulation voltage. See <a href="#">Table 5-4</a> for V <sub>OUT</sub> options.                                                                                                       |
| 0   | LDOA1_EN          | R/W  | 1h    | LDOA1 Enable Bit.<br>0h = Disable.<br>1h = Enable.                                                                                                                                                                               |

### 5.9.47 PG\_STATUS1: Power Good Status1 Register (offset = B0h) [reset = 0h]

PG\_STATUS1 is shown in [Figure 5-60](#) and described in [Table 5-54](#).

Return to [Summary Table](#).

**Figure 5-60. PG\_STATUS1 Register**

| 7                | 6               | 5                | 4                | 3                | 2                | 1                | 0                |
|------------------|-----------------|------------------|------------------|------------------|------------------|------------------|------------------|
| LDOA2_PGOOD<br>D | SWA1_PGOOD<br>D | BUCK6_PGOOD<br>D | BUCK5_PGOOD<br>D | BUCK4_PGOOD<br>D | BUCK3_PGOOD<br>D | BUCK2_PGOOD<br>D | BUCK1_PGOOD<br>D |
| R-0h             | R-0h            | R-0h             | R-0h             | R-0h             | R-0h             | R-0h             | R-0h             |

**Table 5-54. PG\_STATUS1 Field Descriptions**

| Bit | Field       | Type | Reset | Description                                                                                                                      |
|-----|-------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------|
| 7   | LDOA2_PGOOD | R    | 0h    | LDOA2 power good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range. |
| 6   | SWA1_PGOOD  | R    | 0h    | SWA1 power good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range.  |
| 5   | BUCK6_PGOOD | R    | 0h    | BUCK6 power good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range. |
| 4   | BUCK5_PGOOD | R    | 0h    | BUCK5 power good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range. |
| 3   | BUCK4_PGOOD | R    | 0h    | BUCK4 power good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range. |
| 2   | BUCK3_PGOOD | R    | 0h    | BUCK3 power good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range. |
| 1   | BUCK2_PGOOD | R    | 0h    | BUCK2 power good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range. |
| 0   | BUCK1_PGOOD | R    | 0h    | BUCK1 power good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range. |

### 5.9.48 PG\_STATUS2: Power Good Status2 Register (offset = B1h) [reset = 0h]

PG\_STATUS2 is shown in [Figure 5-61](#) and described in [Table 5-55](#).

Return to [Summary Table](#).

**Figure 5-61. PG\_STATUS2 Register**

| 7        | 6          | 5           | 4         | 3          | 2          | 1           | 0    |
|----------|------------|-------------|-----------|------------|------------|-------------|------|
| RESERVED | LDO5_PGOOD | LDOA1_PGOOD | VTT_PGOOD | SWB2_PGOOD | SWB1_PGOOD | LDOA3_PGOOD |      |
| R-0h     | R-0h       | R-0h        | R-0h      | R-0h       | R-0h       | R-0h        | R-0h |

**Table 5-55. PG\_STATUS2 Field Descriptions**

| Bit | Field       | Type | Reset | Description                                                                                                                        |
|-----|-------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------|
| 7-6 | RESERVED    | R    | 0h    |                                                                                                                                    |
| 5   | LDO5_PGOOD  | R    | 0h    | LDO5 Power Good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range.    |
| 4   | LDOA1_PGOOD | R    | 0h    | LDOA1 Power Good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range.   |
| 3   | VTT_PGOOD   | R    | 0h    | VTT LDO Power Good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range. |
| 2   | SWB2_PGOOD  | R    | 0h    | SWB2 Power Good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range.    |
| 1   | SWB1_PGOOD  | R    | 0h    | SWB1 Power Good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range.    |
| 0   | LDOA3_PGOOD | R    | 0h    | LDOA3 Power Good status.<br>0h = The output is not in target regulation range.<br>1h = The output is in target regulation range.   |

### 5.9.49 PWR\_FAULT\_STATUS1: Power Fault Status1 Register (offset = B2h) [reset = 0h]

PWR\_FAULT\_STATUS1 is shown in [Figure 5-62](#) and described in [Table 5-56](#).

Return to [Summary Table](#).

**Figure 5-62. PWR\_FAULT\_STATUS1 Register**

| 7                 | 6               | 5                 | 4                 | 3                 | 2                 | 1                 | 0                 |
|-------------------|-----------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|
| LDOA2_PWRFL<br>LT | SWA1_PWRFL<br>T | BUCK6_PWRFL<br>LT | BUCK5_PWRFL<br>LT | BUCK4_PWRFL<br>LT | BUCK3_PWRFL<br>LT | BUCK2_PWRFL<br>LT | BUCK1_PWRFL<br>LT |
| R/W-0h            | R/W-0h          | R/W-0h            | R/W-0h            | R/W-0h            | R/W-0h            | R/W-0h            | R/W-0h            |

**Table 5-56. PWR\_FAULT\_STATUS1 Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                                 |
|-----|--------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | LDOA2_PWRFLT | R    | 0h    | This fields indicates that LDOA2 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear. |
| 6   | SWA1_PWRFLT  | R    | 0h    | This fields indicates that SWA1 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear.  |
| 5   | BUCK6_PWRFLT | R    | 0h    | This fields indicates that BUCK6 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear. |
| 4   | BUCK5_PWRFLT | R    | 0h    | This fields indicates that BUCK5 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear. |
| 3   | BUCK4_PWRFLT | R    | 0h    | This fields indicates that BUCK4 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear. |
| 2   | BUCK3_PWRFLT | R    | 0h    | This fields indicates that BUCK3 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear. |
| 1   | BUCK2_PWRFLT | R    | 0h    | This fields indicates that BUCK2 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear. |
| 0   | BUCK1_PWRFLT | R    | 0h    | This fields indicates that BUCK1 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear. |

### 5.9.50 PWR\_FAULT\_STATUS2: Power Fault Status2 Register (offset = B3h) [reset = 0h]

PWR\_FAULT\_STATUS2 is shown in [Figure 5-63](#) and described in [Table 5-57](#).

Return to [Summary Table](#).

**Figure 5-63. PWR\_FAULT\_STATUS2 Register**

| 7        | 6 | 5 | 4            | 3          | 2           | 1           | 0            |
|----------|---|---|--------------|------------|-------------|-------------|--------------|
| RESERVED |   |   | LDOA1_PWRFLT | VTT_PWRFLT | SWB2_PWRFLT | SWB1_PWRFLT | LDOA3_PWRFLT |
| R-0h     |   |   | R/W-0h       | R/W-0h     | R/W-0h      | R/W-0h      | R/W-0h       |

**Table 5-57. PWR\_FAULT\_STATUS2 Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                                  |
|-----|--------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------|
| 7-5 | RESERVED     | R    | 0h    |                                                                                                                                              |
| 4   | LDOA1_PWRFLT | R/W  | 0h    | This field indicates that LDOA1 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear.   |
| 3   | VTT_PWRFLT   | R/W  | 0h    | This field indicates that VTT LDO has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear. |
| 4   | SWB2_PWRFLT  | R/W  | 0h    | This field indicates that SWB2 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear.    |
| 3   | SWB1_PWRFLT  | R/W  | 0h    | This field indicates that SWB1 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear.    |
| 0   | LDOA3_PWRFLT | R/W  | 0h    | This field indicates that LDOA3 has lost its regulation.<br>0h = No Fault.<br>1h = Power fault has occurred. The host to write 1 to clear.   |

### 5.9.51 TEMPCRIT: Temperature Fault Status Register (offset = B4h) [reset = 0h]

TEMPCRIT is shown in [Figure 5-64](#) and described in [Table 5-58](#).

Return to [Summary Table](#).

Asserted when an internal temperature sensor detects rise of die temperature above the CRITICAL temperature threshold ( $T_{CRIT}$ ). There are 5 temperature sensors across the die.

**Figure 5-64. TEMPCRIT Register**

| 7        | 6 | 5 | 4        | 3        | 2                  | 1                 | 0                     |
|----------|---|---|----------|----------|--------------------|-------------------|-----------------------|
| RESERVED |   |   | DIE_CRIT | VTT_CRIT | TOP-<br>RIGHT_CRIT | TOP-<br>LEFT_CRIT | BOTTOM-<br>RIGHT_CRIT |
| R-0h     |   |   | R/W-0h   | R/W-0h   | R/W-0h             | R/W-0h            | R/W-0h                |

**Table 5-58. TEMPCRIT Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                |
|-----|-------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-5 | RESERVED          | R    | 0h    |                                                                                                                                                                                                            |
| 4   | DIE_CRIT          | R/W  | 0h    | Temperature of rest of die has exceeded $T_{CRIT}$ .<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear.                                                                                 |
| 3   | VTT_CRIT          | R/W  | 0h    | Temperature of VTT LDO has exceeded $T_{CRIT}$ .<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear.                                                                                     |
| 2   | TOP-RIGHT_CRIT    | R/W  | 0h    | Temperature of die Top-Right has exceeded $T_{CRIT}$ . Top-Right corner of die from top view given pin1 is in Top-Left corner.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear.       |
| 1   | TOP-LEFT_CRIT     | R/W  | 0h    | Temperature of die Top-Left has exceeded $T_{CRIT}$ . Top-Left corner of die from top view given pin1 is in Top-Left corner.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear.         |
| 0   | BOTTOM-RIGHT_CRIT | R/W  | 0h    | Temperature of die Bottom-Right has exceeded $T_{CRIT}$ . Bottom-Right corner of die from top view given pin1 is in Top-Left corner.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear. |

### 5.9.52 TEMPHOT: Temperature Hot Status Register (offset = B5h) [reset = 0h]

TEMPHOT is shown in [Figure 5-65](#) and described in [Table 5-59](#).

Return to [Summary Table](#).

Asserted when an internal temperature sensor detects rise of die temperature above the HOT temperature threshold ( $T_{HOT}$ ). There are 5 temperature sensors across the die.

**Figure 5-65. TEMPHOT Register**

| 7        | 6 | 5 | 4       | 3       | 2                 | 1                | 0                    |
|----------|---|---|---------|---------|-------------------|------------------|----------------------|
| RESERVED |   |   | DIE_HOT | VTT_HOT | TOP-<br>RIGHT_HOT | TOP-<br>LEFT_HOT | BOTTOM-<br>RIGHT_HOT |
| R-0h     |   |   | R/W-0h  | R/W-0h  | R/W-0h            | R/W-0h           | R/W-0h               |

**Table 5-59. TEMPHOT Field Descriptions**

| Bit | Field            | Type | Reset | Description                                                                                                                                                                                           |
|-----|------------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-5 | RESERVED         | R    | 0h    |                                                                                                                                                                                                       |
| 4   | DIE_HOT          | R/W  | 0h    | Temperature of rest of die has exceeded $T_{HOT}$ .<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear.                                                                             |
| 3   | VTT_HOT          | R/W  | 0h    | Temperature of VTT LDO has exceeded $T_{HOT}$ .<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear.                                                                                 |
| 2   | TOP-RIGHT_HOT    | R/W  | 0h    | Temperature of Top-Right has exceeded $T_{HOT}$ . Top-Right corner of die from top view given pin1 is in Top-Left corner.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear.       |
| 1   | TOP-LEFT_HOT     | R/W  | 0h    | Temperature of Top-Left has exceeded $T_{HOT}$ . Top-Left corner of die from top view given pin1 is in Top-Left corner.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear.         |
| 0   | BOTTOM-RIGHT_HOT | R/W  | 0h    | Temperature of Bottom-Right has exceeded $T_{HOT}$ . Bottom-Right corner of die from top view given pin1 is in Top-Left corner.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear. |

### 5.9.53 OC\_STATUS: Overcurrent Fault Status Register (offset = B6h) [reset = 0h]

OC\_STATUS is shown in [Figure 5-66](#) and described in [Table 5-60](#).

Return to [Summary Table](#).

Asserted when overcurrent condition is detected from a LSD FET.

**Figure 5-66. OC\_STATUS Register**

| 7        | 6 | 5 | 4 | 3 | 2        | 1        | 0        |
|----------|---|---|---|---|----------|----------|----------|
| RESERVED |   |   |   |   | BUCK6_OC | BUCK2_OC | BUCK1_OC |
| R-0h     |   |   |   |   | R/W-0h   | R/W-0h   | R/W-0h   |

**Table 5-60. OC\_STATUS Field Descriptions**

| Bit | Field    | Type | Reset | Description                                                                                                        |
|-----|----------|------|-------|--------------------------------------------------------------------------------------------------------------------|
| 7-3 | RESERVED | R    | 0h    |                                                                                                                    |
| 2   | BUCK6_OC | R/W  | 0h    | BUCK6 LSD FET overcurrent has been detected.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear. |
| 1   | BUCK2_OC | R/W  | 0h    | BUCK2 LSD FET overcurrent has been detected.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear. |
| 0   | BUCK1_OC | R/W  | 0h    | BUCK1 LSD FET overcurrent has been detected.<br>0h = Not asserted.<br>1h = Asserted. The host to write 1 to clear. |

## 6 Applications, Implementation, and Layout

### 注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 6.1 Application Information

The TPS6508700 device can be used in several different applications from computing, industrial interfacing and much more. 节 6.2 describes the general application information and provides a more detailed description on the TPS6508700 device that powers the AMD system. 图 6-2 shows the functional block diagram for the device, which outlines the typical external connections required for proper device functionality.

### 6.2 Typical Application

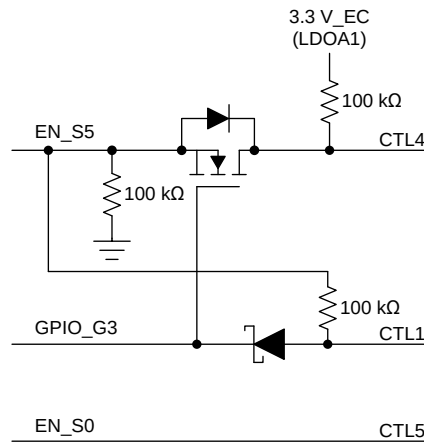
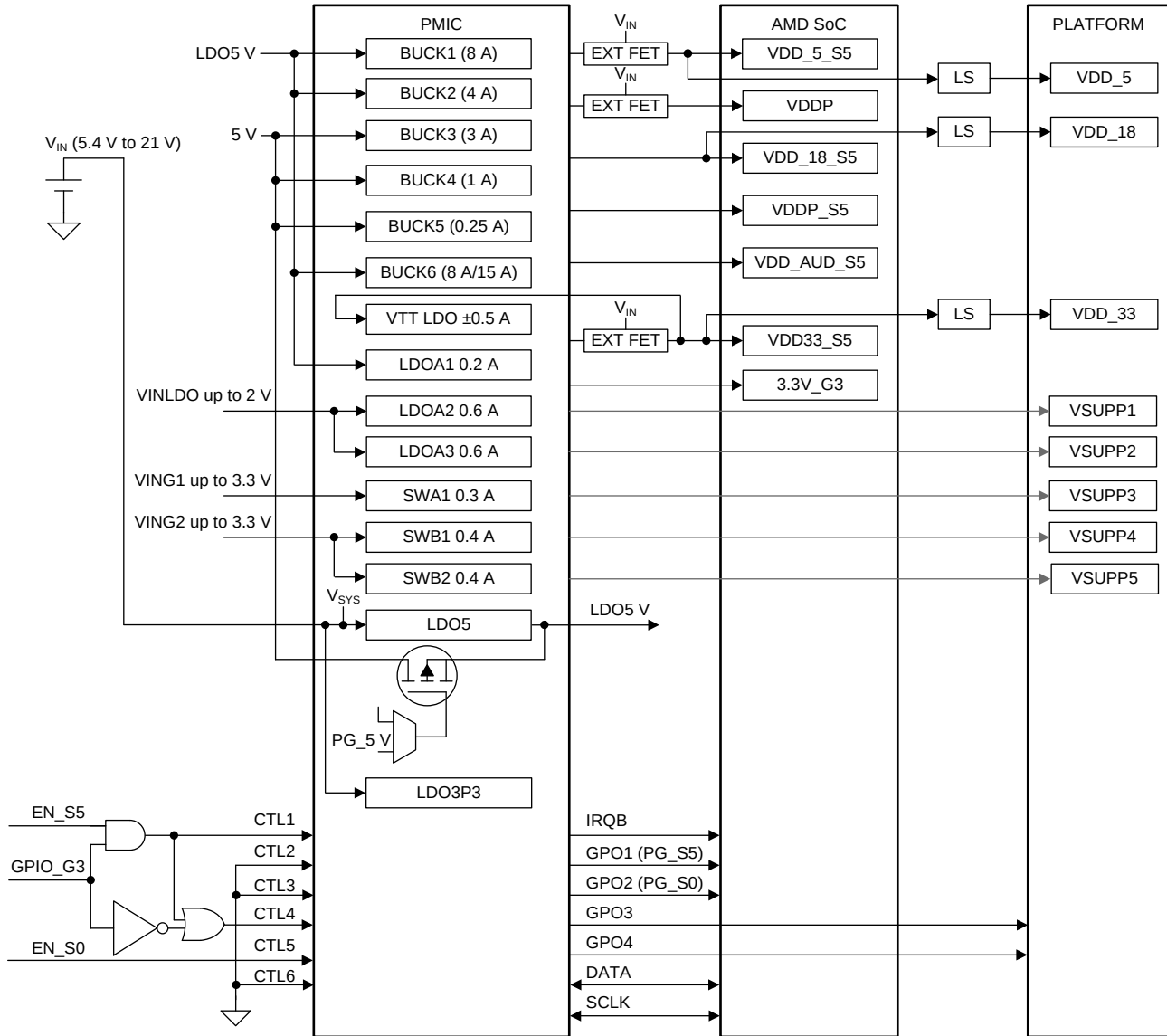


图 6-1. CTL Pin Implementation Option



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图 6-2. Typical Application Example

### 6.2.1 Design Requirements

The TPS6508700 device requires decoupling capacitors on the supply pins. Follow the values for recommended capacitance on these supplies given in [Section 4](#). The controllers, converter, LDOs, and some other features can be adjusted to meet specific application needs. [节 6.2.2](#) describes how to design and adjust the external components to achieve the desired performance. In most cases, the controller and converter designs should be copied directly from the AMD reference design. If significant changes must be made, some guidelines are provided in [节 6.2.2](#).

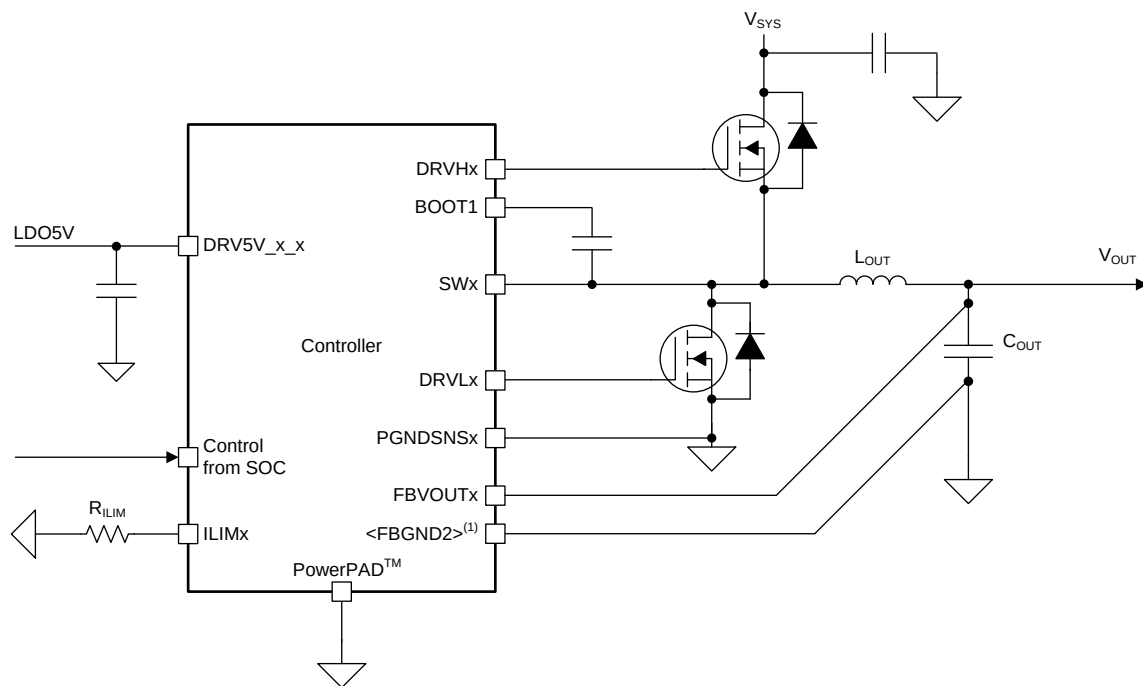
## 6.2.2 Detailed Design Procedure

### 6.2.2.1 Controller Design Procedure

Designing the controller can be broken down into the following steps:

1. Design the output filter
2. Select the FETs
3. Select the bootstrap capacitor
4. Select the input capacitors
5. Set the current limits

The BUCK1, BUCK2, and BUCK6 controllers require a 5-V supply and capacitors at their corresponding DRV5V\_x\_x pins. For most applications, the DRV5V\_x\_x input must come from the LDO5P0 pin to ensure uninterrupted supply voltage. A 2.2-μF, X5R, 20%, 10-V, or similar capacitor must be used for decoupling.



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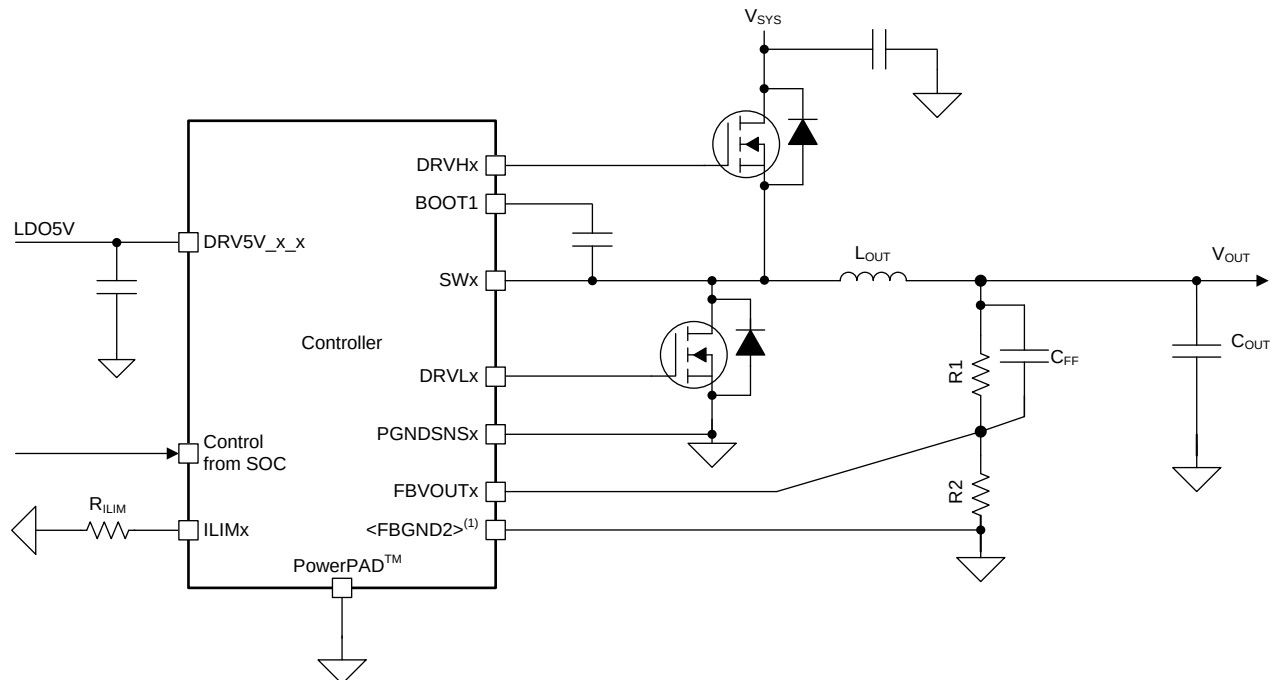
图 6-3. Controller Diagram

#### 6.2.2.1.1 Controller With External Feedback Resistor

For BUCK1, the voltage can be set using external feedback resistor. For all other bucks, the voltage is set by the default OTP settings and no resistor divider is required. For BUCK1, The internal voltage reference is set to 0.4 V. The output voltage is set with a resistor divider from the output node to the FB pin. TI recommends using a 1% tolerance or better to get accurate number. Use 公式 3 to calculate the value of R2.

$$R2 = R1 (0.4 / V_O - 0.4) \quad (3)$$

To set the output voltage to 5 V, use a value of 294 kΩ for R1 and 25.5 kΩ for R2.



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图 6-4. Controller Diagram With External Feedback Resistor

#### 6.2.2.1.2 Selecting the Inductor

Placement of an inductor is required between the external FETs and the output capacitors. Together, the inductor and output capacitors make the double-pole that contributes to stability. Additionally, the inductor is directly responsible for the output ripple, efficiency, and transient performance. As the inductance used increases, the ripple current decreases, which typically results in increased efficiency. However, as the inductance used increases, the transient performance decreases. Finally, the inductor selected must be rated for appropriate saturation current, core losses, and DC resistance (DCR).

Use 公式 4 to calculate the recommended inductance for the controller.

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times f_{SW} \times I_{OUT(MAX)} \times K_{IND}}$$

where

- $V_{OUT}$  is the typical output voltage.
- $V_{IN}$  is the typical input voltage.
- $f_{SW}$  is the typical switching frequency.
- $I_{OUT(MAX)}$  is the maximum load current.
- $K_{IND}$  is the ratio of  $I_{L(ripple)}$  to the  $I_{OUT(MAX)}$ . For this application, TI recommends that  $K_{IND}$  is set to a value from 0.2 to 0.4.

(4)

With the chosen inductance value, the peak current for the inductor in steady state operation,  $I_{L(MAX)}$ , can be calculated using 公式 5. The rated saturation current of the inductor must be higher than the  $I_{L(MAX)}$  current.

$$I_{L(MAX)} = I_{OUT(MAX)} + \frac{(V_{IN} - V_{OUT}) \times V_{OUT}}{2 \times V_{IN} \times f_{SW} \times L}$$

(5)

### 6.2.2.1.3 Selecting the Output Capacitors

TI recommends using ceramic capacitors with low ESR values to provide the lowest output voltage ripple. The output capacitor requires an X7R or an X5R dielectric. Y5V and Z5U dielectric capacitors, aside from their wide variation in capacitance over temperature, become resistive at high frequencies.

At light load currents, the controller operates in PFM mode, and the output voltage ripple is dependent on the output-capacitor value and the PFM peak inductor current. Higher output-capacitor values minimize the voltage ripple in PFM mode. To achieve the specified regulation performance and low output-voltage ripple, the DC-bias characteristic of ceramic capacitors must be considered. The effective capacitance of ceramic capacitors drops with increasing DC bias voltage.

TI recommends using small ceramic capacitors placed between the inductor and load with many vias to the power ground (PGND) plane for the output capacitors of the buck controllers. This solution typically provides the smallest and lowest cost solution available for D-CAP2 controllers.

The selection of the output capacitor is typically driven by the output transient response. 公式 6 provides a rough estimate of the minimum required capacitance to ensure proper transient response. Because the transient response is significantly affected by the board layout, some experimentation is expected to confirm that values derived in this section are applicable to any particular use case. 公式 6 is not meant to be an absolute requirement, but rather a rough starting point. Alternatively, some known combination values from which to begin are provided in 表 6-1.

$$C_{OUT} > \frac{I_{TRAN(MAX)}^2 \times L}{(V_{IN} - V_{OUT}) \times V_{UNDER}}$$

where

- $I_{TRAN(MAX)}$  is the maximum load current step.
- $L$  is the chosen inductance.
- $V_{OUT}$  is the minimum programmed output voltage.
- $V_{IN}$  is the maximum input voltage.
- $V_{UNDER}$  is the minimum allowable undershoot from the programmable voltage.

(6)

In cases where the transient current change is very low, the DC stability may become important. Use 公式 7 to calculate the approximate amount of capacitance required to maintain DC stability. Again, this equation is provided as a starting point; actual values will vary on a board-to-board case.

$$C_{OUT} > \frac{V_{OUT} \times 50 \mu s}{V_{IN} \times f_{SW} \times L}$$

where

- $V_{OUT}$  is the maximum programmed output voltage
- 50  $\mu s$  is based on internal ramp setup
- $V_{IN}$  is the minimum input voltage
- $f_{SW}$  is the typical switching frequency
- $L$  is the chosen inductance

(7)

The maximum valuable between 公式 6 and 公式 7 must be selected. 表 6-1 lists some known inductor-capacitor combinations.

**表 6-1. Known LC Combinations**

| $I_{TRAN(max)}$ (A) | $L$ ( $\mu H$ ) | $V_{OUT}$ (V) | $V_{UNDER}$ (V) | $C_{OUT}(\mu F)$ |
|---------------------|-----------------|---------------|-----------------|------------------|
| 3.5                 | 0.47            | 1             | 0.05            | 110              |
| 4                   | 0.47            | 1             | 0.05            | 220              |
| 5                   | 0.47            | 1.35          | 0.068           | 220              |
| 8                   | 0.33            | 1             | 0.06            | 440              |
| 20                  | 0.22            | 1             | 0.16            | 550              |

#### 6.2.2.1.4 Selecting the FETs

This controller is designed to drive two NMOS FETs. Typically, lower  $R_{DS(on)}$  values are better for improving the overall efficiency of the controller; however, higher gate-charge thresholds result in lower efficiency so the two values must be balanced for optimal performance. As the  $R_{DS(on)}$  for the low-side FET decreases, the minimum current limit increases; therefore, appropriately select the values for the FETs, inductor, output capacitors, and current limit resistor. TI's [CSD87331Q3D](#), [CSD87381P](#), and [CSD87588N](#) devices are recommended for the controllers, depending on the required maximum current.

#### 6.2.2.1.5 Bootstrap Capacitor

To ensure the internal high-side gate drivers are supplied with a stable low-noise supply voltage, a capacitor must be connected between the SWx pins and the respective BOOTx pins. TI recommends placing ceramic capacitors with a value of 0.1  $\mu$ F for the controllers. During testing, a 0.1- $\mu$ F, size 0402, 10-V capacitor is used for the controllers.

TI recommends reserving a small resistor in series with the bootstrap capacitor in case the turnon and turnoff of the FETs must be slowed to reduce voltage ringing on the switch node, which is a common practice for controller design.

#### 6.2.2.1.6 Setting the Current Limit

The current-limiting resistor value must be chosen based on [公式 1](#).

#### 6.2.2.1.7 Selecting the Input Capacitors

Because of the nature of the switching controller with a pulsating input current, a low-ESR input capacitor is required for best input-voltage filtering and also for minimizing the interference with other circuits caused by high input-voltage spikes. For the controller, a typical 2.2- $\mu$ F capacitor can be used for the DRV5V\_x\_x pin to support the transients on the driver. For the FET input, 10  $\mu$ F of input capacitance (after derating) is recommended for most applications. To achieve the low-ESR requirement, a ceramic capacitor is recommended. However, the voltage rating and DC-bias characteristic of ceramic capacitors must be considered. For better input-voltage filtering, the input capacitor can be increased without any limit.

#### 注

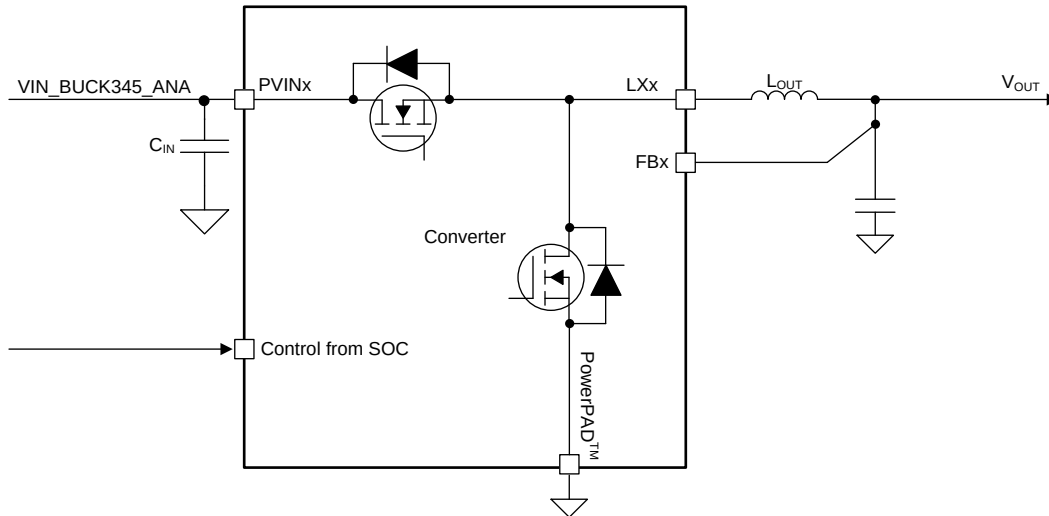
Use the correct capacitance value for the ceramic capacitor after derating to achieve the recommended input capacitance.

TI recommends placing a ceramic capacitor as close as possible to the FET across the respective VSYS and PGND pins of the FETs. The preferred capacitors for the controllers are two Murata GRM21BR61E226ME44: 22- $\mu$ F, 0805, 25-V,  $\pm 20\%$ , or similar capacitors.

#### 6.2.2.2 Converter Design Procedure

Designing the converter has only two steps: design the output filter and select the input capacitors.

The converter must be supplied by a 5-V source. [图 6-5](#) shows a diagram of the converter.



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**图 6-5. Converter Diagram****6.2.2.2.1 Selecting the Inductor**

Placement of an inductor between the external FETs and the output capacitors is required. Together, the inductor and output capacitors form a double pole in the control loop that contributes to stability. Additionally, the inductor is directly responsible for the output ripple, efficiency, and transient performance. As the inductance used increases, the ripple current decreases, which typically results in an increase in efficiency. However, with an increase in inductance used, the transient performance decreases. Finally, the inductor selected must be rated for appropriate saturation current, core losses, and DCR.

**注**

Internal parameters for the converters are optimized for a 0.47-μH inductor for BUCK3 and a 1-μH inductor for BUCK4 and BUCK5; however, using other inductor values is possible as long as they are chosen carefully and thoroughly tested.

$$L = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times f_{SW} \times I_{OUT(MAX)} \times K_{IND}} \quad (8)$$

With the chosen inductance value and the peak current for the inductor in steady state operation,  $I_{L(MAX)}$  can be calculated using 公式 9. The rated saturation current of the inductor must be higher than the  $I_{L(MAX)}$  current.

$$I_{L(MAX)} = I_{OUT(MAX)} + \frac{(V_{IN} - V_{OUT}) \times V_{OUT}}{2 \times V_{IN} \times f_{SW} \times L} \quad (9)$$

**6.2.2.2.2 Selecting the Output Capacitors**

Ceramic capacitors with low ESR values are recommended because they provide the lowest output voltage ripple. The output capacitor requires either an X7R or X5R rating. Y5V and Z5U capacitors, aside from the wide variation in capacitance over temperature, become resistive at high frequencies.

At light load currents, the converter operates in PFM mode and the output voltage ripple is dependent on the output-capacitor value and the PFM peak inductor current. Higher output-capacitor values minimize the voltage ripple in PFM mode. To achieve the specified regulation performance and low output-voltage ripple, the DC-bias characteristic of ceramic capacitors must be considered. The effective capacitance of ceramic capacitors drops with increasing DC-bias voltage.

For the output capacitors of the buck converters, TI recommends placing small ceramic capacitors between the inductor and load with many vias to the PGND plane. This solution typically provides the smallest and lowest-cost solution available for D-CAP2 controllers.

The output capacitance must equal or exceed the minimum capacitance listed for BUCK3, BUCK4, and BUCK5 (assuming quality layout techniques are followed).

### 6.2.2.2.3 Selecting the Input Capacitors

Because of the nature of the switching converter with a pulsating input current, a low-ESR input capacitor is required for the best input-voltage filtering and for minimizing the interference with other circuits caused by high input-voltage spikes. For the PVINx pin, 2.5  $\mu\text{F}$  of input capacitance (after derating) is required for most applications. A ceramic capacitor is recommended to achieve the low-ESR requirement. However, the voltage rating and DC-bias characteristic of ceramic capacitors must be considered. The input capacitor can be increased without any limit for better input-voltage filtering.

#### 注

Use the correct capacitance value for the ceramic capacitor after derating to achieve the recommended input capacitance.

The preferred capacitor for the converters is one Samsung CL05A106MP5NUNC: 10- $\mu\text{F}$ , 0402, 10-V,  $\pm 20\%$ , or similar capacitor.

### 6.2.2.3 LDO Design Procedure

The VTT LDO must support the fast load transients from the DDR memory for termination. Therefore, TI recommends using ceramic capacitors to maintain a high amount of capacitance with low ESR on the VTT LDO outputs and inputs. The preferred output capacitors for the VTT LDO are the GRM188R60J226MEA0 from Murata (22  $\mu\text{F}$ , 0603, 6.3 V,  $\pm 20\%$ , or similar capacitors). The preferred input capacitor for the VTT LDO is the CL05A106MP5NUNC from Samsung (10- $\mu\text{F}$ , 0402, 10-V,  $\pm 20\%$ , or similar capacitor).

The remaining LDOs must have input and output capacitors chosen based on the values in [Section 4.9](#).

## 6.2.3 Application Curves

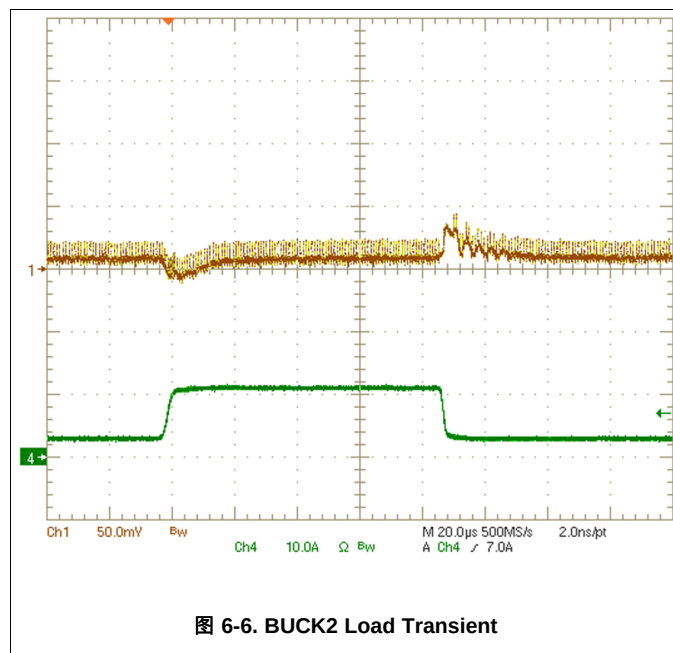


图 6-6. BUCK2 Load Transient

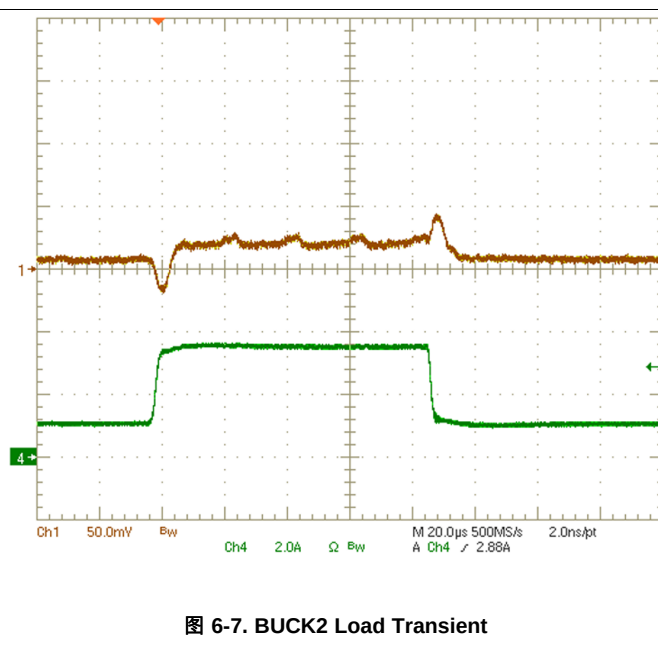


图 6-7. BUCK2 Load Transient

## 6.2.4 Layout

### 6.2.4.1 Layout Guidelines

For all switching power supplies, the layout is an important step in the design, especially at high peak currents and high switching frequencies. If the layout is not carefully done, the regulator can have stability problems and EMI issues. Therefore, use wide and short traces for the main current path and for the power ground (PGND) tracks. The input capacitors, output capacitors, and inductors must be placed as close as possible to the device. Use a common-ground node for the power ground and use a different, isolated node for the control ground to minimize the effects of ground noise. Connect these ground nodes close to the AGND pin by one or two vias. Use of the design guide is highly recommended in addition to following these other basic requirements:

- Do not allow the AGND, PGND<sub>SNSx</sub>, or FBGND2 pin to connect to the thermal pad on the top layer.
- To ensure proper sensing based on the FET  $R_{DS(on)}$ , the PGND<sub>SNSx</sub> pin must not connect to the board ground or to the PGND pin of the FET.
- All inductors, input and output capacitors, and FETs for the converters and controller must be on the same board layer as the device.
- To achieve the best regulation performance, place feedback connection points near the output capacitors and minimize the control feedback loop as much as possible.
- Bootstrap capacitors must be placed close to the device.
- The internal reference regulators must have their input and output capacitors placed close to the device pins.
- Route the DRVHx and SWx pins as a differential pair. Ensure that a power-ground path is routed in parallel with the DRVLx pin, which provides optimal driver loops.

### 6.2.4.2 Layout Example

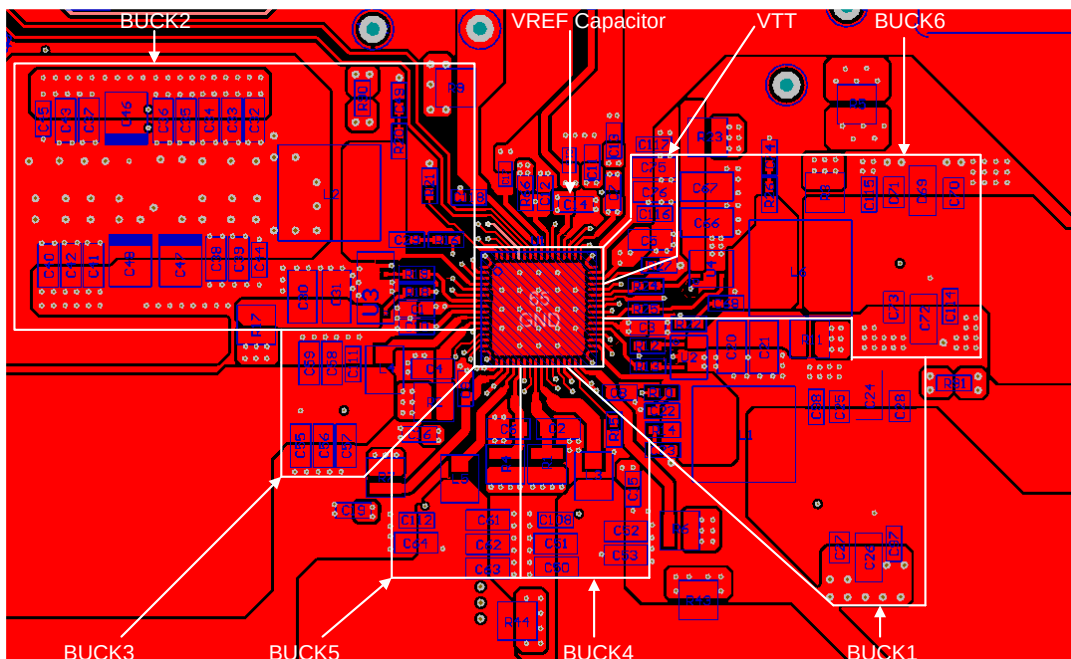


图 6-8. EVM Layout Example With All Components on the Top Layer

### 6.3 Power Supply Coupling and Bulk Capacitors

This device is designed to work with several different input voltages. The minimum voltage on the VSYS pin is 5.6 V for the device to start up; however, this is a low power rail. The input to the FETs must be from 4.5 V to 21 V as long as the proper bill of materials (BOM) choices are made. The input to the converters must be 5 V. For the device to output maximum power, the input power must be sufficient. For the controllers,  $V_{IN}$  must be able to supply sufficient input current for the output power of the application. For the converters, the PVINx converter must be able to supply 2 A (typical).

As a best practice, determine the power usage by the system and back-calculate the necessary power input based on the expected efficiency values.

### 6.4 Do's and Don'ts

- Connect the LDO5V output to the DRV5V\_x\_x inputs. This output initially supplies 5 V for the drivers from the VSYS pin and then switches to using the 5-V buck converter when available for optimal efficiency.
- Ensure that none of the control pins are potentially floating.
- Include 0- $\Omega$  resistors on the DRVH or BOOT pins of the controllers on prototype boards, which allows for slowing the controllers if the system is unable to handle the noise generated by the large switching or if switching voltage is too large because of layout.
- Do not connect the V5ANA power input to a different source other than PVINx. A mismatch here causes reference circuits to regulate incorrectly.
- Do not supply the V5ANA power input before the VSYS. Reference biasing of the internal FETs may turn on the HS FET passing the input to the output until VSYS is biased.

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### 7.2 文档支持

#### 7.2.1 相关文档

请参阅如下相关文档：

- 德州仪器 (TI)，《CSD87331Q3D 同步降压 NexFET™ 电源块》数据表
- 德州仪器 (TI)，《CSD87381P 同步降压 NexFET™ 电源块 II》数据表
- 德州仪器 (TI)，《CSD87588N 同步降压 NexFET™ 电源块 II》数据表

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### 7.6 静电放电警告



ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

### 7.7 术语表

**TI 术语表** 这份术语表列出并解释术语、缩写和定义。

## 8 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。这些数据如有变更，恕不另行通知和修订此文档。如欲获取此数据表的浏览器版本，请参阅左侧的导航。

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS6508700RSKR   | ACTIVE        | VQFN         | RSK                | 64   | 2000           | RoHS & Green    | NIPDAU                               | Level-3-260C-168 HR  | -40 to 85    | T6508700<br>PG1.0       | <a href="#">Samples</a> |
| TPS6508700RSKT   | ACTIVE        | VQFN         | RSK                | 64   | 250            | RoHS & Green    | NIPDAU                               | Level-3-260C-168 HR  | -40 to 85    | T6508700<br>PG1.0       | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

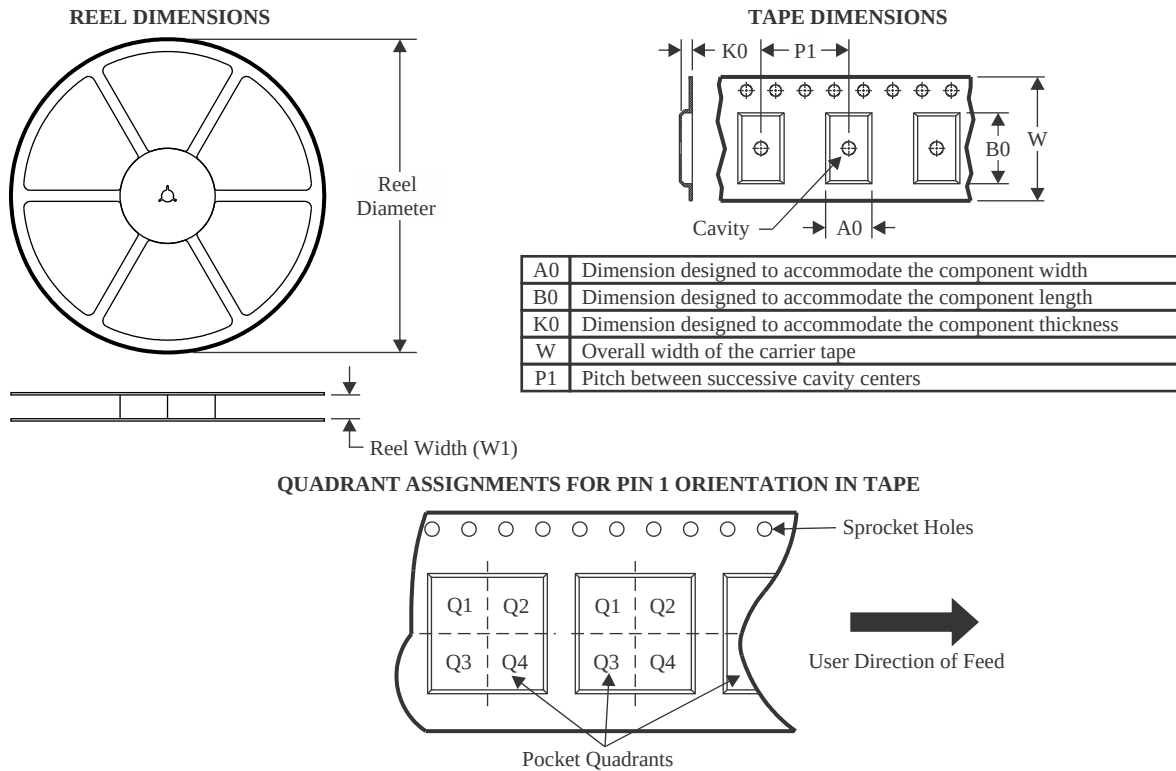
(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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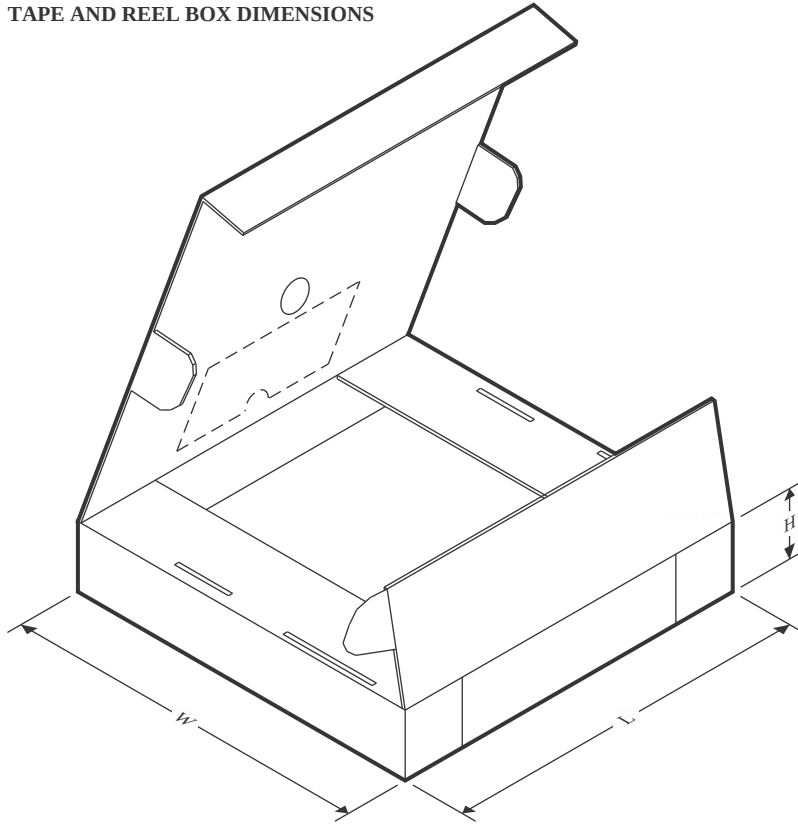
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS6508700RSKR | VQFN         | RSK             | 64   | 2000 | 330.0              | 16.4               | 8.3     | 8.3     | 1.1     | 12.0    | 16.0   | Q2            |
| TPS6508700RSKT | VQFN         | RSK             | 64   | 250  | 180.0              | 16.4               | 8.3     | 8.3     | 1.1     | 12.0    | 16.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS

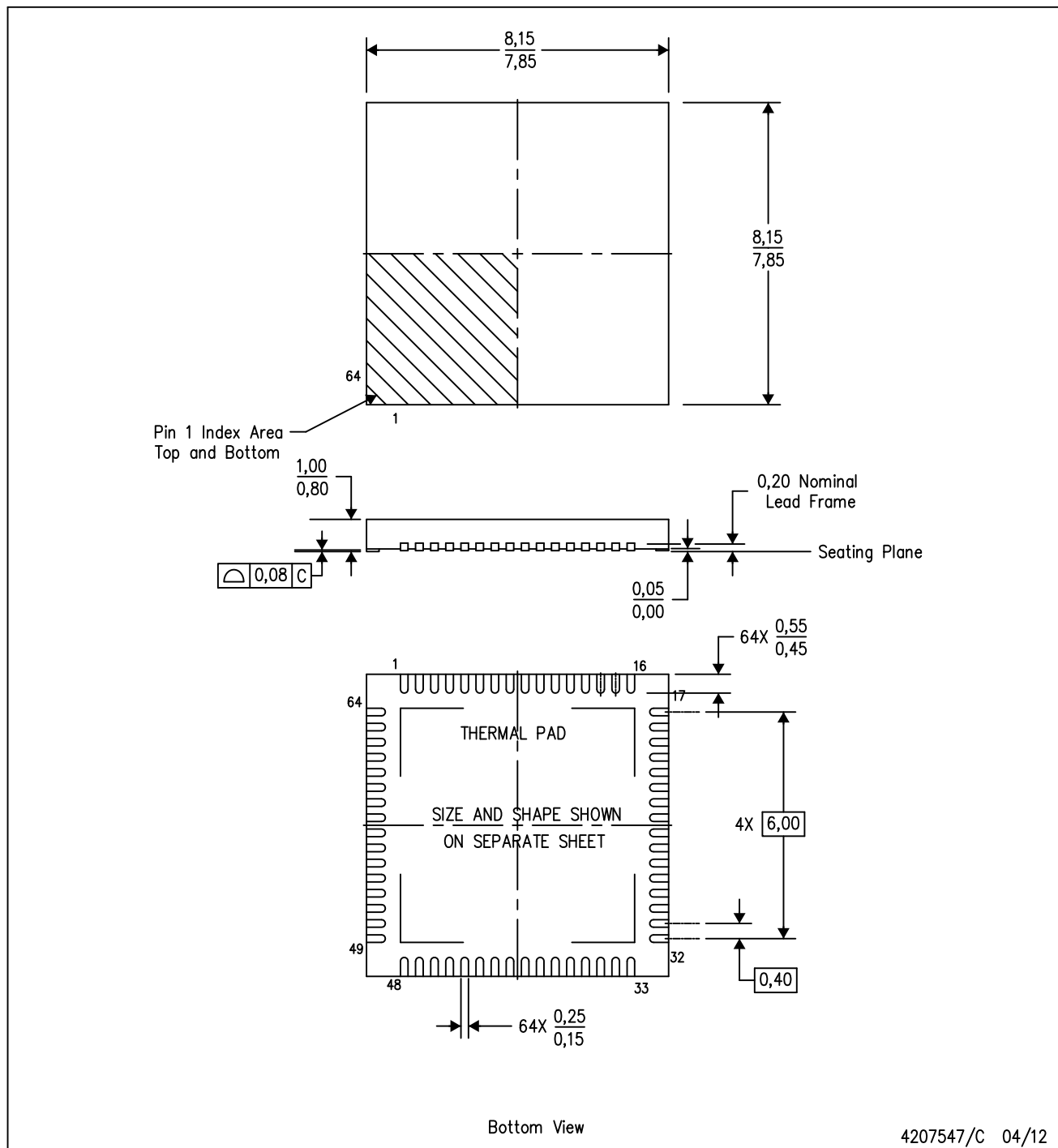


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS6508700RSKR | VQFN         | RSK             | 64   | 2000 | 367.0       | 367.0      | 38.0        |
| TPS6508700RSKT | VQFN         | RSK             | 64   | 250  | 210.0       | 185.0      | 35.0        |

RSK (S-PVQFN-N64)

PLASTIC QUAD FLATPACK NO-LEAD



- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5-1994.
  - This drawing is subject to change without notice.
  - QFN (Quad Flatpack No-Lead) Package configuration.
  - The package thermal pad must be soldered to the board for thermal and mechanical performance.
  - See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.

RSK (S-PVQFN-N64)

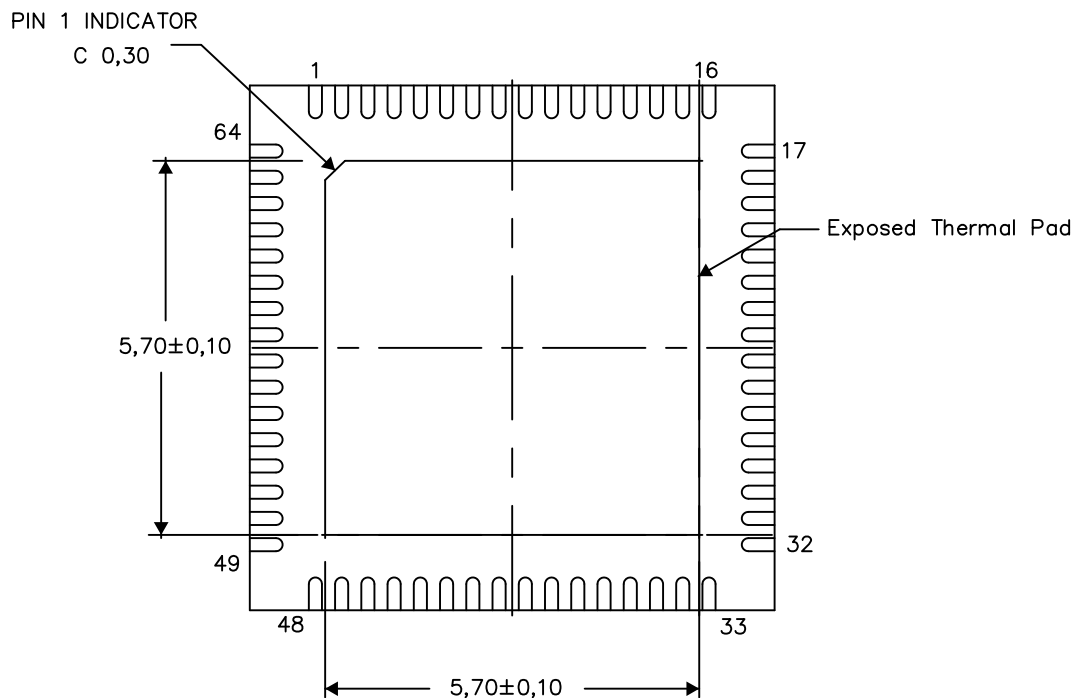
PLASTIC QUAD FLATPACK NO-LEAD

## THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

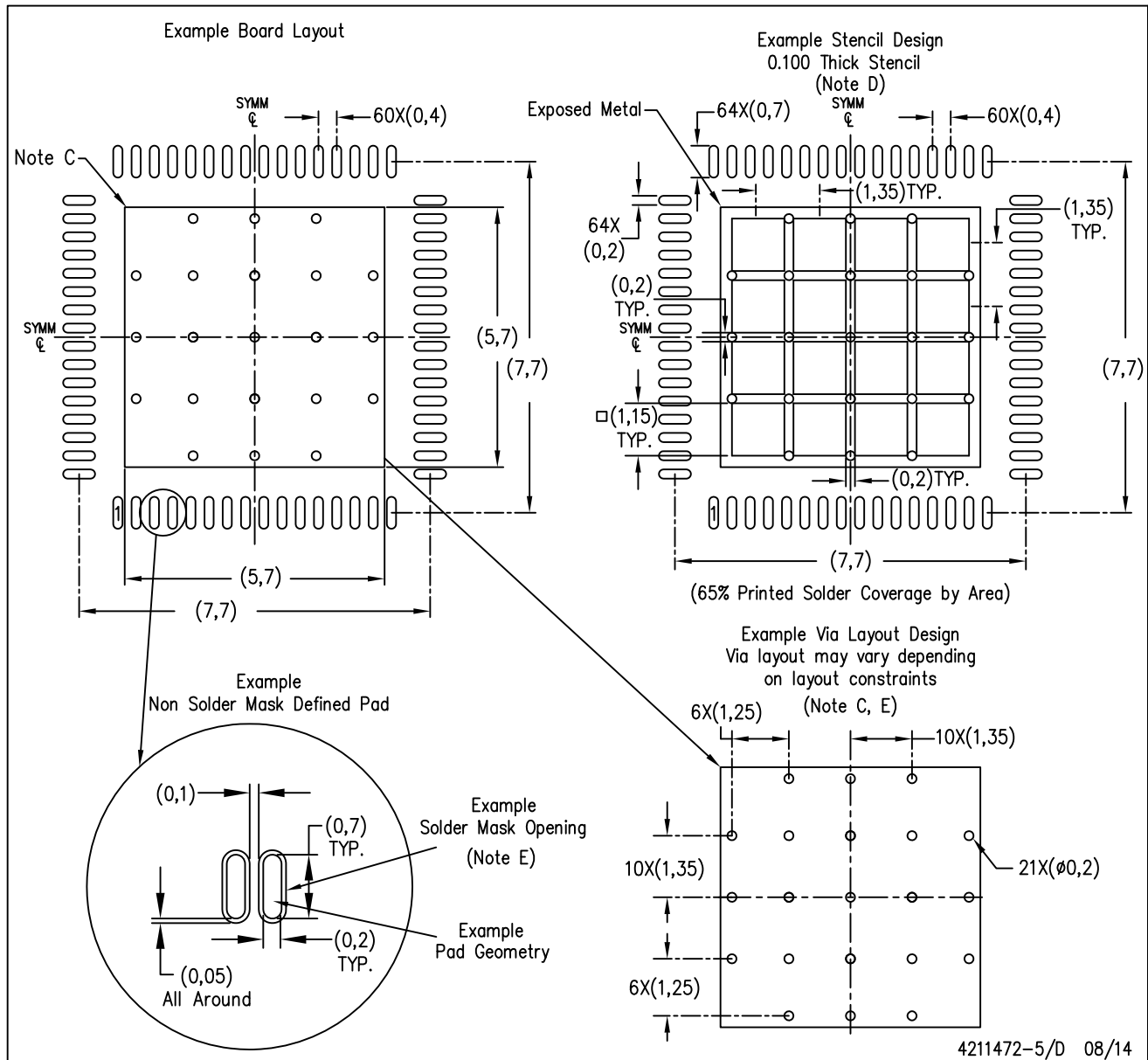
Exposed Thermal Pad Dimensions

4208001-5/H 08/14

NOTE: A. All linear dimensions are in millimeters

RSK (S-PVQFN-N64)

PLASTIC QUAD FLATPACK NO-LEAD



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SCBA017, SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - Customers should contact their board fabrication site for recommended solder mask tolerances and via tenting recommendations for any larger diameter vias placed in the thermal pad.

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